ADE-206-009A

HG62G Series
High-Speed CMOS Gate Array

HITACHI

Mar. 1992
Rev. 1

Description

The HG62G series free-channel gate arrays are fabricated with 0.8 µm CMOS process and double metal interconnect technology. The HG62G series consists of 4 master slices ranging from 14,540 to 34,797 raw gates with high I/O pin counts.

Internal gate delay time is as low as 0.3 ns per gate and output buffer speed is improved as 1.8 ns with maximum drivability of 24 mA output current.

The macro cells are compatible with the HG62S series, including RAM availability.

With the HG62G, it is easy to design high-speed, high-performance systems with on-chip autodiagnosis support.

Features

- Ultrahigh-speed operation
  - — Internal gate (2-input power NAND, FO = 2, Al = 2 mm).....0.3 ns typ.
  - — Input buffer (FO = 2, Al = 2 mm).....0.8 ns typ.
  - — Output buffer (C_L = 50 pF).....1.8 ns typ.
- High drivability output
  - — Selective buffers with I_{OL} = 2 mA, 8 mA, 12 mA or 24 mA
- High I/O pin counts
  - — Around 40% improvement in a comparison with current HG62S series.
- Low power dissipation
  - — Internal gate at 10 MHz operation .....90 µw/gate typ.
- Low voltage operation
  - — Operating voltage range.....2.7 to 5.5 V
- Autodiagnosis
  - — Automatic test circuit and test pattern generation
- RAM capability
  - — Various single-/dual-port RAMS
  - — Built-in autodiagnosis function
- Macro cell library variation
  - — Compatibility with HG62S series
  - — Power-type cell variation
  - — Normal or scan type latches and flip-flops available
- Wide variety of input and output cells
  - — Input, output and I/O buffers
  - — TTL or CMOS levels
  - — Reduced noise output buffers
  - — Driving capacity: I_{OL} = 2, 8, 12, 24 mA
  - — Oscillator, Schmitt-trigger inputs, pull-up/down resistors
- Package variety: High pin count packages
- Design support environment
  - — Hierarchical design support
  - — Fault simulator for test pattern evaluation
  - — Automatic test pattern
  - — Local design support center
  - — EWS (engineering work station) support

Ordering Information

Item	HG62G014	HG62G019	HG62G027	HG62G035
Gate count	14,540	19,519	27,587	34,797
Pad count	160	184	216	240

Hitachi semiconductor

Maximum Available Signal Pins

Package Type	Body	HG62G014	HG62G019	HG62G027	HG62G035
DILP-64S		60	60	—	—
QFP-64	14 × 14 mm	60	60	60	—
QFP-80	14 × 14 mm	(under dev)	(under dev)	76	76
QFP-100	14 × 14 mm	(under dev)	(under dev)	(under dev)	96
QFP-144	20 × 20 mm	(under dev)	(under dev)	—	—
QFP-176	24 × 24 mm	—	—	(under dev)	(under dev)
QFP-136	28 × 28 mm	128	128	(under dev)	(under dev)
QFP-168	28 × 28 mm	136	152	152	152
QFP-208	28 × 28 mm			188	188

Note: (under dev): Under development

Logic Design Cautions

Number of Usable Gates

In free-channel gate arrays, a routing area is kept open by spoiling some of the basic cells in the channel area used. Therefore, the actual gate count depends on the logic circuit. Table 3 shows approximate gate counts.

If RAM is used, Hitachi needs to know the memory density (word/bit organization) and random logic gate counts to quote the best master slice selection.

Autodiagnosis

Automatic generation of high fault coverage (more than 95%) test circuits and test patterns requires the following:

- Dedicate two pins to test functions (figure 1).
- Use cells with scan function for latches, flip-flops, and shift registers. Calculations for timing design and gate count estimation should use macro cells with the scan function. The names of macro cells with the scan function start with "T". For example, FD (normal) → TFD (scan type).

Approximate Actual Gate Counts

Master	HG62G014	HG62G019	HG62G027	HG62G035
Usable gates (k gates)	5.8–6.5	7.8–8.8	11.0–12.4	13.9–15.7

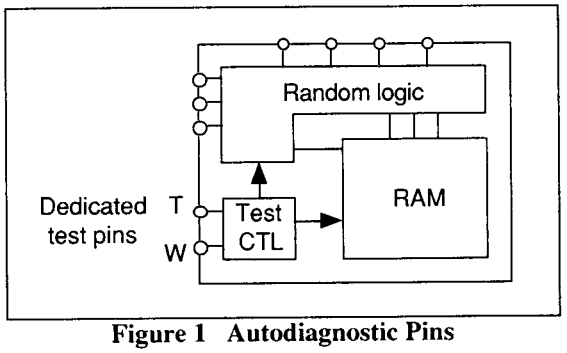


Figure 1 Autodiagnostic Pins

- Autodiagnosis is also available for circuits with RAM, and the RAM itself can be autodiagnosed. Even when autodiagnosis is not required for RAM but only for the peripheral circuits, use RAM cells with the scan function.

Blocks

Logically unified circuits can be placed in a block during layout. The maximum number of gates in a block should be 4,000. Also, the total number of gates in all blocks should be less than 60% of the total number of gates.

Gate Delay Time

Gate delay time calculations are more accurate when they use actual routing information after automatic layout. However, a rough estimation is needed to prevent timing design errors in the earlier design phase. Gate delay times are estimated as follows:

$$t_{plh} = t_{olh} + (K_{lh} \times C_L)$$
$$t_{phl} = t_{ohl} + (K_{hl} \times C_L)$$
$$C_L = \Sigma C_{AL} + 0.05 \times \Sigma LV$$

Where:

C_{AL}: Statistic wiring capacitance per fanout
LV: Input load constant

The macro cell library lists the to, K, and LV constants.

In delay time calculations, the statistic wiring capacitance per fanout depends on whether the circuits are part of a block layout (table 1).

Table 1 Statistic Wiring Capacitance

Unit : (pF/fo)

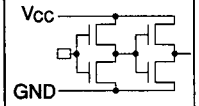
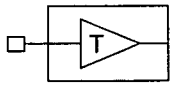
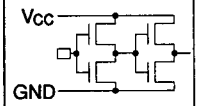
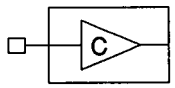
		Inter-block	
	Intra-block	**G014, G019**	**G027, S035**
C_{AL}	0.12	0.25	0.35

Note: Gate delay time distribution: 35%–180%
V_{CC} = 5 V ± 5%, Ta = –20°C to +75°C

Macro Cell Library

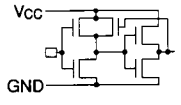
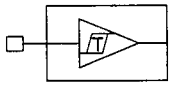
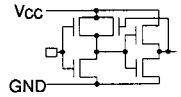
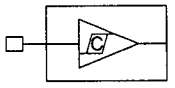
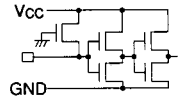
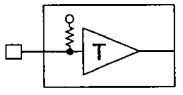
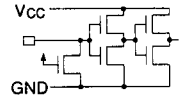
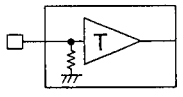
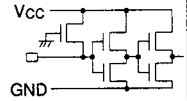
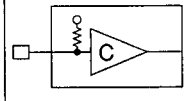
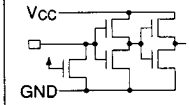
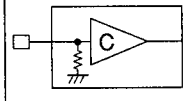
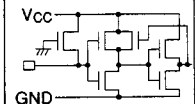
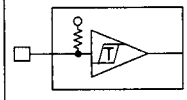
I/O Buffers

- Input buffers

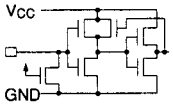
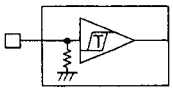
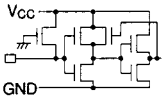
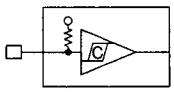
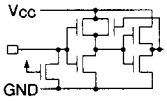
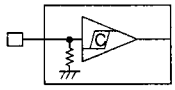
Macro						Delay					
								t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	**Equiv. Circuit**	**Equiv. Gate Count**	**LV**	**Clamp Level when Open**	**Symbol**	**Symbol No.**	**Input Name**	**Output Name**	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
TTL-level input buffer IT		—	—			D1			0.53	0.16	1.19	0.14
CMOS-level input buffer IC		—	—			D1			0.65	0.17	0.82	0.14

Note) When using EWS for gate array design, please reconfirm the latest availability of cells.

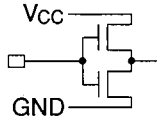
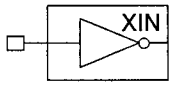
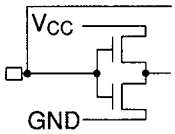
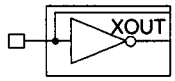
• Input buffers (cont)

Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
Schmitt-trigger TTL-level input buffer ITS		—	—			D1			0.83	0.22	1.57	0.27
Schmitt-trigger CMOS-level input buffer ICS		—	—			D1			0.96	0.26	1.34	0.26
TTL-level input buffer with pull-up ITU		—	—			D2			0.53	0.16	1.19	0.14
TTL-level input buffer with pull-down ITD		—	—			D2			0.53	0.16	1.19	0.14
CMOS-level input buffer with pull-up ICU		—	—			D2			0.65	0.17	0.82	0.14
CMOS-level input buffer with pull-down ICD		—	—			D2			0.65	0.17	0.82	0.14
Schmitt-trigger TTL-level input buffer with pull-up ITSU		—	—			D2			0.83	0.22	1.57	0.27

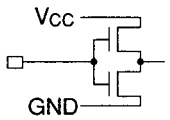
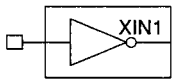
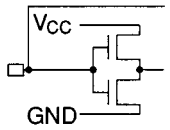
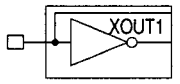
• Input buffers (cont)

Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Input Name	Output Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
Schmitt-trigger TTL-level input buffer with pull-down ITSD		—	—			D2			0.83	0.22	1.57	0.27
Schmitt-trigger CMOS-level input buffer with pull-up ICSU		—	—			D2			0.96	0.26	1.34	0.26
Schmitt-trigger CMOS-level input buffer with pull-down ICSD		—	—			D2			0.96	0.26	1.34	0.26

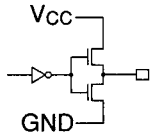
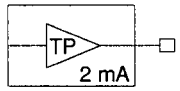
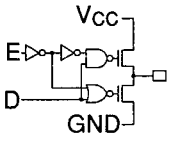
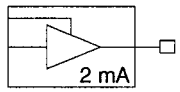
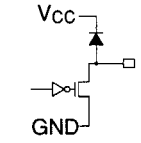
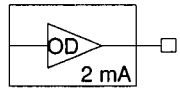
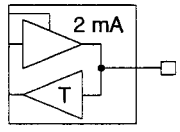
• Crystal oscillators

Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Input Name	Output Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
OSC in (2 M to 20 MHz) XIN		—	—			D1			2.40	0.19	1.80	0.11
OSC out (2 M to 20 MHz) XOUT		—	—			D1			0.96	0.12	0.66	0.13

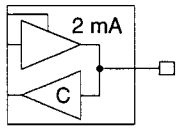
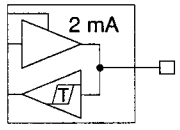
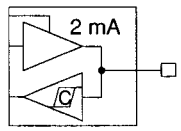
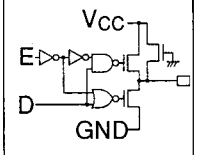
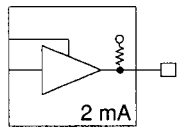
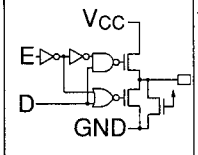
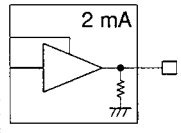
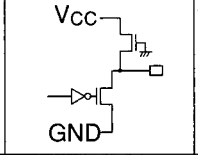
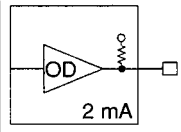
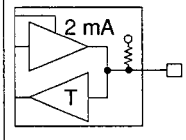
• Crystal oscillators (cont)

Macro: Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Delay: Input Name	Delay: Output Name	t_{plh} (ns): t_{olh}	t_{plh} (ns): K_{lh}	t_{phl} (ns): t_{ohl}	t_{phl} (ns): K_{hl}
OSC in (32 k to 400 kHz) XIN1		—	—			D1			5.34	6.57	3.28	2.88
OSC out (32 k to 400 kHz) XOUT1		—	—			D1			0.96	0.12	0.66	0.13

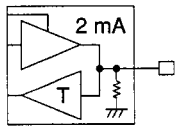
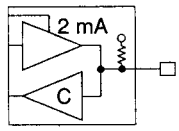
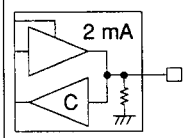
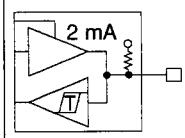
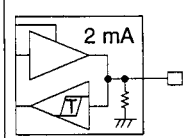
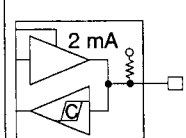
• Outputs and bidirectional buffers (I_{OL} = 2 mA)

Macro: Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Delay: Input Name	Delay: Output Name	t_{plh} (ns): t_{olh}	t_{plh} (ns): K_{lh}	t_{phl} (ns): t_{ohl}	t_{phl} (ns): K_{hl}
Totempole output OT1		—	3			D1			1.92	0.114	2.22	0.097
Three-state output OZ1		—	4 5			D1	E D		2.12 1.92	0.114	2.42 2.22	0.097
Open-drain output ODN1		—	3			D1			(t_{olz}) 1.92	(K_{lz}) —	(t_{ozl}) 2.22	(K_{zl}) 0.097
TTL-level I/O buffer	Refer to equivalent circuit of three-state output.	—	4			D2	E D		2.12 1.92	0.114	2.42 2.22	0.097
ITO1	Refer to equivalent circuit of input buffers.		5						0.53	0.16	1.19	0.14

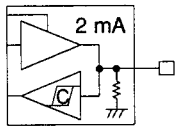
• Outputs and bidirectional buffers (I_{OL} = 2 mA) (cont)

Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Input Name	Output Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
CMOS-level I/O buffer	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.12	0.114	2.42	0.097
							D		1.92		2.22	
ICO1	Refer to equivalent circuit of input buffers.		5						0.65	0.17	0.82	0.14
TTL-level I/O buffer with Schmitt-trigger	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.12	0.114	2.42	0.097
							D		1.92		2.22	
ITSO1	Refer to equivalent circuit of input buffers.		5						0.83	0.22	1.57	0.27
CMOS-level I/O buffer with Schmitt-trigger	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.12	0.114	2.42	0.097
							D		1.92		2.22	
ICSO1	Refer to equivalent circuit of input buffers.		5						0.96	0.26	1.34	0.26
Three-state output buffer with pull-up		—	4			D2	E		2.12	0.114	2.42	0.097
							D		1.92		2.22	
OZ1U			5									
Three-state output buffer with pull-down		—	4			D2	E		2.12	0.114	2.42	0.097
							D		1.92		2.22	
OZ1D			5									
Open-drain output buffer with pull-up		—	3			D2			(t_{olz}) 1.92	(K_{lz}) —	(t_{ozl}) 2.22	(K_{zl}) 0.097
ODN1U												
TTL-level I/O buffer with pull-up	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.12	0.114	2.42	0.097
							D		1.92		2.22	
ITO1U	Refer to equivalent circuit of input buffers.		5						0.53	0.16	1.19	0.14

• Outputs and bidirectional buffers (I_{OL} = 2 mA) (cont)

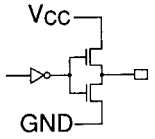
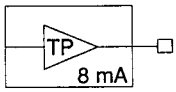
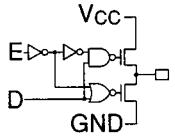
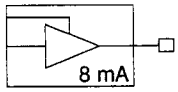
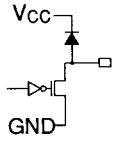
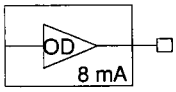
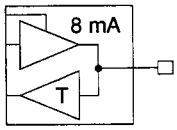
Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
TTL-level I/O buffer with pull-down ITO1D	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.12	0.114	2.42	0.097
							D		1.92		2.22	
	Refer to equivalent circuit of input buffers.		5						0.53	0.16	1.19	0.14
CMOS-level I/O buffer with pull-up ICO1U	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.12	0.114	2.42	0.097
							D		1.92		2.22	
	Refer to equivalent circuit of input buffers.		5						0.65	0.17	0.82	0.14
CMOS-level I/O buffer with pull-down ICO1D	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.12	0.114	2.42	0.097
							D		1.92		2.22	
	Refer to equivalent circuit of input buffers.		5						0.65	0.17	0.82	0.14
TTL-level Schmitt-trigger I/O buffer with pull-up ITSO1U	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.12	0.114	2.42	0.097
							D		1.92		2.22	
	Refer to equivalent circuit of input buffers.		5						0.83	0.22	1.57	0.27
TTL-level Schmitt-trigger I/O buffer with pull-down ITSO1D	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.12	0.114	2.42	0.097
							D		1.92		2.22	
	Refer to equivalent circuit of input buffers.		5						0.83	0.22	1.57	0.27
CMOS-level Schmitt-trigger I/O buffer with pull-up ICSO1U	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.12	0.114	2.42	0.097
							D		1.92		2.22	
	Refer to equivalent circuit of input buffers.		5						0.96	0.26	1.34	0.26

• Outputs and bidirectional buffers (I_{OL} = 2 mA) (cont)

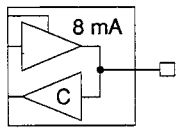
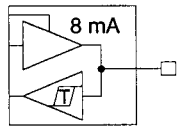
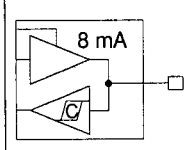
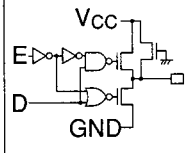
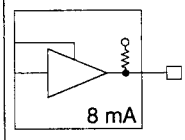
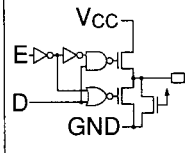
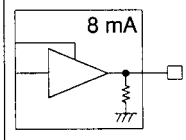
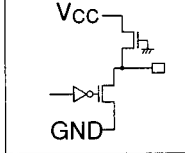
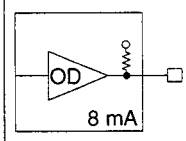
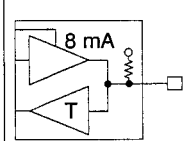
Macro: Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Delay: Input Name	Delay: Output Name	t_{plh} (ns): t_{olh}	t_{plh} (ns): K_{lh}	t_{phl} (ns): t_{ohl}	t_{phl} (ns): K_{hl}
CMOS-level Schmitt-trigger I/O buffer with pull-down ICSO1D	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.12	0.114	2.42	0.097
							D		1.92		2.22	
	Refer to equivalent circuit of input buffers.		5						0.96	0.26	1.34	0.26

Note: Propagation delay constant from anable terminals (E) as three-state output responds to $t_{olh} \rightarrow t_{olz}$ or t_{ozh}, and $t_{ohl} \rightarrow t_{ohz}$ or t_{ozl}.

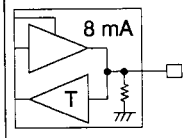
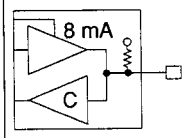
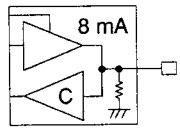
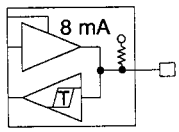
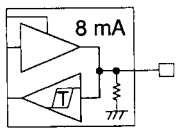
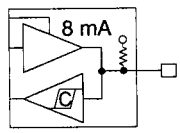
• Outputs and bidirectional buffers (I_{OL} = 8 mA)

Macro: Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Delay: Input Name	Delay: Output Name	t_{plh} (ns): t_{olh}	t_{plh} (ns): K_{lh}	t_{phl} (ns): t_{ohl}	t_{phl} (ns): K_{hl}
Totempole output OT3		—	3			D1			1.93	0.027	1.29	0.047
Three-state output OZ3		—	4			D1	E		2.13	0.027	1.49	0.047
			5				D		1.93		1.29	
Open-drain output ODN3		—	3			D1			(t_{olz}) 1.93	(K_{lz}) —	(t_{ozl}) 1.29	(K_{zl}) 0.047
TTL-level I/O buffer ITO3	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.13	0.027	1.49	0.047
							D		1.93		1.29	
	Refer to equivalent circuit of input buffers.		5						0.53	0.16	1.19	0.14

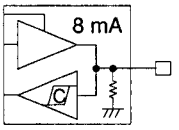
• Outputs and bidirectional buffers (I_{OL} = 8 mA) (cont)

Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Input Name	Output Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
CMOS-level I/O buffer	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.13	0.027	1.49	0.047
							D		1.93		1.29	
ICO3	Refer to equivalent circuit of input buffers.		5						0.65	0.17	0.82	0.14
TTL-level I/O buffer with Schmitt-trigger	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.13	0.027	1.49	0.047
							D		1.93		1.29	
ITSO3	Refer to equivalent circuit of input buffers.		5						0.83	0.22	1.57	0.27
CMOS-level I/O buffer with Schmitt-trigger	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.13	0.027	1.49	0.047
							D		1.93		1.29	
ICSO3	Refer to equivalent circuit of input buffers.		5						0.96	0.26	1.34	0.26
Three-state output buffer with pull-up		—	4			D2	E		2.13	0.027	1.49	0.047
							D		1.93		1.29	
OZ3U			5									
Three-state output buffer with pull-down		—	4			D2	E		2.13	0.027	1.49	0.047
							D		1.93		1.29	
OZ3D			5									
Open-drain output buffer with pull-up		—	3			D2			(t_{olz}) 1.93	(K_{lz}) —	(t_{ozl}) 1.29	(K_{zl}) 0.047
ODN3U												
TTL-level I/O buffer with pull-up	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.13	0.027	1.49	0.047
							D		1.93		1.29	
ITO3U	Refer to equivalent circuit of input buffers.		5						0.53	0.16	1.19	0.14

• Outputs and bidirectional buffers (I_{OL} = 8 mA) (cont)

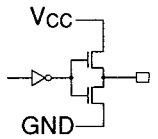
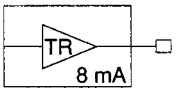
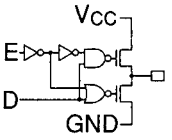
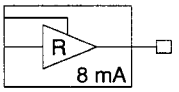
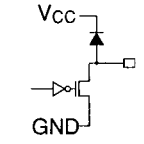
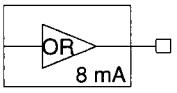
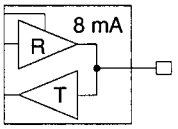
Macro						Sym-bol No.	Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol		In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
TTL-level I/O buffer with pull-down ITO3D	Refer to equivalent circuit of three-state output.	—	4			D2	E D		2.13 1.93	0.027	1.49 1.29	0.047
	Refer to equivalent circuit of input buffers.		5						0.53	0.16	1.19	0.14
CMOS-level I/O buffer with pull-up ICO3U	Refer to equivalent circuit of three-state output.	—	4			D2	E D		2.13 1.93	0.027	1.49 1.29	0.047
	Refer to equivalent circuit of input buffers.		5						0.65	0.17	0.82	0.14
CMOS-level I/O buffer with pull-down ICO3D	Refer to equivalent circuit of three-state output.	—	4			D2	E D		2.13 1.93	0.027	1.49 1.29	0.047
	Refer to equivalent circuit of input buffers.		5						0.65	0.17	0.82	0.14
TTL-level Schmitt-trigger I/O buffer with pull-up ITSO3U	Refer to equivalent circuit of three-state output.	—	4			D2	E D		2.13 1.93	0.027	1.49 1.29	0.047
	Refer to equivalent circuit of input buffers.		5						0.83	0.22	1.57	0.27
TTL-level Schmitt-trigger I/O buffer with pull-down ITSO3D	Refer to equivalent circuit of three-state output.	—	4			D2	E D		2.13 1.93	0.027	1.49 1.29	0.047
	Refer to equivalent circuit of input buffers.		5						0.83	0.22	1.57	0.27
CMOS-level Schmitt-trigger I/O buffer with pull-up ICSO3U	Refer to equivalent circuit of three-state output.	—	4			D2	E D		2.13 1.93	0.027	1.49 1.29	0.047
	Refer to equivalent circuit of input buffers.		5						0.96	0.26	1.34	0.26

• Outputs and bidirectional buffers (I_{OL} = 8 mA) (cont)

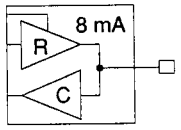
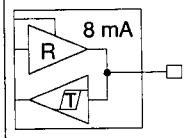
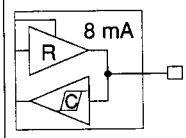
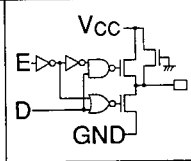
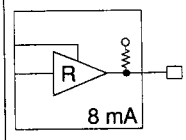
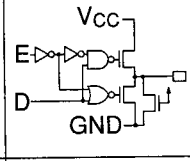
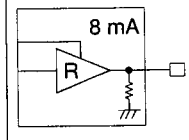
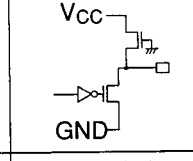
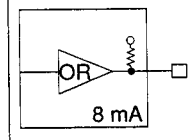
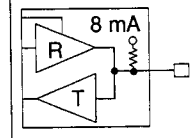
Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
CMOS-level Schmitt-trigger I/O buffer with pull-down ICSO3D	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.13	0.027	1.49	0.047
							D		1.93		1.29	
	Refer to equivalent circuit of input buffers.		5						0.96	0.26	1.34	0.26

Note: Propagation delay constant from anable terminals (E) as three-state output responds to $t_{olh} \rightarrow t_{olz}$ or t_{ozh}, and $t_{ohl} \rightarrow t_{ohz}$ or t_{ozl}.

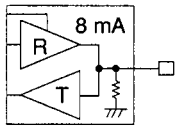
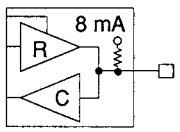
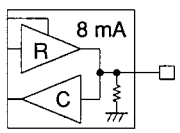
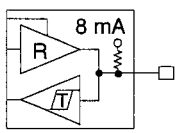
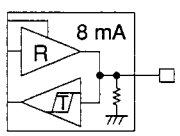
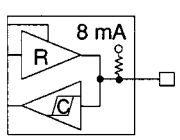
• GND noise reduction buffers (I_{OL} = 8 mA)

Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
Totempole output OT3R		—	2			D1			2.92	0.035	5.37	0.051
Three-state output OZ3R		—	4			D1	E		2.35	0.037	3.84	0.054
			6				D		2.15		3.64	
Open-drain output ODN3R		—	2			D1			(t_{olz}) 2.92	(K_{lz}) —	(t_{ozl}) 5.37	(K_{zl}) 0.051
TTL-level I/O buffer	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.35	0.037	3.84	0.054
							D		2.15		3.64	
ITO3R	Refer to equivalent circuit of input buffers.		6						0.53	0.16	1.19	0.14

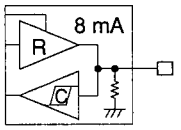
• GND noise reduction buffers (I_{OL} = 8 mA) (cont)

Macro						Sym-bol No.	Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol		In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
CMOS-level I/O buffer ICO3R	Refer to equivalent circuit of three-state output. Refer to equivalent circuit of input buffers.	—	4 6			D2	E D		2.35 2.15 0.65	0.037 0.17	3.84 3.64 0.82	0.054 0.14
TTL-level I/O buffer with Schmitt-trigger ITSO3R	Refer to equivalent circuit of three-state output. Refer to equivalent circuit of input buffers.	—	4 6			D2	E D		2.35 2.15 0.83	0.037 0.22	3.84 3.64 1.57	0.054 0.27
CMOS-level I/O buffer with Schmitt-trigger ICSO3R	Refer to equivalent circuit of three-state output. Refer to equivalent circuit of input buffers.	—	4 6			D2	E D		2.35 2.15 0.96	0.037 0.26	3.84 3.64 1.34	0.054 0.26
Three-state output buffer with pull-up OZ3RU		—	4 6			D2	E D		2.35 2.15	0.037	3.84 3.64	0.054
Three-state output buffer with pull-down OZ3RD		—	4 6			D2	E D		2.35 2.15	0.037	3.84 3.64	0.054
Open-drain output buffer with pull-up ODN3RU		—	2			D2			(t_{olz}) 2.92	(K_{lz}) —	(t_{ozl}) 5.37	(K_{zl}) 0.051
TTL-level I/O buffer with pull-up ITO3RU	Refer to equivalent circuit of three-state output. Refer to equivalent circuit of input buffers.	—	4 6			D2	E D		2.35 2.15 0.53	0.037 0.16	3.84 3.64 1.19	0.054 0.14

• GND noise reduction buffers (I_{OL} = 8 mA) (cont)

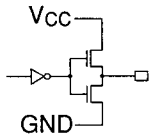
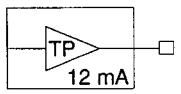
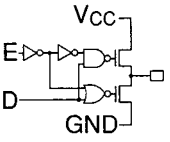
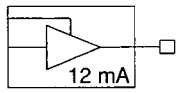
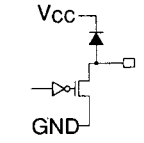
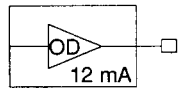
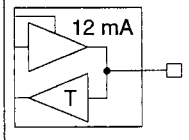
Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
TTL-level I/O buffer with pull-down ITO3RD	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.35	0.037	3.84	0.054
							D		2.15		3.64	
	Refer to equivalent circuit of input buffers.		6						0.53	0.16	1.19	0.14
CMOS-level I/O buffer with pull-up ICO3RU	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.35	0.037	3.84	0.054
							D		2.15		3.64	
	Refer to equivalent circuit of input buffers.		6						0.65	0.17	0.82	0.14
CMOS-level I/O buffer with pull-down ICO3RD	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.35	0.037	3.84	0.054
							D		2.15		3.64	
	Refer to equivalent circuit of input buffers.		6						0.65	0.17	0.82	0.14
TTL-level Schmitt-trigger I/O buffer with pull-up ITSO3RU	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.35	0.037	3.84	0.054
							D		2.15		3.64	
	Refer to equivalent circuit of input buffers.		6						0.83	0.22	1.57	0.27
TTL-level Schmitt-trigger I/O buffer with pull-down ITSO3RD	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.35	0.037	3.84	0.054
							D		2.15		3.64	
	Refer to equivalent circuit of input buffers.		6						0.83	0.22	1.57	0.27
CMOS-level Schmitt-trigger I/O buffer with pull-up ICSO3RU	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.35	0.037	3.84	0.054
							D		2.15		3.64	
	Refer to equivalent circuit of input buffers.		6						0.96	0.26	1.34	0.26

• GND noise reduction buffers (I_{OL} = 8 mA) (cont)

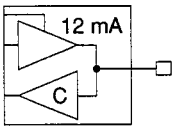
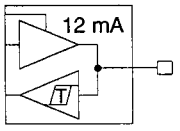
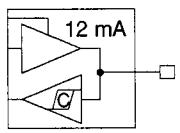
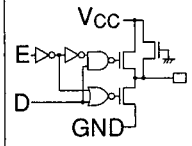
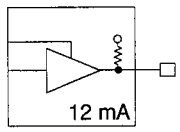
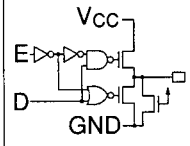
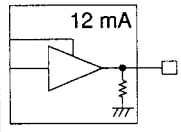
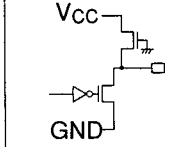
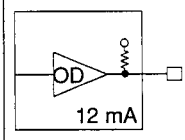
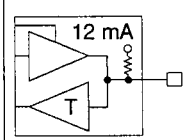
Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
CMOS-level Schmitt-trigger I/O buffer with pull-down ICSO3RD	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.35	0.037	3.84	0.054
							D		2.15		3.64	
	Refer to equivalent circuit of input buffers.		6						0.96	0.26	1.34	0.26

Note: Propagation delay constant from anable terminals (E) as three-state output responds to $t_{olh} \rightarrow t_{olz}$ or t_{ozh}, and $t_{ohl} \rightarrow t_{ohz}$ or t_{ozl}

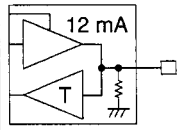
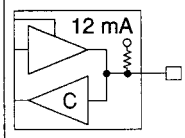
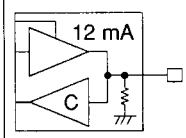
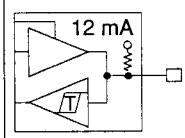
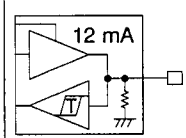
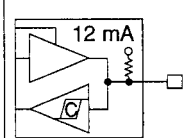
• Outputs and bidirectional buffers (I_{OL} = 12 mA)

Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
Totempole output OT4		—	5			D1			1.92	0.022	1.56	0.032
Three-state output OZ4		—	5			D1	E		2.12	0.022	1.76	0.032
			6				D		1.92		1.56	
Open-drain output ODN4		—	5			D1			(t_{olz}) 1.92	(K_{lz}) —	(t_{ozl}) 1.56	(K_{zl}) 0.032
TTL-level I/O buffer	Refer to equivalent circuit of three-state output.	—	5			D2	E		2.12	0.022	1.76	0.032
							D		1.92		1.56	
ITO4	Refer to equivalent circuit of input buffers.		6						0.53	0.16	1.19	0.14

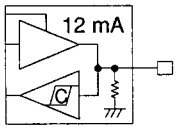
• Outputs and bidirectional buffers (I_{OL} = 12 mA) (cont)

Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Input Name	Output Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
CMOS-level I/O buffer	Refer to equivalent circuit of three-state output.	—	5			D2	E		2.12	0.022	1.76	0.032
							D		1.92		1.56	
ICO4	Refer to equivalent circuit of input buffers.		6						0.65	0.17	0.82	0.14
TTL-level I/O buffer with Schmitt-trigger	Refer to equivalent circuit of three-state output.	—	5			D2	E		2.12	0.022	1.76	0.032
							D		1.92		1.56	
ITSO4	Refer to equivalent circuit of input buffers.		6						0.83	0.22	1.57	0.27
CMOS-level I/O buffer with Schmitt-trigger	Refer to equivalent circuit of three-state output.	—	5			D2	E		2.12	0.022	1.76	0.032
							D		1.92		1.56	
ICSO4	Refer to equivalent circuit of input buffers.		6						0.96	0.26	1.34	0.26
Three-state output buffer with pull-up		—	5			D2	E		2.12	0.022	1.76	0.032
							D		1.92		1.56	
OZ4U			6									
Three-state output buffer with pull-down		—	5			D2	E		2.12	0.022	1.76	0.032
							D		1.92		1.56	
OZ4D			6									
Open-drain output buffer with pull-up		—	5			D2			(t_{olz}) 1.92	(K_{lz}) —	(t_{ozl}) 1.56	(K_{zl}) 0.032
ODN4U												
TTL-level I/O buffer with pull-up	Refer to equivalent circuit of three-state output.	—	5			D2	E		2.12	0.022	1.76	0.032
							D		1.92		1.56	
ITO4U	Refer to equivalent circuit of input buffers.		6						0.53	0.16	1.19	0.14

• Outputs and bidirectional buffers (I_{OL} = 12 mA) (cont)

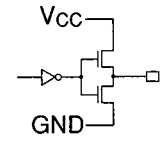
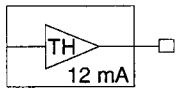
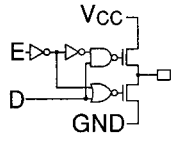
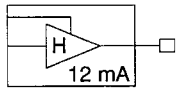
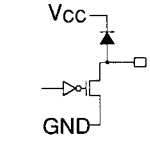
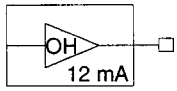
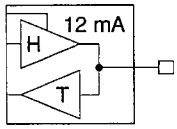
Macro						Sym-bol No.	Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol		In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
TTL-level I/O buffer with pull-down ITO4D	Refer to equivalent circuit of three-state output.	—	5			D2	E D		2.12 1.92	0.022	1.76 1.56	0.032
	Refer to equivalent circuit of input buffers.		6						0.53	0.16	1.19	0.14
CMOS-level I/O buffer with pull-up ICO4U	Refer to equivalent circuit of three-state output.	—	5			D2	E D		2.12 1.92	0.022	1.76 1.56	0.032
	Refer to equivalent circuit of input buffers.		6						0.65	0.17	0.82	0.14
CMOS-level I/O buffer with pull-down ICO4D	Refer to equivalent circuit of three-state output.	—	5			D2	E D		2.12 1.92	0.022	1.76 1.56	0.032
	Refer to equivalent circuit of input buffers.		6						0.65	0.17	0.82	0.14
TTL-level Schmitt-trigger I/O buffer with pull-up ITSO4U	Refer to equivalent circuit of three-state output.	—	5			D2	E D		2.12 1.92	0.022	1.76 1.56	0.032
	Refer to equivalent circuit of input buffers.		6						0.83	0.22	1.57	0.27
TTL-level Schmitt-trigger I/O buffer with pull-down ITSO4D	Refer to equivalent circuit of three-state output.	—	5			D2	E D		2.12 1.92	0.022	1.76 1.56	0.032
	Refer to equivalent circuit of input buffers.		6						0.83	0.22	1.57	0.27
CMOS-level Schmitt-trigger I/O buffer with pull-up ICSO4U	Refer to equivalent circuit of three-state output.	—	5			D2	E D		2.12 1.92	0.022	1.76 1.56	0.032
	Refer to equivalent circuit of input buffers.		6						0.96	0.26	1.34	0.26

• Outputs and bidirectional buffers (I_{OL} = 12 mA) (cont)

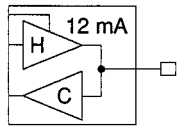
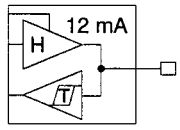
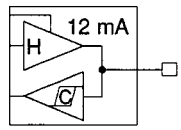
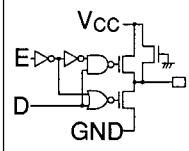
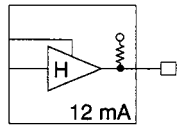
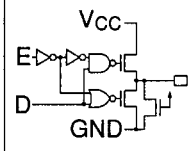
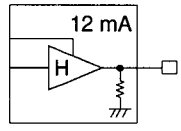
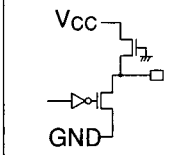
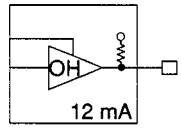
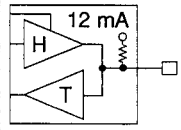
Macro: Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Delay: Input Name	Delay: Output Name	t_{plh} (ns): t_{olh}	t_{plh} (ns): K_{lh}	t_{phl} (ns): t_{ohl}	t_{phl} (ns): K_{hl}
CMOS-level Schmitt-trigger I/O buffer with pull-down ICSO4D	Refer to equivalent circuit of three-state output.	—	5			D2	E		2.12	0.022	1.76	0.032
							D		1.92		1.56	
	Refer to equivalent circuit of input buffers.		6						0.96	0.26	1.34	0.26

Note: Propagation delay constant from anable terminals (E) as three-state output responds to $t_{olh} \rightarrow t_{olz}$ or t_{ozh}, and $t_{ohl} \rightarrow t_{ohz}$ or t_{ozl}.

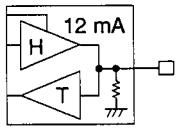
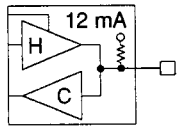
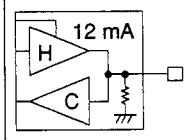
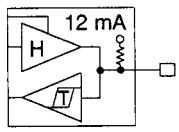
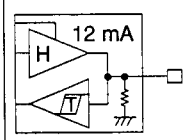
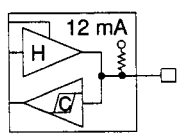
• Outputs and bidirectional buffers (I_{OL} = 12 mA high speed buffer)

Macro: Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Delay: Input Name	Delay: Output Name	t_{plh} (ns): t_{olh}	t_{plh} (ns): K_{lh}	t_{phl} (ns): t_{ohl}	t_{phl} (ns): K_{hl}
Totempole output OT4H		—	5			D1			1.05	0.016	0.60	0.023
Three-state output OZ4H		—	5			D1	E		1.25	0.016	0.80	0.023
			6				D		1.05		0.60	
Open-drain output ODN4H		—	5			D1			(t_{olz}) 1.05	(K_{lz}) —	(t_{ozl}) 0.60	(K_{zl}) 0.023
TTL-level I/O buffer	Refer to equivalent circuit of three-state output.	—	5			D2	E		1.25	0.016	0.80	0.023
							D		1.05		0.60	
ITO4H	Refer to equivalent circuit of input buffers.		6						0.53	0.16	1.19	0.14

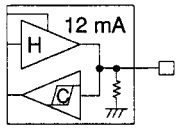
• Outputs and bidirectional buffers (I_{OL} = 12 mA high speed buffer) (cont)

Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Input Name	Output Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
CMOS-level I/O buffer	Refer to equivalent circuit of three-state output.	—	5			D2	E		1.25	0.016	0.80	0.023
							D		1.05		0.60	
ICO4H	Refer to equivalent circuit of input buffers.		6						0.65	0.17	0.82	0.14
TTL-level I/O buffer with Schmitt-trigger	Refer to equivalent circuit of three-state output.	—	5			D2	E		1.25	0.016	0.80	0.023
							D		1.05		0.60	
ITSO4H	Refer to equivalent circuit of input buffers.		6						0.83	0.22	1.57	0.27
CMOS-level I/O buffer with Schmitt-trigger	Refer to equivalent circuit of three-state output.	—	5			D2	E		1.25	0.016	0.80	0.023
							D		1.05		0.60	
ICSO4H	Refer to equivalent circuit of input buffers.		6						0.96	0.26	1.34	0.26
Three-state output buffer with pull-up		—	5			D2	E		1.25	0.016	0.80	0.023
			6				D		1.05		0.60	
OZ4HU												
Three-state output buffer with pull-down		—	5			D2	E		1.25	0.016	0.80	0.023
			6				D		1.05		0.60	
OZ4HD												
Open-drain output buffer with pull-up		—	5			D2			(t_{olz}) 1.05	(K_{lz}) —	(t_{ozl}) 0.60	(K_{zl}) 0.023
ODN4HU												
TTL-level I/O buffer with pull-up	Refer to equivalent circuit of three-state output.	—	5			D2	E		1.25	0.016	0.80	0.023
							D		1.05		0.60	
ITO4HU	Refer to equivalent circuit of input buffers.		6						0.53	0.16	1.19	0.14

• Outputs and bidirectional buffers (I_{OL} = 12 mA high speed buffer) (cont)

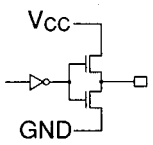
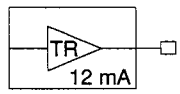
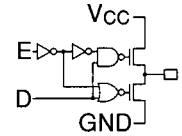
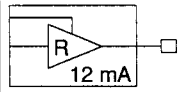
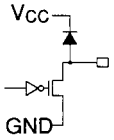
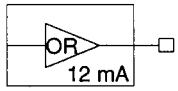
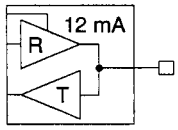
Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
TTL-level I/O buffer with pull-down ITO4HD	Refer to equivalent circuit of three-state output.	—	5			D2	E		1.25	0.016	0.80	0.023
							D		1.05		0.60	
	Refer to equivalent circuit of input buffers.		6						0.53	0.16	1.19	0.14
CMOS-level I/O buffer with pull-up ICO4HU	Refer to equivalent circuit of three-state output.	—	5			D2	E		1.25	0.016	0.80	0.023
							D		1.05		0.60	
	Refer to equivalent circuit of input buffers.		6						0.65	0.17	0.82	0.14
CMOS-level I/O buffer with pull-down ICO4HD	Refer to equivalent circuit of three-state output.	—	5			D2	E		1.25	0.016	0.80	0.023
							D		1.05		0.60	
	Refer to equivalent circuit of input buffers.		6						0.65	0.17	0.82	0.14
TTL-level Schmitt-trigger I/O buffer with pull-up ITSO4HU	Refer to equivalent circuit of three-state output.	—	5			D2			1.25	0.016	0.80	0.023
									1.05		0.60	
	Refer to equivalent circuit of input buffers.		6						0.83	0.22	1.57	0.27
TTL-level Schmitt-trigger I/O buffer with pull-down ITSO4HD	Refer to equivalent circuit of three-state output.	—	5			D2			1.25	0.016	0.80	0.023
									1.05		0.60	
	Refer to equivalent circuit of input buffers.		6						0.83	0.22	1.57	0.27
CMOS-level Schmitt-trigger I/O buffer with pull-up ICSO4HU	Refer to equivalent circuit of three-state output.	—	5			D2			1.25	0.016	0.80	0.023
									1.05		0.60	
	Refer to equivalent circuit of input buffers.		6						0.96	0.26	1.34	0.26

• Outputs and bidirectional buffers (I_{OL} = 12 mA high speed buffer) (cont)

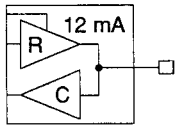
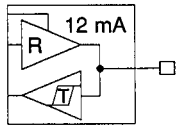
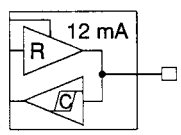
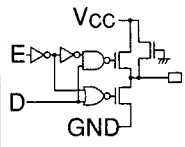
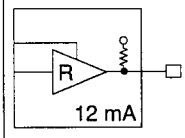
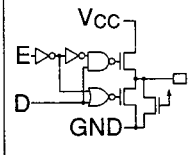
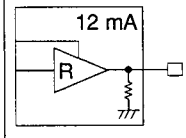
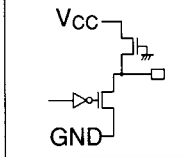
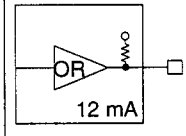
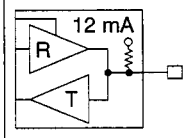
Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
CMOS-level Schmitt-trigger I/O buffer with pull-down ICSO4HD	Refer to equivalent circuit of three-state output.	—	5			D2			1.25 1.05	0.016	0.80 0.60	0.023
	Refer to equivalent circuit of input buffers.		6						0.96	0.26	1.34	0.26

Note: Propagation delay constant from anable terminals (E) as three-state output responds to $t_{olh} \rightarrow t_{olz}$ or t_{ozh}, and $t_{ohl} \rightarrow t_{ohz}$ or t_{ozl}.

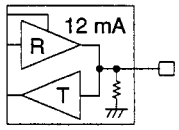
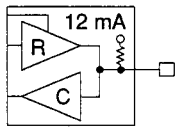
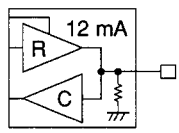
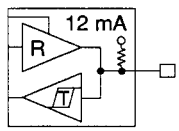
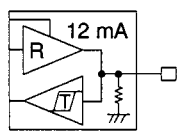
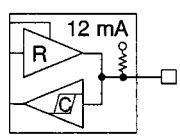
• GND noise reduction buffers (I_{OL} = 12 mA)

Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
Totempole output OT4R		—	2			D1			3.22	0.029	6.56	0.043
Three-state output OZ4R		—	4 6			D1	E D		2.36 2.16	0.031	4.03 3.83	0.046
Open-drain output ODN4R		—	2			D1			(t_{olz}) 3.22	(K_{lz}) —	(t_{ozl}) 6.56	(K_{zl}) 0.043
TTL-level I/O buffer ITO4R	Refer to equivalent circuit of three-state output.	—	4			D2	E D		2.36 2.16	0.031	4.03 3.83	0.046
	Refer to equivalent circuit of input buffers.		6						0.53	0.16	1.19	0.14

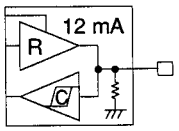
• GND noise reduction buffers (I_{OL} = 12 mA) (cont)

Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
CMOS-level I/O buffer	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.36	0.031	4.03	0.046
							D		2.16		3.83	
ICO4R	Refer to equivalent circuit of input buffers.		6						0.65	0.17	0.82	0.14
TTL-level I/O buffer with Schmitt-trigger	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.36	0.031	4.03	0.046
							D		2.16		3.83	
ITSO4R	Refer to equivalent circuit of input buffers.		6						0.83	0.22	1.57	0.27
CMOS-level I/O buffer with Schmitt-trigger	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.36	0.031	4.03	0.046
							D		2.16		3.83	
ICSO4R	Refer to equivalent circuit of input buffers.		6						0.96	0.26	1.34	0.26
Three-state output buffer with pull-up		—	4			D2	E		2.36	0.031	4.03	0.046
							D		2.16		3.83	
OZ4RU			6									
Three-state output buffer with pull-down		—	4			D2	E		2.36	0.031	4.03	0.046
							D		2.16		3.83	
OZ4RD			6									
Open-drain output buffer with pull-up		—	2			D2			(t_{olz}) 3.22	(K_{lz}) —	(t_{ozl}) 6.56	(K_{zl}) 0.043
ODN4RU												
TTL-level I/O buffer with pull-up	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.36	0.031	4.03	0.046
							D		2.16		3.83	
ITO4RU	Refer to equivalent circuit of input buffers.		6						0.53	0.16	1.19	0.14

• GND noise reduction buffers (I_{OL} = 12 mA) (cont)

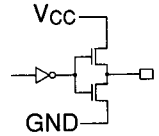
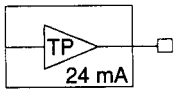
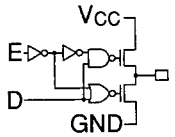
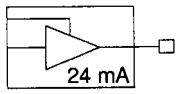
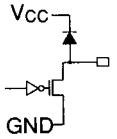
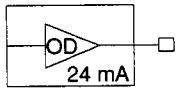
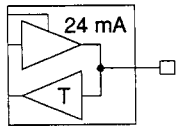
Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
TTL-level I/O buffer with pull-down ITO4RD	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.36	0.031	4.03	0.046
							D		2.16		3.83	
	Refer to equivalent circuit of input buffers.		6						0.53	0.16	1.19	0.14
CMOS-level I/O buffer with pull-up ICO4RU	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.36	0.031	4.03	0.046
							D		2.16		3.83	
	Refer to equivalent circuit of input buffers.		6						0.65	0.17	0.82	0.14
CMOS-level I/O buffer with pull-down ICO4RD	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.36	0.031	4.03	0.046
							D		2.16		3.83	
	Refer to equivalent circuit of input buffers.		6						0.65	0.17	0.82	0.14
TTL-level Schmitt-trigger I/O buffer with pull-up ITSO4RU	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.36	0.031	4.03	0.046
							D		2.16		3.83	
	Refer to equivalent circuit of input buffers.		6						0.83	0.22	1.57	0.27
TTL-level Schmitt-trigger I/O buffer with pull-down ITSO4RD	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.36	0.031	4.03	0.046
							D		2.16		3.83	
	Refer to equivalent circuit of input buffers.		6						0.83	0.22	1.57	0.27
CMOS-level Schmitt-trigger I/O buffer with pull-up ICSO4RU	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.36	0.031	4.03	0.046
							D		2.16		3.83	
	Refer to equivalent circuit of input buffers.		6						0.96	0.26	1.34	0.26

• GND noise reduction buffers (I_{OL} = 12 mA) (cont)

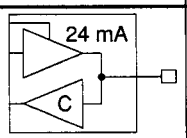
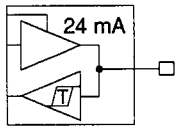
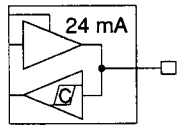
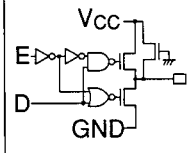
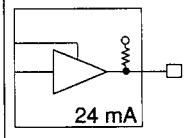
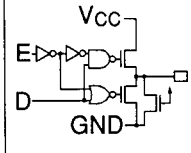
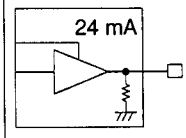
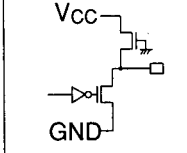
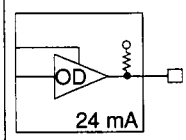
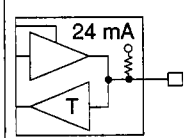
Macro: Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Delay: Input Name	Delay: Output Name	t_{plh} (ns): t_{olh}	t_{plh} (ns): K_{lh}	t_{phl} (ns): t_{ohl}	t_{phl} (ns): K_{hl}
CMOS-level Schmitt-trigger I/O buffer with pull-down ICSO4RD	Refer to equivalent circuit of three-state output.	—	4			D2	E		2.36	0.031	4.03	0.046
							D		2.16		3.83	
	Refer to equivalent circuit of input buffers.		6						0.96	0.26	1.34	0.26

Note: Propagation delay constant from anable terminals (E) as three-state output responds to $t_{olh} \rightarrow t_{olz}$ or t_{ozh}, and $t_{ohl} \rightarrow t_{ohz}$ or t_{ozl}.

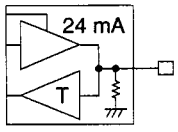
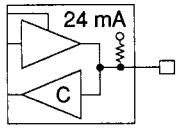
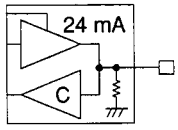
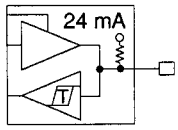
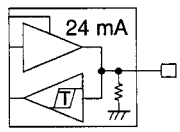
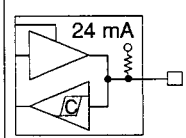
• Outputs and bidirectional buffers (I_{OL} = 24 mA)

Macro: Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Delay: Input Name	Delay: Output Name	t_{plh} (ns): t_{olh}	t_{plh} (ns): K_{lh}	t_{phl} (ns): t_{ohl}	t_{phl} (ns): K_{hl}
Totempole output OT5		—	5			D1			1.05	0.016	0.60	0.023
Three-state output OZ5		—	5			D1	E		1.25	0.016	0.80	0.023
			6				D		1.05		0.60	
Open-drain output ODN5		—	5			D1			(t_{olz}) 1.05	(K_{lz}) —	(t_{ozl}) 0.60	(K_{zl}) 0.023
TTL-level I/O buffer	Refer to equivalent circuit of three-state output.	—	5			D2	E		1.25	0.016	0.80	0.023
							D		1.05		0.60	
ITO5	Refer to equivalent circuit of input buffers.		6						0.53	0.16	1.19	0.14

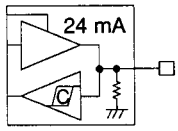
• Outputs and bidirectional buffers (I_{OL} = 24 mA) (cont)

Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
CMOS-level I/O buffer ICO5	Refer to equivalent circuit of three-state output. Refer to equivalent circuit of input buffers.	—	5 6			D2	E D		1.25 1.05 0.65	0.016 0.17	0.80 0.60 0.82	0.023 0.14
TTL-level I/O buffer with Schmitt-trigger ITSO5	Refer to equivalent circuit of three-state output. Refer to equivalent circuit of input buffers.	—	5 6			D2	E D		1.25 1.05 0.83	0.016 0.22	0.80 0.60 1.57	0.023 0.27
CMOS-level I/O buffer with Schmitt-trigger ICSO5	Refer to equivalent circuit of three-state output. Refer to equivalent circuit of input buffers.	—	5 6			D2	E D		1.25 1.05 0.96	0.016 0.26	0.80 0.60 1.34	0.023 0.26
Three-state output buffer with pull-up OZ5U		—	5 6			D2	E D		1.25 1.05	0.016	0.80 0.60	0.023
Three-state output buffer with pull-down OZ5D		—	5 6			D2	E D		1.25 1.05	0.016	0.80 0.60	0.023
Open-drain output buffer with pull-up ODN5U		—	5			D2			(t_{olz}) 1.05	(K_{lz}) —	(t_{ozl}) 0.60	(K_{zl}) 0.023
TTL-level I/O buffer with pull-up ITO5U	Refer to equivalent circuit of three-state output. Refer to equivalent circuit of input buffers.	—	5 6			D2	E D		1.25 1.05 0.53	0.016 0.16	0.80 0.60 1.19	0.023 0.14

- Outputs and bidirectional buffers (I_{OL} = 24 mA) (cont)

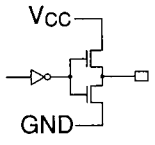
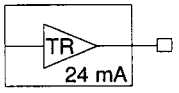
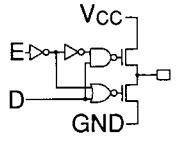
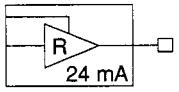
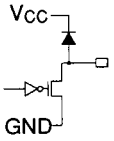
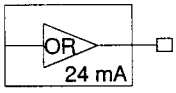
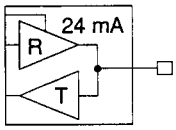
Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
TTL-level I/O buffer with pull-down ITO5D	Refer to equivalent circuit of three-state output.	—	5			D2	E D		1.25 1.05	0.016	0.80 0.60	0.023
	Refer to equivalent circuit of input buffers.		6						0.53	0.16	1.19	0.14
CMOS-level I/O buffer with pull-up ICO5U	Refer to equivalent circuit of three-state output.	—	5			D2	E D		1.25 1.05	0.016	0.80 0.60	0.023
	Refer to equivalent circuit of input buffers.		6						0.65	0.17	0.82	0.14
CMOS-level I/O buffer with pull-down ICO5D	Refer to equivalent circuit of three-state output.	—	5			D2	E D		1.25 1.05	0.016	0.80 0.60	0.023
	Refer to equivalent circuit of input buffers.		6						0.65	0.17	0.82	0.14
TTL-level Schmitt-trigger I/O buffer with pull-up ITSO5U	Refer to equivalent circuit of three-state output.	—	5			D2			1.25 1.05	0.016	0.80 0.60	0.023
	Refer to equivalent circuit of input buffers.		6						0.83	0.22	1.57	0.27
TTL-level Schmitt-trigger I/O buffer with pull-down ITSO5D	Refer to equivalent circuit of three-state output.	—	5			D2			1.25 1.05	0.016	0.80 0.60	0.023
	Refer to equivalent circuit of input buffers.		6						0.83	0.22	1.57	0.27
CMOS-level Schmitt-trigger I/O buffer with pull-up ICSO5U	Refer to equivalent circuit of three-state output.	—	5			D2			1.25 1.05	0.016	0.80 0.60	0.023
	Refer to equivalent circuit of input buffers.		6						0.96	0.26	1.34	0.26

• Outputs and bidirectional buffers (I_{OL} = 24 mA) (cont)

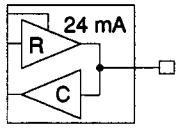
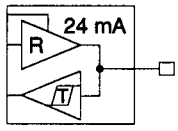
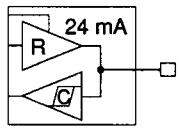
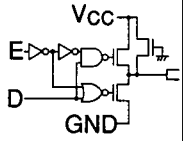
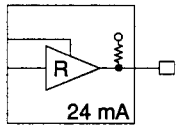
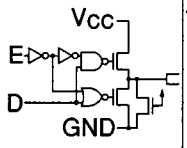
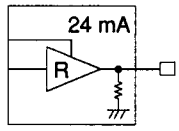
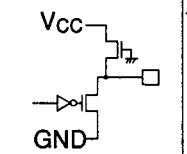
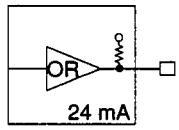
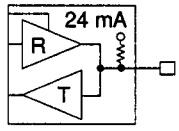
Macro: Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Delay: Input Name	Delay: Output Name	t_{plh} (ns): t_{olh}	t_{plh} (ns): K_{lh}	t_{phl} (ns): t_{ohl}	t_{phl} (ns): K_{hl}
CMOS-level Schmitt-trigger I/O buffer with pull-down ICSO5D	Refer to equivalent circuit of three-state output.	—	5			D2			1.25 1.05	0.016	0.80 0.60	0.023
	Refer to equivalent circuit of input buffers.		6						0.96	0.26	1.34	0.26

Note: Propagation delay constant from anable terminals (E) as three-state output responds to $t_{olh} \rightarrow t_{olz}$ or t_{ozh}, and $t_{ohl} \rightarrow t_{ohz}$ or t_{ozl}.

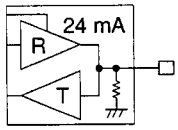
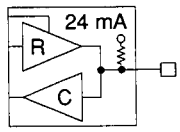
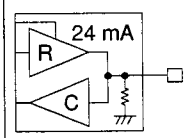
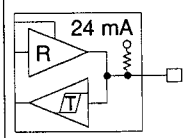
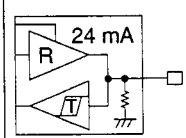
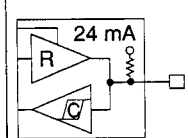
• GND noise reduction buffers (I_{OL} = 24 mA)

Macro: Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Delay: Input Name	Delay: Output Name	t_{plh} (ns): t_{olh}	t_{plh} (ns): K_{lh}	t_{phl} (ns): t_{ohl}	t_{phl} (ns): K_{hl}
Totempole output OT5R		—	2			D1			3.06	0.016	6.30	0.037
Three-state output OZ5R		—	3 5			D1	E D		2.38 2.18	0.017	4.00 3.80	0.030
Open-drain output ODN5R		—	2			D1			(t_{olz}) 3.06	(K_{lz}) —	(t_{ozl}) 6.30	(K_{zl}) 0.037
TTL-level I/O buffer	Refer to equivalent circuit of three-state output.	—	3			D2	E D		2.38 2.18	0.017	4.00 3.80	0.030
ITO5R	Refer to equivalent circuit of input buffers.		5						0.53	0.16	1.19	0.14

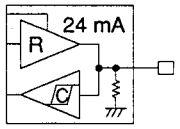
• GND noise reduction buffers (I_{OL} = 24 mA) (cont)

Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Input Name	Output Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
CMOS-level I/O buffer	Refer to equivalent circuit of three-state output.	—	3			D2	E		2.38	0.017	4.00	0.030
							D		2.18		3.80	
ICO5R	Refer to equivalent circuit of input buffers.		5						0.65	0.17	0.82	0.14
TTL-level I/O buffer with Schmitt-trigger	Refer to equivalent circuit of three-state output.	—	3			D2	E		2.38	0.017	4.00	0.030
							D		2.18		3.80	
ITSO5R	Refer to equivalent circuit of input buffers.		5						0.83	0.22	1.57	0.27
CMOS-level I/O buffer with Schmitt-trigger	Refer to equivalent circuit of three-state output.	—	3			D2	E		2.38	0.017	4.00	0.030
							D		2.18		3.80	
ICSO5R	Refer to equivalent circuit of input buffers.		5						0.96	0.26	1.34	0.26
Three-state output buffer with pull-up		—	3			D2	E		2.38	0.017	4.00	0.030
							D		2.18		3.80	
OZ5RU			5									
Three-state output buffer with pull-down		—	3			D2	E		2.38	0.017	4.00	0.030
							D		2.18		3.80	
OZ5RD			5									
Open-drain output buffer with pull-up		—	2			D2			(t_{olz}) 3.06	(K_{lz}) —	(t_{ozl}) 6.30	(K_{zl}) 0.037
ODN5RU												
TTL-level I/O buffer with pull-up	Refer to equivalent circuit of three-state output.	—	3			D2	E		2.38	0.017	4.00	0.030
							D		2.18		3.80	
ITO5RU	Refer to equivalent circuit of input buffers.		5						0.53	0.16	1.19	0.14

• GND noise reduction buffers (I_{OL} = 24 mA) (cont)

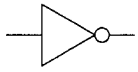
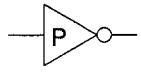
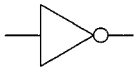
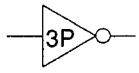
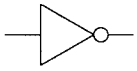
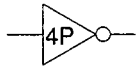
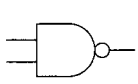
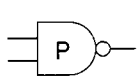
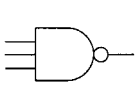
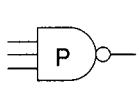
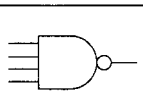
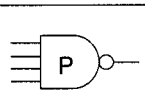
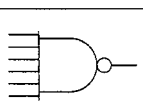
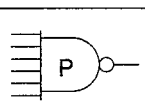
Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Symbol No.	Input Name	Output Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
TTL-level I/O buffer with pull-down ITO5RD	Refer to equivalent circuit of three-state output.	—	3			D2	E		2.38	0.017	4.00	0.030
							D		2.18		3.80	
	Refer to equivalent circuit of input buffers.		5						0.53	0.16	1.19	0.14
CMOS-level I/O buffer with pull-up ICO5RU	Refer to equivalent circuit of three-state output.	—	3			D2	E		2.38	0.017	4.00	0.030
							D		2.18		3.80	
	Refer to equivalent circuit of input buffers.		5						0.65	0.17	0.82	0.14
CMOS-level I/O buffer with pull-down ICO5RD	Refer to equivalent circuit of three-state output.	—	3			D2	E		2.38	0.017	4.00	0.030
							D		2.18		3.80	
	Refer to equivalent circuit of input buffers.		5						0.65	0.17	0.82	0.14
TTL-level Schmitt-trigger I/O buffer with pull-up ITSO5RU	Refer to equivalent circuit of three-state output.	—	3			D2	E		2.38	0.017	4.00	0.030
							D		2.18		3.80	
	Refer to equivalent circuit of input buffers.		5						0.83	0.22	1.57	0.27
TTL-level Schmitt-trigger I/O buffer with pull-down ITSO5RD	Refer to equivalent circuit of three-state output.	—	3			D2	E		2.38	0.017	4.00	0.030
							D		2.18		3.80	
	Refer to equivalent circuit of input buffers.		5						0.83	0.22	1.57	0.27
CMOS-level Schmitt-trigger I/O buffer with pull-up ICSO5RU	Refer to equivalent circuit of three-state output.	—	3			D2	E		2.38	0.017	4.00	0.030
							D		2.18		3.80	
	Refer to equivalent circuit of input buffers.		5						0.96	0.26	1.34	0.26

• GND noise reduction buffers (I_{OL} = 24 mA) (cont)

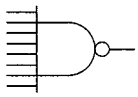
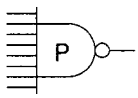
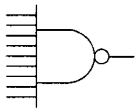
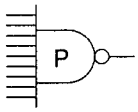
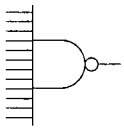
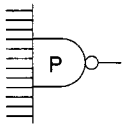
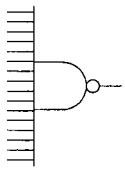
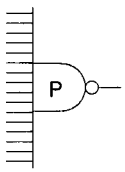
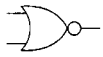
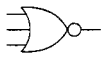
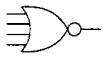
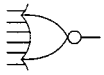
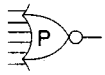
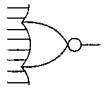
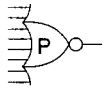
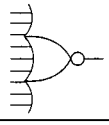
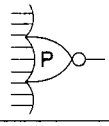
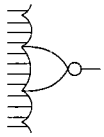
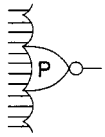
Macro							Delay					
									t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
CMOS-level Schmitt-trigger I/O buffer with pull-down ICSO5RD	Refer to equivalent circuit of three-state output.	—	3			D2	E		2.38	0.017	4.00	0.030
							D		2.18		3.80	
	Refer to equivalent circuit of input buffers.		5						0.96	0.26	1.34	0.26

Note: Propagation delay constant from anable terminals (E) as three-state output responds to $t_{olh} \rightarrow t_{olz}$ or t_{ozh}, and $t_{ohl} \rightarrow t_{ohz}$ or t_{ozl}.

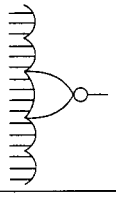
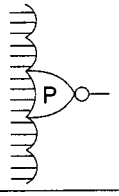
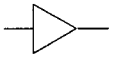
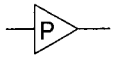
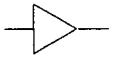
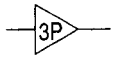
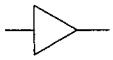
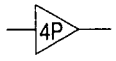
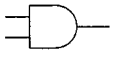
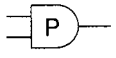
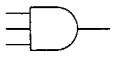
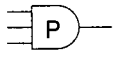
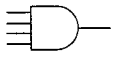
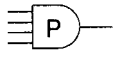
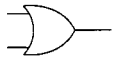
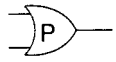
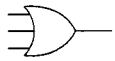
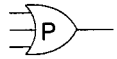
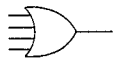
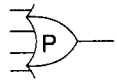
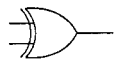
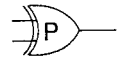
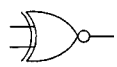
Power Gates

Macro						Delay			
						t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equivalent Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
Power inverter NAP1		1	2	@		0.18	0.30	0.30	0.30
Power inverter NA3P		2	3	@		0.19	0.24	0.31	0.24
Power inverter NA4P		2	4	@		0.20	0.18	0.32	0.18
2-input power NAND NAP2		2	2	@		0.16	0.30	0.20	0.42
3-input power NAND NAP3		3	2	@		0.18	0.30	0.22	0.58
4-input power NAND NAP4		4	2	@		0.20	0.30	0.25	0.70
6-input power NAND NAP6		5	1	@		0.48	0.30	0.85	0.30

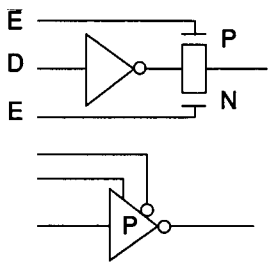
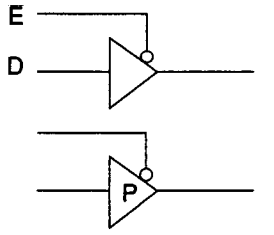
Power Gates (cont)

Macro						Delay			
						t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equivalent Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
8-input power NAND NAP8		7	1	@		0.52	0.30	0.95	0.30
9-input power NAND NAP9		7	1	@		0.52	0.30	0.95	0.30
12-input power NAND NAP-12		9	1	@		0.52	0.30	1.28	0.30
16-input power NAND NAP16		13	1	@		0.52	0.30	0.88	0.42
2-input NOR NRP2		2	2	#		0.28	0.50	0.24	0.30
3-input NOR NRP3		3	2	#		0.30	0.74	0.26	0.30
4-input NOR NRP4		4	2	#		0.32	0.98	0.28	0.30
6-input NOR NRP6		5	1	#		0.74	0.30	0.55	0.30
8-input NOR NRP8		7	1	#		0.90	0.30	0.55	0.30
9-input NOR NRP9		7	1	#		0.90	0.30	0.55	0.30
12-input NOR NRP12		9	1	#		1.02	0.30	0.58	0.30

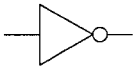
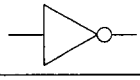
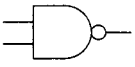
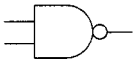
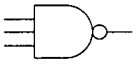
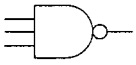
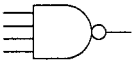
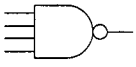
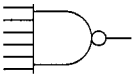
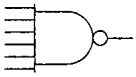
Power Gates (cont)

Macro						Delay			
						t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equivalent Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
16-input NOR NRP16		13	1	#		1.00	0.50	0.62	0.30
Power buffer ANP		2	1	@		0.20	0.30	0.38	0.30
Power buffer AN3P		3	2	@		0.20	0.24	0.34	0.24
Power buffer AN4P		3	2	@		0.22	0.18	0.36	0.18
2-input power AND ANP2		2	1	@		0.46	0.30	0.38	0.30
3-input power AND ANP3		3	1	@		0.50	0.30	0.40	0.30
4-input power AND ANP4		3	1	@		0.58	0.30	0.42	0.30
2-input power OR ORP2		2	1	#		0.52	0.30	0.46	0.30
3-input power OR ORP3		3	1	#		0.57	0.30	0.52	0.30
4-input power OR ORP4		3	1	#		0.64	0.30	0.62	0.30
2-input power EOR EORP		4	2	#		0.37	0.50	0.50	0.42
2-input power ENOR ENRP		4	2	#		0.37	0.50	0.48	0.42

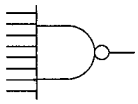
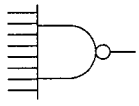
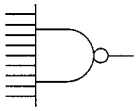
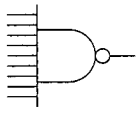
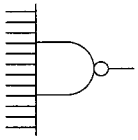
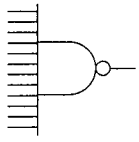
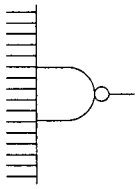
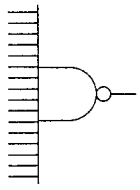
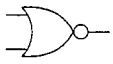
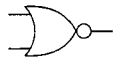
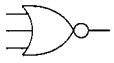
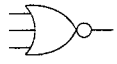
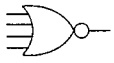
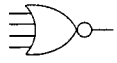
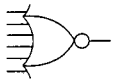
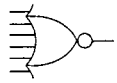
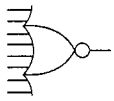
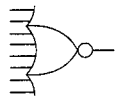
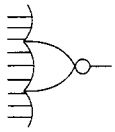
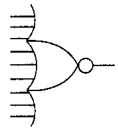
Three-State Power Gates

Macro					Delay					
							t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equivalent Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
3-state power inverter (internal) NAZP		2	0.5 0.5 2	– – @	D E/$\overline{E}$		0.58 0.28	0.40	0.44 0.40	0.38
3-state power buffer (internal) ANZP		4	2 2	# @	D $\overline{E}$		0.50 0.60	0.30	0.40 0.50	0.30

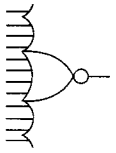
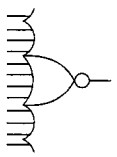
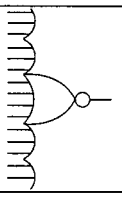
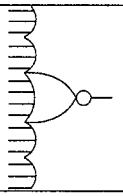
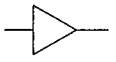
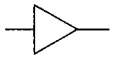
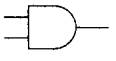
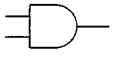
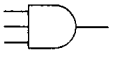
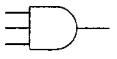
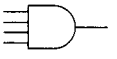
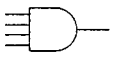
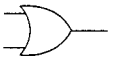
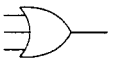
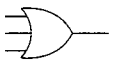
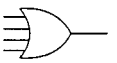
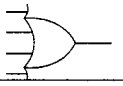
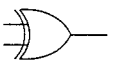
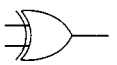
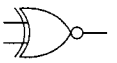
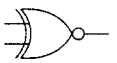
Gates

Macro						Delay			
						t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equivalent Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
Inverter NA1		1	1	@		0.16	0.50	0.28	0.50
2-input NAND NA2		1	1	@		0.18	0.50	0.30	0.76
3-input NAND NA3		2	1	@		0.22	0.50	0.32	1.08
4-input NAND NA4		2	1	@		0.24	0.50	0.34	1.36
6-input NAND NA6		5	1	@		0.38	0.50	0.75	0.50

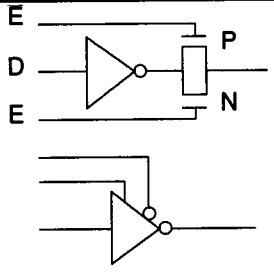
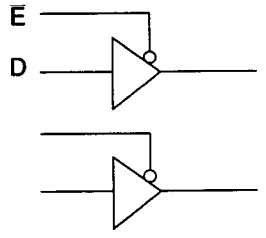
Gates (cont)

Macro						Delay			
						t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equivalent Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
8-input NAND NA8		6	1	@		0.42	0.50	0.85	0.50
9-input NAND NA9		7	1	@		0.42	0.50	0.85	0.50
12-input NAND NA12		8	1	@		0.42	0.50	1.18	0.50
16-input NAND NA16		11	1	@		0.42	0.50	0.78	0,76
2-input NOR NR2		1	1	#		0.20	0.92	0.38	0.50
3-input NOR NR3		2	1	#		0.22	1.34	0.43	0.50
4-input NOR NR4		2	1	#		0.24	1.80	0.50	0.50
6-input NOR NR6		5	1	#		0.64	0.50	0.45	0.50
8-input NOR NR8		6	1	#		0.80	0.50	0.45	0.50
9-input NOR NR9		7	1	#		0.80	0.50	0.45	0.50

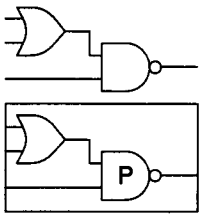
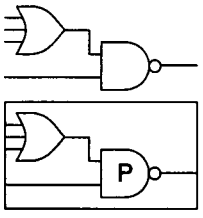
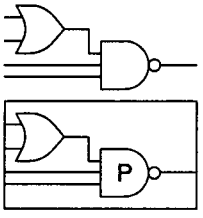
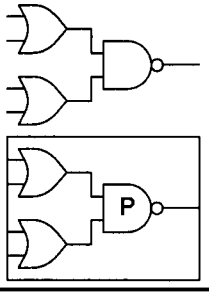
Gates (cont)

Macro						Delay			
						t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equivalent Circuit	Equiv. Gate Count	LV	Clamp Level when Open	Symbol	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
12-input NOR NR12		8	1	#		0.92	0.50	0.48	0.50
16-input NOR NR16		11	1	#		0.90	0.92	0.52	0.50
Buffer AN1		1	1	@		0.34	0.50	0.26	0.50
2-input AND AN2		2	1	@		0.36	0.50	0.28	0.50
3-input AND AN3		2	1	@		0.40	0.50	0.30	0.50
4-input AND AN4		3	1	@		0.48	0.50	0.32	0.50
2-input OR OR2		2	1	#		0.42	0.50	0.36	0.50
3-input OR OR3		2	1	#		0.47	0.50	0.42	0.50
4-input OR OR4		3	1	#		0.54	0.50	0.52	0.50
2-input EOR EOR		3	2	#		0.27	0.92	0.40	0.76
2-input ENOR ENR		3	2	#		0.27	0.92	0.38	0.76

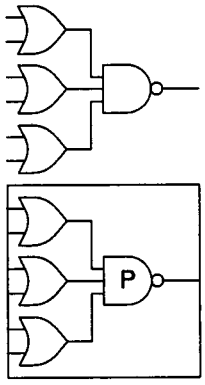
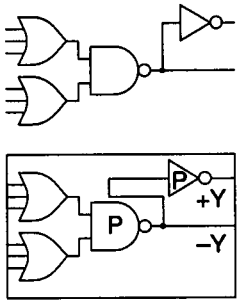
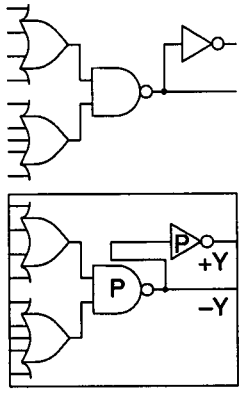
Three-State Gates

Macro					Delay					
							t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equivalent Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
3-state inverter (internal) NAZ		1	0.5 0.5 1	@	D E/E		0.48 0.18	0.65	0.34 0.30	0.62
3-state buffer (internal) ANZ		3	2 2	# @	D E		0.40 0.50	0.50	0.30 0.40	0.50

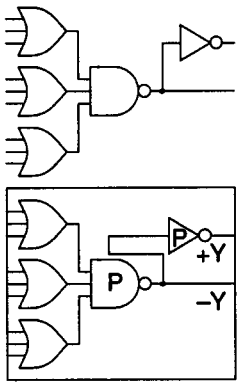
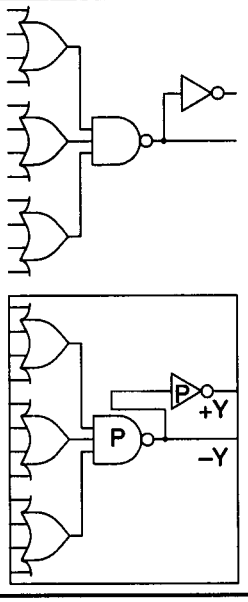
AND-NOR, OR-NAND Power Gates

Macro						Delay					
								t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
2-OR NAND NAR23P		3	2	# # @	A1	OR NAND		0.33 0.33	0.50	0.48 0.48	0.42
3-OR NAND NAR34P		4	2	# # # @	A2	OR NAND		0.40 0.40	0.74	0.48 0.48	0.42
2-OR 3-NAND NAR24P		4	2	# # @ @	A2	OR NAND		0.40 0.40	0.50	0.48 0.48	0.58
2-wide, 2-input OR-NAND NA2R2P		4	2	# # # #	A1			0.40	0.50	0.53	0.42

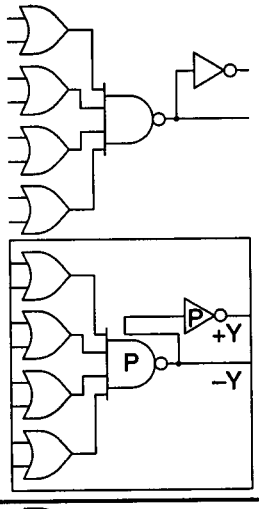
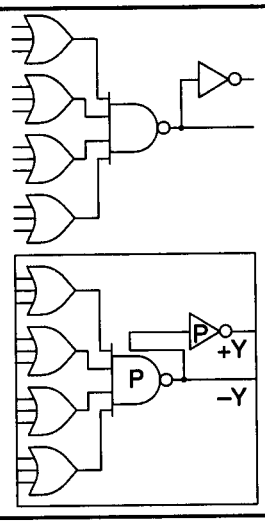
AND-NOR, OR-NAND Power Gates (cont)

Macro						Delay					
								t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
3-wide, 2-input OR-NAND NA3R2P		6	2	# # # # # #	A3			0.42	0.50	0.60	0.58
2-wide, 3-input OR-NAND NA2R3NP		7	2	# # # # # #	A2		+Y	0.72	0.30	0.97	0.30
							–Y	0.77	0.74	0.57	0.42
2-wide, 4-input OR-NAND NA2R4NP		9	2	# # # # # # # #	A4		+Y	0.72	0.30	1.00	0.30
							–Y	0.80	0.98	0.57	0.42

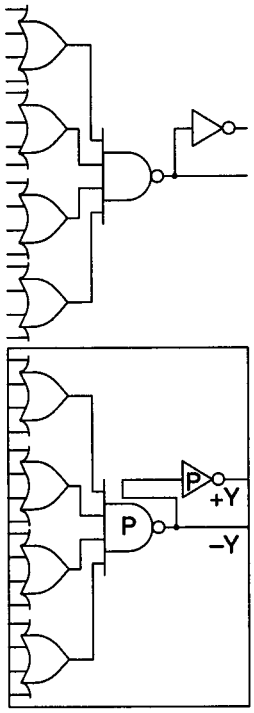
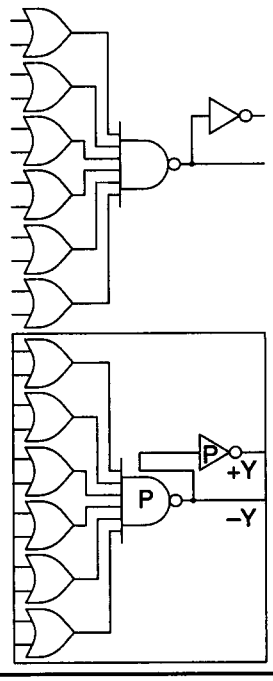
AND-NOR, OR-NAND Power Gates (cont)

Macro						Delay					
								t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
3-wide, 3-input OR-NAND NA3R3NP		10	2	# # # # # # # # # #			+Y	0.79	0.30	1.00	0.30
							–Y	0.80	0.74	0.64	0.58
3-wide, 4-input OR-NAND NA3R4NP		13	2	# # # # # # # # # # # #			+Y	0.79	0.30	1.28	0.30
							–Y	1.08	0.98	0.64	0.58

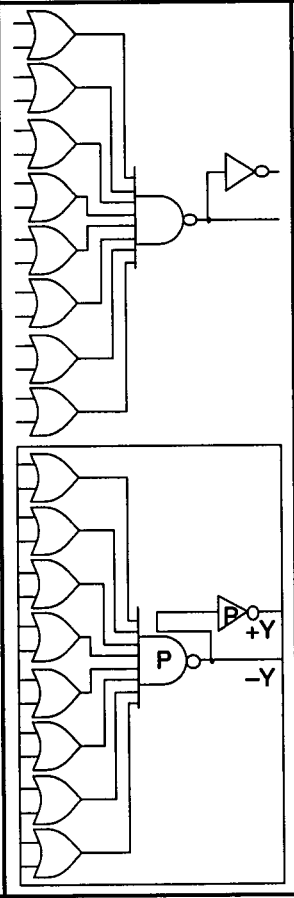
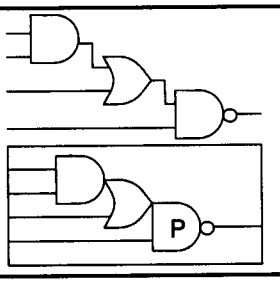
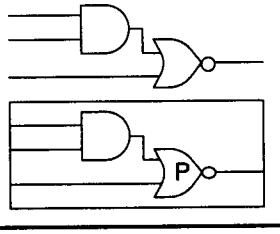
AND-NOR, OR-NAND Power Gates (cont)

Macro						Delay					
								t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
4-wide, 2-input OR-NAND NA4R2NP		10	2	@ @ @ @ @ @ @ @	A4		+Y	0.75	0.30	0.77	0.30
							–Y	0.57	0.50	0.60	0.70
4-wide, 3-input OR-NAND NA4R3NP		13	2	# # # # # # # # # # # # #			+Y	0.95	0.30	1.28	0.30
							–Y	1.08	0.74	0.80	0.70

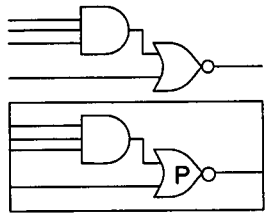
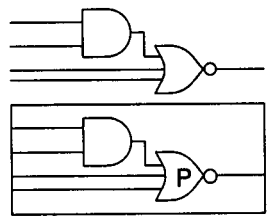
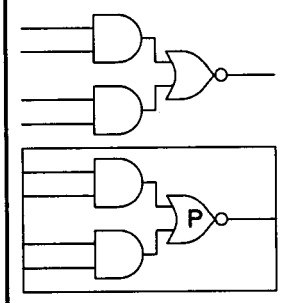
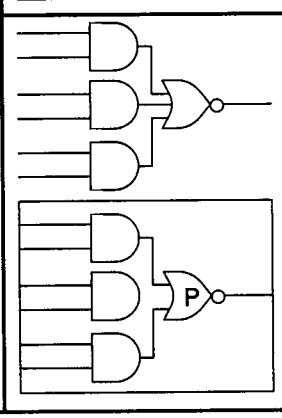
AND-NOR, OR-NAND Power Gates (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
4-wide, 4-input OR-NAND NA4R4NP		17	2	# # # # # # # # # # # # # # # # #	A5		+Y	1.02	0.30	1.57	0.30
							–Y	1.37	0.98	0.87	0.70
6-wide, 2-input OR-NAND NA6R2NP		9	1	@ @ @ @ @ @ @ @ @ @ @ @ @			+Y	0.70	0.50	0.67	0.30
							–Y	0.82	0.30	0.90	0.30

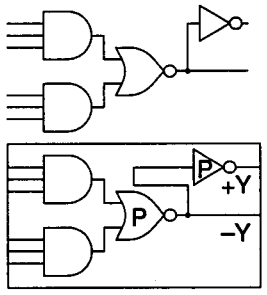
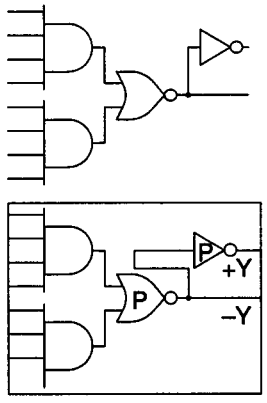
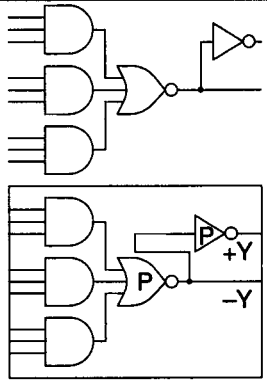
AND-NOR, OR-NAND Power Gates (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	In-put Name	Out-put Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
8-wide, 2-input OR-NAND NA8R2NP		12	1	@ @ @ @ @ @ @ @ @ @ @ @ @ @	A5		+Y	0.73	0.74	0.67	0.30
							–Y	0.82	0.30	0.93	0.30
2-AND-OR-NAND NARA24P		4	2	@ @ # @	A1	AND		0.33	0.50	0.53	0.58
						OR		0.33		0.53	
						NAND		0.33		0.40	
2-AND-NOR NRA23P		3	2	@ @ #	A1	AND		0.37	0.50	0.50	0.42
						NOR		0.36		0.50	

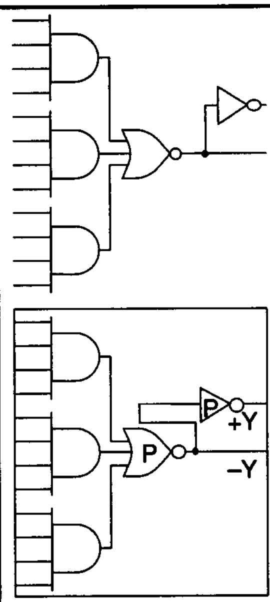
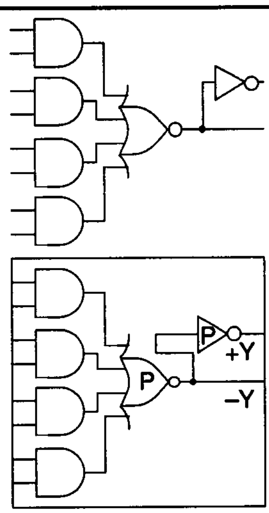
AND-NOR, OR-NAND Power Gates (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	In-put Name	Out-put Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
3-AND-NOR NRA34P		4	2	@ @ @ #	A2	AND NOR		0.37 0.36	0.50	0.50 0.50	0.58
2-AND-3-NOR NRA24P		4	2	@ @ # #	A2	AND NOR		0.38 0.38	0.74	0.50 0.50	0.42
2-wide 2-input AND-NOR NR2A2P		4	2	@ @ @ @	A1			0.40	0.50	0.53	0.42
3-wide 2-input AND-NOR NR3A2P		6	2	@ @ @ @ @ @	A3			0.46	0.74	0.60	0.42

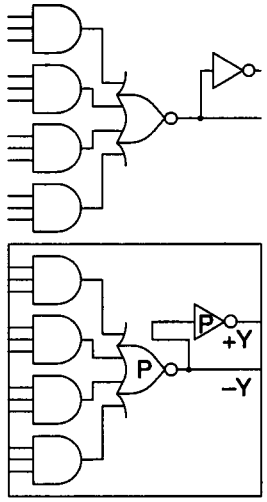
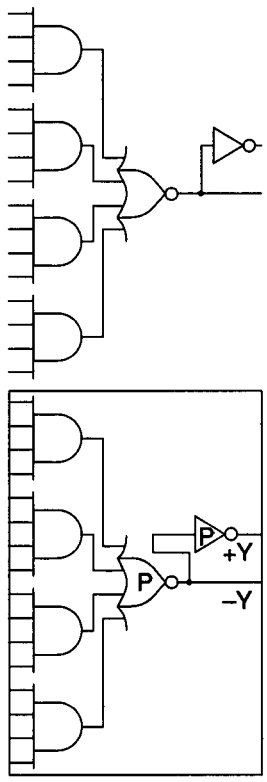
AND-NOR, OR-NAND Power Gates (cont)

Macro						Delay					
								t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
2-wide 3-input AND-NOR NR2A3NP		7	2	@ @ @ @ @ @	A2		+Y	1.05	0.30	0.60	0.30
							–Y	0.40	0.50	0.90	0.58
2-wide 4-input AND-NOR NR2A4NP		9	2	@ @ @ @ @ @ @ @	A4		+Y	1.05	0.30	0.60	0.30
							–Y	0.40	0.50	0.90	0.70
3-wide 3-input AND-NOR NR3A3NP		10	2	@ @ @ @ @ @ @ @ @			+Y	1.08	0.30	0.80	0.30
							–Y	0.60	0.74	0.93	0.58

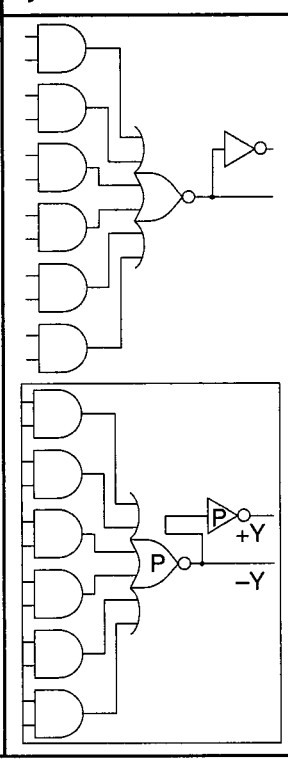
AND-NOR, OR-NAND Power Gates (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	In-put Name	Out-put Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
3-wide 4-input AND-NOR NR3A4NP		13	2	@ @ @ @ @ @ @ @ @ @ @ @			+Y	1.15	0.30	1.00	0.30
							−Y	0.80	0.74	1.00	0.70
4-wide 2-input AND-NOR NR4A2NP		9	2	# # # # # # # #	A4		+Y	0.82	0.30	0.77	0.30
							−Y	0.57	0.98	0.67	0.42

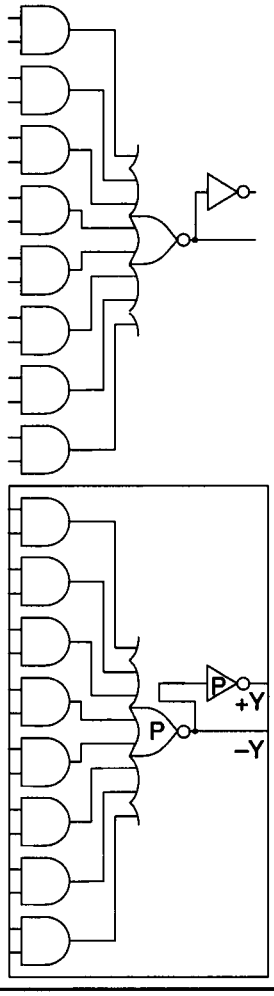
AND-NOR, OR-NAND Power Gates (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	In-put Name	Out-put Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
4-wide 3-input AND-NOR NR4A3NP		13	2	@ @ @ @ @ @ @ @ @ @ @ @			+Y	0.85	0.30	0.80	0.30
							–Y	0.60	0.98	0.70	0.58
4-wide 4-input AND-NOR NR4A4NP		17	2	@ @ @ @ @ @ @ @ @ @ @ @ @	A5		+Y	1.25	0.30	1.02	0.30
							–Y	0.82	0.98	1.10	0.70

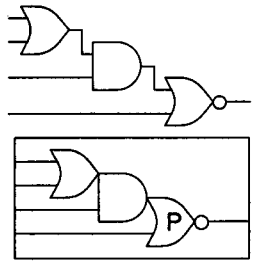
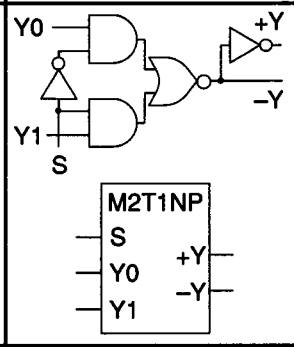
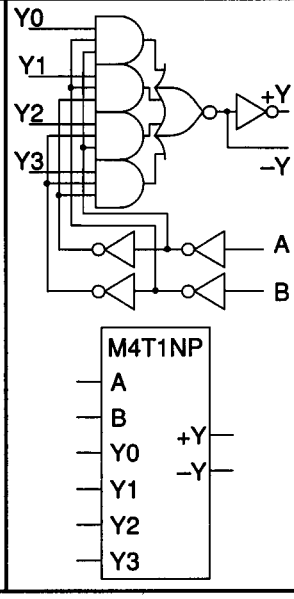
AND-NOR, OR-NAND Power Gates (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	In-put Name	Out-put Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
6-wide 2-input AND-NOR NR6A2NP		9	1	# # # # # # # # # # # #			+Y	0.80	0.30	0.75	0.30
							–Y	0.90	0.30	1.00	0.30

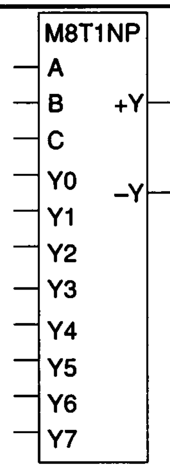
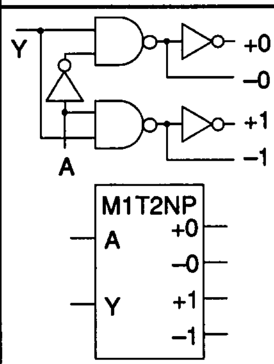
AND-NOR, OR-NAND Power Gates (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
8-wide 2-input AND-NOR NR8A2NP		12	1	# # # # # # # # # # # # # # # # #	A5		+Y	0.90	0.30	1.08	0.30
							–Y	0.88	0.30	0.75	0.30

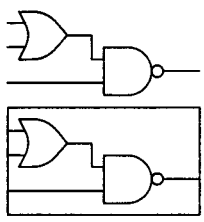
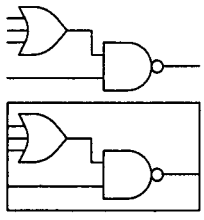
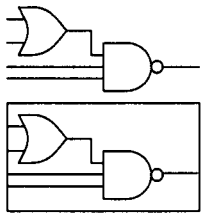
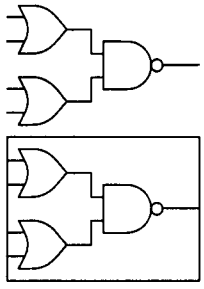
AND-NOR, OR-NAND Power Gates (cont)

Macro						Delay					
								t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
2-OR-AND-NOR NRAR24P		4	2	# # @ #	A1	OR AND NOR		0.56 0.50 0.40	0.74	0.54 0.48 0.42	0.42
2-to-1 multiplexer M2T1NP		6	2 2 2	# # #	B2	Y0 Y1 S	+Y	0.83 0.83 0.98	0.30	0.55 0.55 0.88	0.30
						Y0 Y1 S	–Y	0.40 0.40 0.73	0.50	0.63 0.63 0.78	0.42
4-to-1 multiplexer M4T1NP		15	1 1 2 2 2 2	# # # # # #	B4	Y0 Y1 Y2 Y3 A B	+Y	1.20 1.20 1.20 1.20 1.40 1.40	0.30	0.82 0.82 0.82 0.82 1.25 1.25	0.30
						Y0 Y1 Y2 Y3 A B	–Y	0.67 0.67 0.67 0.67 1.10 1.10	0.98	1.00 1.00 1.00 1.00 1.20 1.20	0.58

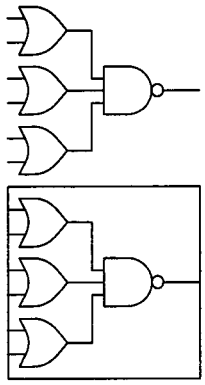
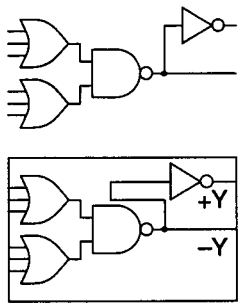
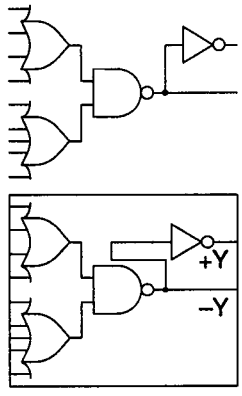
AND-NOR, OR-NAND Power Gates (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
8-to-1 multiplexer M8T1NP		23	1	# # # # # # # # # # #	B6	Y0–Y7	+Y	1.37	0.30	1.30	0.58
						A		2.10		1.83	
						B					
						C					
						Y0–Y7	–Y	1.45	0.30	1.57	0.30
						A		1.98		2.30	
						B					
						C					
1-to-2 demultiplexer M1T2NP		7	2 4	# @	B3	Y	+0	0.62	0.30	0.63	0.30
						A		0.69		0.70	
						Y	+1	0.62	0.30	0.63	0.30
						A		0.62		0.63	
						Y	–0	0.43	0.30	0.47	0.42
						A		0.50		0.54	
						Y	–1	0.43	0.30	0.47	0.42
						A		0.43		0.47	

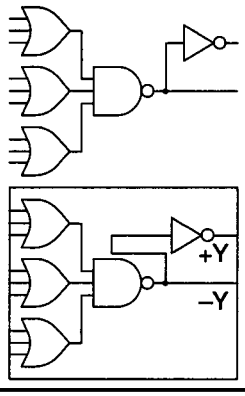
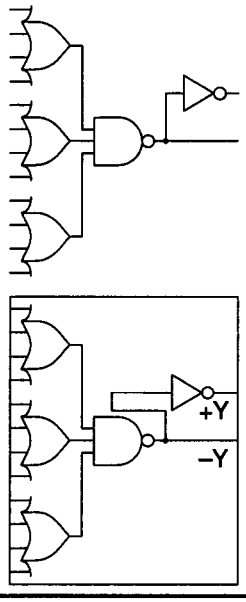
AND-NOR, OR-NAND Gates (Normal)

Macro						Delay					
								t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
2-OR NAND NAR23		2	1	# # @	A1	OR NAND		0.23 0.23	0.92	0.38 0.38	0.76
3-OR NAND NAR34		2	1	# # # @	A2	OR NAND		0.30 0.30	1.34	0.38 0.38	0.76
2-OR 3-NAND NAR24		2	1	# # @ @	A2	OR NAND		0.30 0.30	0.92	0.38 0.38	1.08
2-wide, 2-input OR-NAND NA2R2		2	1	# # # #	A1			0.30	0.92	0.43	0.76

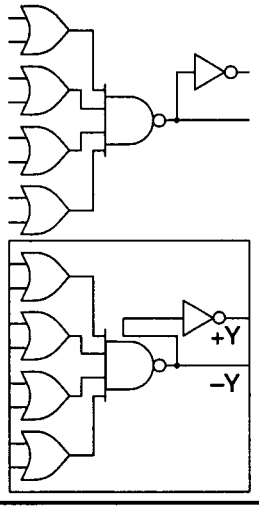
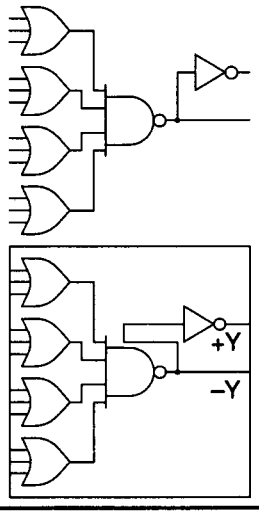
AND-NOR, OR-NAND Gates (Normal) (cont)

Macro						Delay					
								t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
3-wide, 2-input OR-NAND NA3R2		3	1	# # # # # #	A3			0.32	0.92	0.50	1.08
2-wide, 3-input OR-NAND NA2R3N		4	1	# # # # # #	A2		+Y	0.62	0.50	0.87	0.50
							–Y	0.67	1.34	0.47	0.76
2-wide, 4-input OR-NAND NA2R4N		5	1	# # # # # # # #	A4		+Y	0.62	0.50	0.90	0.50
							–Y	0.70	1.80	0.47	0.76

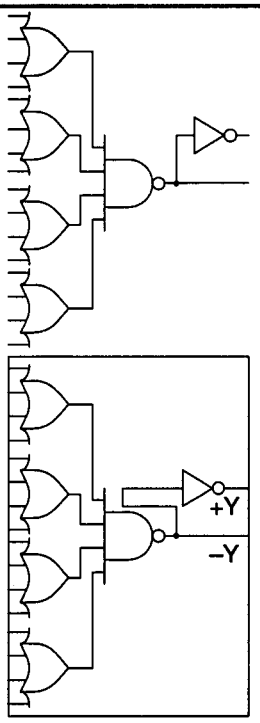
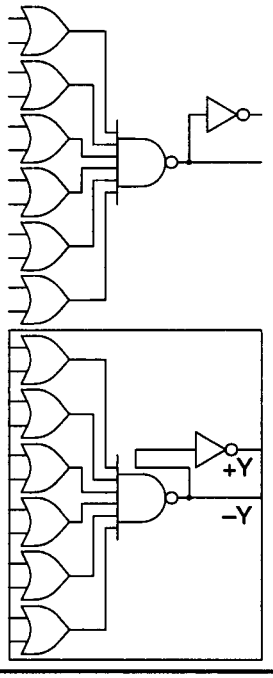
AND-NOR, OR-NAND Gates (Normal) (cont)

Macro						Delay					
								t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
3-wide, 3-input OR-NAND NA3R3N		5	1	# # # # # # # # #			+Y	0.69	0.50	0.90	0.50
							–Y	0.70	1.34	0.54	1.08
3-wide, 4-input OR-NAND NA3R4N		7	1	# # # # # # # # # # #			+Y	0.69	0.50	1.18	0.50
							–Y	0.98	1.80	0.54	1.08

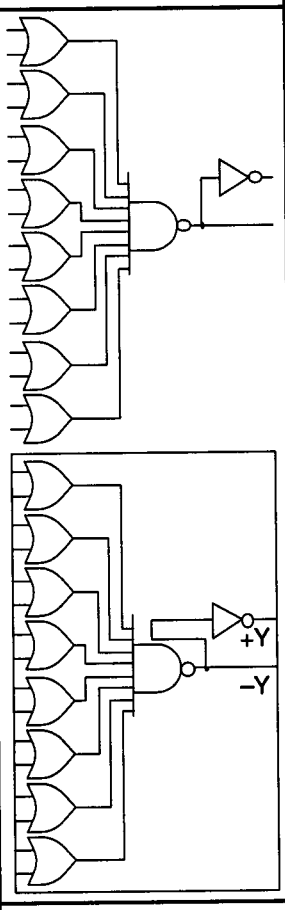
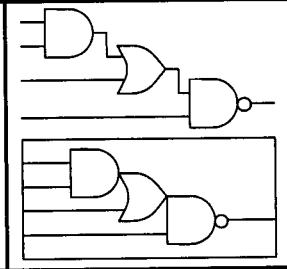
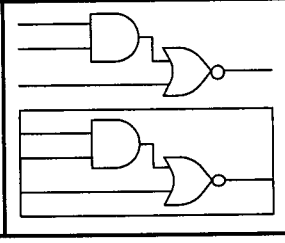
AND-NOR, OR-NAND Gates (Normal) (cont)

Macro						Delay					
								t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
4-wide, 2-input OR-NAND NA4R2N		5	1	@ @ @ @ @ @ @ @	A4		+Y	0.65	0.50	0.67	0.50
							–Y	0.47	0.92	0.50	1.36
4-wide, 3-input OR-NAND NA4R3N		7	1	# # # # # # # # # # # #			+Y	0.85	0.50	1.18	0.50
							–Y	0.98	1.34	0.70	1.36

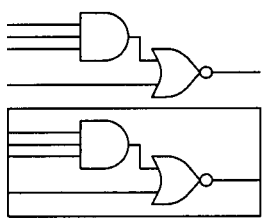
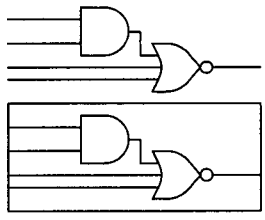
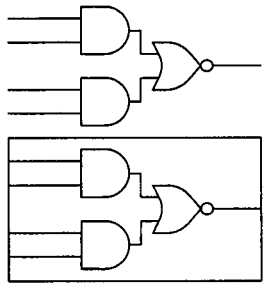
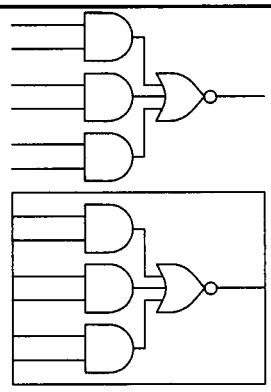
AND-NOR, OR-NAND Gates (Normal) (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	In-put Name	Out-put Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
4-wide, 4-input OR-NAND NA4R4N		9	1	# # # # # # # # # # # # # # # # #	A5		+Y	0.92	0.50	1.47	0.50
							–Y	1.27	1.80	0.77	1.36
6-wide, 2-input OR-NAND NA6R2N		8	1	@ @ @ @ @ @ @ @ @ @ @ @			+Y	0.60	0.92	0.57	0.50
							–Y	0.72	0.50	0.80	0.50

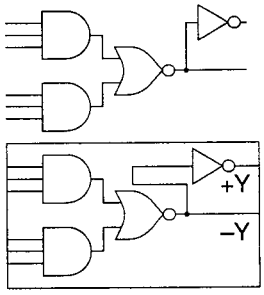
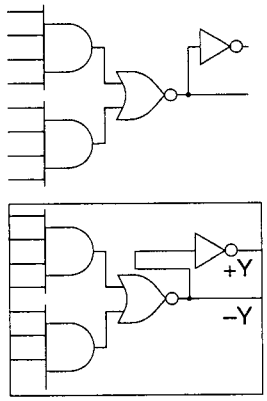
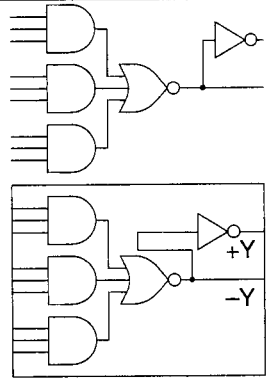
AND-NOR, OR-NAND Gates (Normal) (cont)

Macro						Delay					
								t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
8-wide, 2-input OR-NAND NA8R2N		10	1	@ @ @ @ @ @ @ @ @ @ @ @ @	A5		+Y	0.63	1.34	0.57	0.50
							–Y	0.72	0.50	0.83	0.50
2-AND-OR-NAND NARA24		2	1	@ @ # @	A1	AND		0.23	0.92	0.43	1.08
						OR		0.23		0.43	
						NAND		0.23		0.30	
2-AND-NOR NRA23		2	1	@ @ #	A1	AND		0.27	0.92	0.40	0.76
						NOR		0.26		0.40	

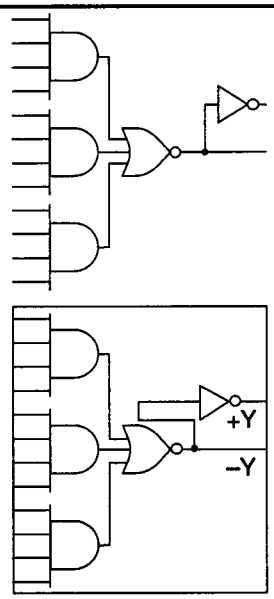
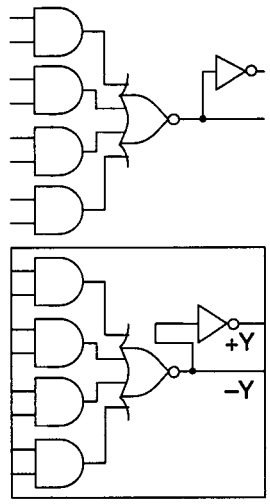
AND-NOR, OR-NAND Gates (Normal) (cont)

Macro						Delay					
								t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
3-AND-NOR NRA34		2	1	@ @ @ #	A2	AND NOR		0.27 0.26	0.92	0.40 0.40	1.08
2-AND-3-NOR NRA24		2	1	@ @ # #	A2	AND NOR		0.28 0.28	1.34	0.40 0.40	0.76
2-wide, 2-input AND-NOR NR2A2		2	1	@ @ @ @	A1			0.30	0.92	0.43	0.76
3-wide, 2-input AND-NOR NR3A2		3	1	@ @ @ @ @ @	A3			0.36	1.34	0.50	0.76

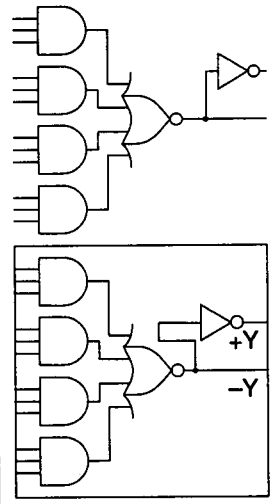
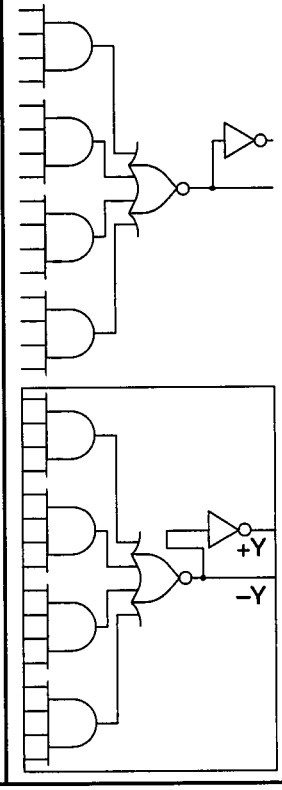
AND-NOR, OR-NAND Gates (Normal) (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	In-put Name	Out-put Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
2-wide, 3-input AND-NOR NR2A3N		4	1	@ @ @ @ @ @	A2		+Y	0.95	0.50	0.50	0.50
							–Y	0.30	0.92	0.80	1.08
2-wide, 4-input AND-NOR NR2A4N		5	1	@ @ @ @ @ @ @ @	A4		+Y	0.98	0.50	0.60	0.50
							–Y	0.40	0.92	0.83	1.36
3-wide, 3-input AND-NOR NR3A3N		5	1	@ @ @ @ @ @ @ @ @			+Y	0.98	0.50	0.70	0.50
							–Y	0.50	1.34	0.83	1.08

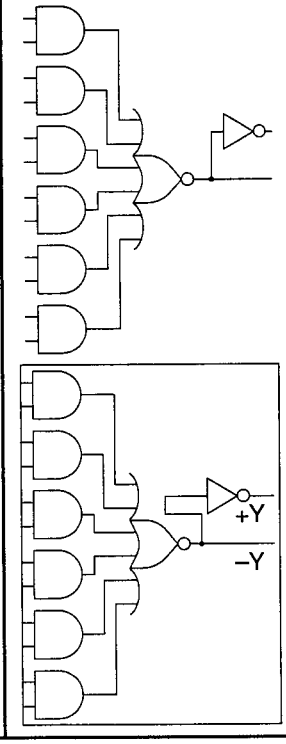
AND-NOR, OR-NAND Gates (Normal) (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
3-wide 4-input AND-NOR NR3A4N		7	1	@ @ @ @ @ @ @ @ @ @ @ @			+Y	1.05	0.50	0.90	0.50
							–Y	0.70	1.34	0.90	1.36
4-wide 2-input AND-NOR NR4A2N		5	1	# # # # # # # #	A4		+Y	0.72	0.50	0.67	0.50
							–Y	0.47	1.80	0.57	0.76

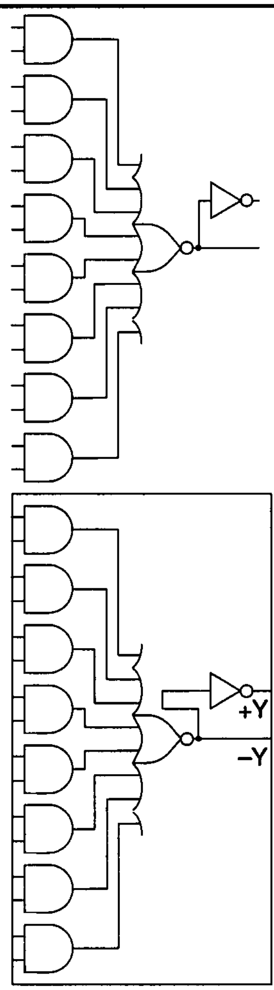
AND-NOR, OR-NAND Gates (Normal) (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	In-put Name	Out-put Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
4-wide 3-input AND-NOR NR4A3N		7	1	@ @ @ @ @ @ @ @ @ @ @ @			+Y	0.75	0.50	0.70	0.50
							–Y	0.50	1.80	0.60	1.34
4-wide 4-input AND-NOR NR4A4N		9	1	@ @ @ @ @ @ @ @ @ @ @ @ @ @ @ @ @	A5		+Y	1.15	0.50	0.92	0.50
							–Y	0.72	1.80	1.00	1.36

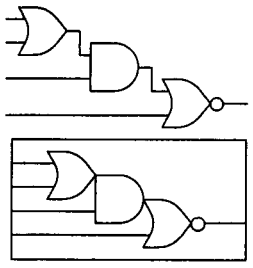
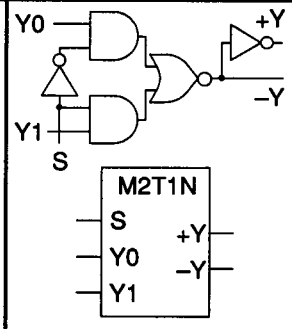
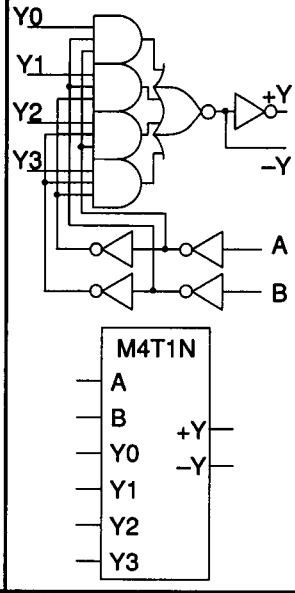
AND-NOR, OR-NAND Gates (Normal) (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	In-put Name	Out-put Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
6-wide 2-input AND-NOR NR6A2N		8	1	# # # # # # # # # # # #			+Y	0.70	0.50	0.65	0.50
							–Y	0.80	0.50	0.90	0.50

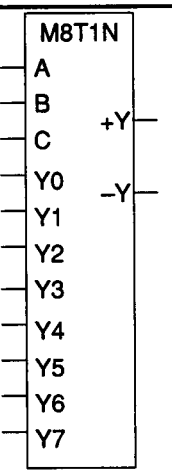
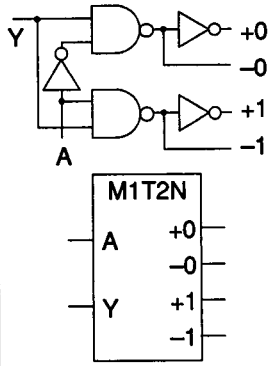
AND-NOR, OR-NAND Gates (Normal) (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
8-wide 2-input AND-NOR NR8A2N		10	1	# # # # # # # # # # # # # # # #	A5		+Y	0.80	0.50	0.98	0.50
							−Y	0.78	0.50	0.65	0.50

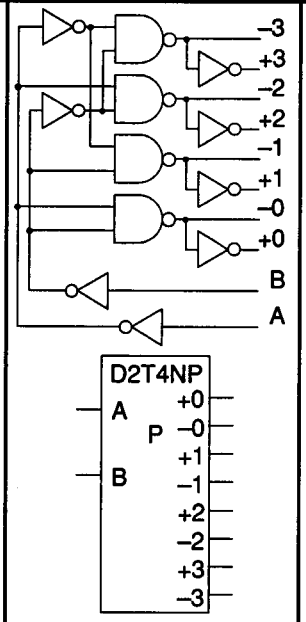
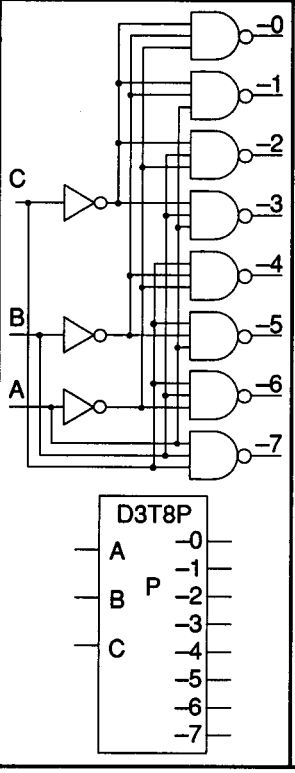
AND-NOR, OR-NAND Gates (Normal) (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
2-OR-AND-NOR NRAR24		2	1	# # @ #	A1	OR AND NOR		0.46 0.40 0.30	1.34	0.44 0.38 0.32	0.76
2-to-1 multiplexer M2T1N		3	2 1 1	# # #	B2	Y0 Y1 S Y0 Y1 S	+Y –Y 	0.73 0.73 0.88 0.30 0.30 0.63	0.50 0.92 	0.45 0.45 0.78 0.53 0.53 0.68	0.50 0.76
4-to-1 multiplexer M4T1N		9	1	# # # # # #	B4	Y0 Y1 Y2 Y3 A B Y0 Y1 Y2 Y3 A B	+Y –Y 	1.10 1.10 1.10 1.10 1.30 1.30 0.57 0.57 0.57 0.57 1.00 1.00	0.50 1.80 	0.72 0.72 0.72 0.72 1.15 1.15 0.90 0.90 0.90 0.90 1.10 1.10	0.50 1.08

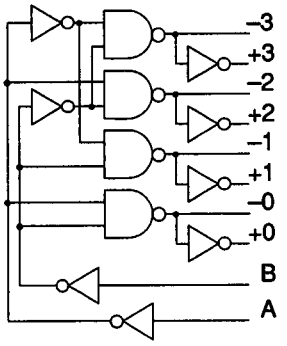
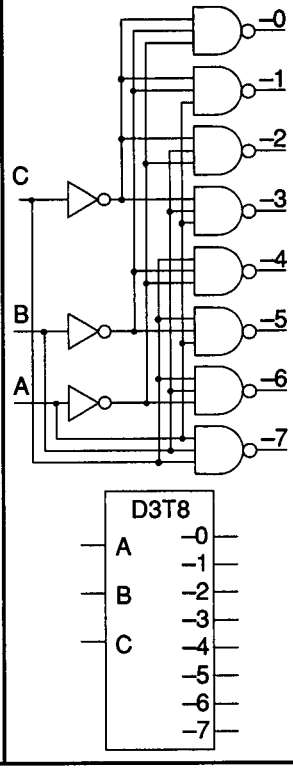
AND-NOR, OR-NAND Gates (Normal) (cont)

Macro						Delay					
								t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
8-to-1 multiplexer M8T1N		21	1	# # # # # # # # # # #	B6	Y0–Y7	+Y	1.27	0.50	1.20	1.08
						A		2.00		1.73	
						B					
						C					
						Y0–Y7	–Y	1.35	0.50	1.47	0.50
						A		1.88		2.20	
						B					
						C					
1-to-2 demultiplexer M1T2N		4	2	# @	B3	Y	+0	0.52	0.50	0.53	0.50
						A		0.59		0.60	
						Y	+1	0.52	0.50	0.53	0.50
						A		0.52		0.53	
						Y	–0	0.33	0.50	0.37	0.76
						A		0.40		0.44	
						Y	–1	0.33	0.50	0.37	0.76
						A		0.33		0.37	

Power Decoders

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
2-bit decoder D2T4NP		14	1	# #	B5	A	–0	0.58	0.30	0.62	0.42
						B		0.58		0.62	
						A	–1	0.70	0.30	0.80	0.42
						B		0.58		0.62	
						A	–2	0.58	0.30	0.62	0.42
						B		0.70		0.80	
						A	–3	0.70	0.30	0.80	0.42
						B		0.70		0.80	
						A	+0	0.77	0.30	0.78	0.30
						B		0.77		0.78	
						A	+1	0.95	0.30	0.90	0.30
						B		0.77		0.78	
						A	+2	0.77	0.30	0.78	0.30
						B		0.95		0.90	
						A	+3	0.95	0.30	0.90	0.30
						B		0.95		0.90	
3-bit decoder D3T8P		26	9	# # #	B5	A, B, C	–0 to –7	0.68	0.30	0.62	0.58

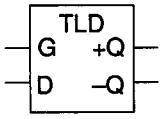
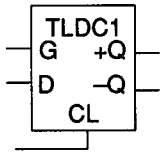
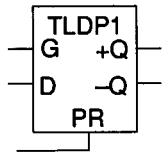
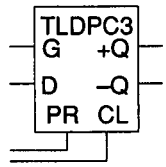
Decoders (Normal)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
2-bit decoder D2T4N		8	1	# #	B5	A	–0	0.48	0.50	0.52	0.76
						B		0.48		0.52	
						A	–1	0.60	0.50	0.70	0.76
						B		0.48		0.52	
						A	–2	0.48	0.50	0.52	0.76
						B		0.60		0.70	
						A	–3	0.60	0.50	0.70	0.76
						B		0.60		0.70	
						A	+0	0.67	0.50	0.68	0.50
						B		0.67		0.68	
						A	+1	0.85	0.50	0.80	0.50
						B		0.67		0.68	
						A	+2	0.67	0.50	0.68	0.50
						B		0.85		0.80	
						A	+3	0.85	0.50	0.80	0.50
						B		0.85		0.80	
3-bit decoder D3T8		14	5	# # #	B5	A, B, C	–0 to –7	0.58	0.50	0.52	1.08

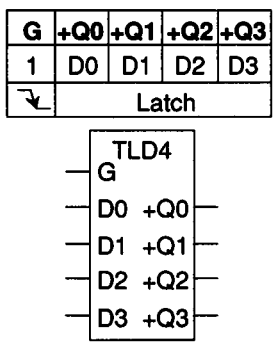
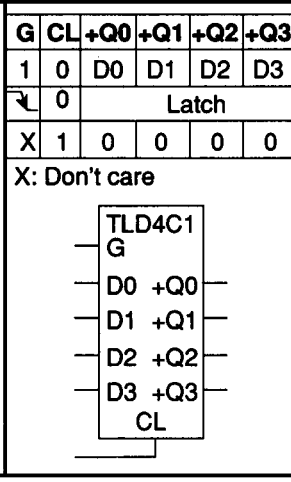
Latches (with Scan Function)

Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
RS latch TLRS0	SN RN +Q –Q 0 0 0 0 0 1 1 0 1 0 0 1 1 1 Latch	9	1	@ @	A3	$\overline{S}$ $\overline{R}$	+Q	1.30 1.16	0.50	— 1.00	0.42
						$\overline{S}$ R	–Q	1.16 1.30	0.50	1.00 —	0.42
RS latch TLRS3	S R +Q –Q 0 0 Latch 0 1 0 1 1 0 1 0 1 1 1 1	9	1	# #	A3	S R	+Q	1.00 —	0.50	1.30 1.37	0.42
						S R	–Q	— 1.00	0.50	1.37 1.30	0.42
2-input RS latch TLR2S20	SN RN +Q –Q 0 0 0 0 0 1 1 0 1 0 0 1 1 1 Latch	10	1	@ @ @ @	A4	$\overline{S}$ $\overline{R}$	+Q	1.37 1.30	0.50	— 1.05	0.42
						$\overline{S}$ R	–Q	1.30 1.37	0.50	1.05 —	0.42
2-input RS latch TLR2S23	S R +Q –Q 0 0 Latch 0 1 0 1 1 0 1 0 1 1 1 1	10	1	# #	A4	S R	+Q	1.05 —	0.50	1.37 1.51	0.42
						S R	–Q	— 1.05	0.50	1.51 1.37	0.42

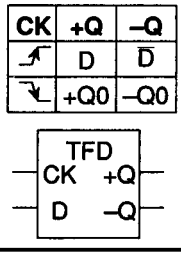
Latches (with Scan Function) (cont)

Function and Macro Name	Macro: Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Output Name	t_{plh} (ns) t_{olh}	K_{lh}	t_{phl} (ns) t_{ohl}	K_{hl}
D Latch TLD	G | +Q | –Q 1 | D | $\bar{D}$ ↘ | Latch 	6	1 1	@ @	C	G D	+Q	1.20 1.20	0.30	1.20 1.20	0.30
						G D	–Q	1.00 1.00	0.30	1.05 1.05	0.30
D Latch with CLR TLDC1	G | CL | +Q | –Q 1 | 0 | D | $\bar{D}$ ↘ | 0 | Latch X | 1 | 0 | 1 X: Don't care 	7	1 1 1	@ @ #	C	G D CL	+Q	1.30 1.30 0.85	0.30	1.20 1.20 0.80	0.30
						G D CL	–Q	1.00 1.00 0.60	0.30	1.15 1.15 0.70	0.30
D Latch with PRE TLDP1	G | PR | +Q | –Q 1 | 0 | D | $\bar{D}$ ↘ | 0 | Latch X | 1 | 1 | 0 X: Don't care 	7	1 1 1	@ @ #	C	G D PR	+Q	1.20 1.20 0.95	0.30	1.30 1.30 1.05	0.30
						G D PR	–Q	1.10 1.10 0.85	0.30	1.05 1.05 0.80	0.30
D Latch with CLR/PRE TLDPC3	G | PR | CL | +Q | –Q 1 | 0 | 0 | D | $\bar{D}$ ↘ | 0 | 0 | Latch X | 1 | 0 | 1 | 0 X | 0 | 1 | 0 | 1 X | 1 | 1 | 0 | 1 X: Don't care 	8	1 1 1 1	@ @ # #	C	G D PR CL	+Q	1.40 1.40 1.10 0.85	0.30	1.40 1.40 0.95 0.80	0.30
						G D PR CL	–Q	1.20 1.20 0.75 0.60	0.30	1.25 1.25 0.95 0.70	0.30

Latches (with Scan Function) (cont)

Function and Macro Name	Macro: Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Output Name	t_{plh} (ns) t_{olh}	t_{plh} (ns) K_{lh}	t_{phl} (ns) t_{ohl}	t_{phl} (ns) K_{hl}
4-bit latch TLD4		21	1 1 1 1 1	@ @ @ @ @	B4	G D0–D3	+Q0–+Q3	1.12 1.02	0.30	1.28 1.07	0.30
4-bit latch with CLR TLD4C1		27	1 1 1 1 1 1	@ @ @ @ @ # (CL)	B4	G D0–D3 CL	+Q0–+Q3	1.12 1.12 1.00	0.30	1.28 1.07 1.05	0.30

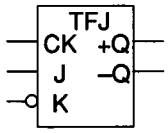
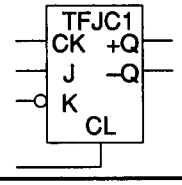
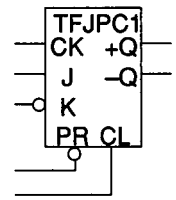
Flip-Flops (with Scan Function)

Function and Macro Name	Macro: Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Output Name	t_{plh} (ns) t_{olh}	t_{plh} (ns) K_{lh}	t_{phl} (ns) t_{ohl}	t_{phl} (ns) K_{hl}
D flip-flop TFD		8	1	@ @	C	CK	+Q –Q	1.24 1.10	0.30 0.30	1.30 1.09	0.30 0.30

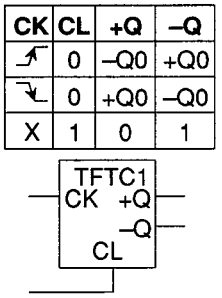
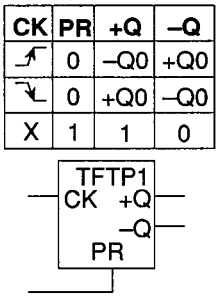
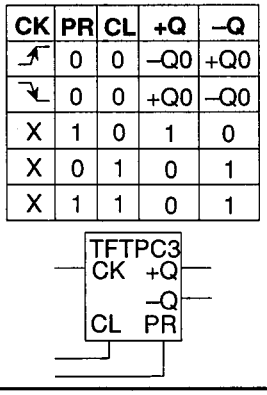
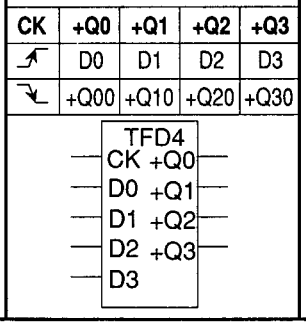
Flip-Flops (with Scan Function) (cont)

Function and Macro Name	Macro: Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: In-put Name	Out-put Name	t_{plh} (ns) t_{olh}	t_{plh} (ns) K_{lh}	t_{phl} (ns) t_{ohl}	t_{phl} (ns) K_{hl}
D flip-flop with Load TFDL1	CK L +Q –Q ↑ 0 DC $\overline{DC}$ ↑ 1 DL $\overline{DL}$ ↓ X +Q0 –Q0 TFDL1: CK +Q, DC –Q, DL, L	10	1 1 1 2	@ @ @ #	C	CK	+Q	1.24	0.30	1.30	0.30
							–Q	1.10	0.30	1.09	0.30
D flip-flop with CLR TFDC1	CK CL +Q –Q ↑ 0 D $\overline{D}$ ↓ 0 +Q0 –Q0 X 1 0 1 TFDC1: CK +Q, D –Q, CL	9	1 1 2	@ @ #	C	CK	+Q	1.34	0.30	1.30	0.30
						CL		—		0.87	
						CK	–Q	1.10	0.30	1.19	0.30
						CL		0.67		—	
D flip-flop with PRE TFDP1	CK PR +Q –Q ↑ 0 D $\overline{D}$ ↓ 0 +Q0 –Q0 X 1 1 0 TFDP1: CK +Q, D –Q, PR	9	1 1 2	@ @ #	C	CK	+Q	1.26	0.30	1.35	0.30
						PR		1.02		—	
						CK	–Q	1.15	0.30	1.11	0.30
						PR		—		0.87	
D flip-flop with CLR/PRE TFDPC3	CK PR CL +Q –Q ↑ 0 0 D $\overline{D}$ ↓ 0 0 +Q0 –Q0 X 1 0 1 0 X 0 1 0 1 X 1 1 0 1 TFDPC3: CK +Q, D –Q, PR, CL	10	1 1 2 2	@ @ # #	C	CK	+Q	1.26	0.30	1.35	0.30
						CL		0.94		0.87	
						PR		1.16		—	
						CK	–Q	1.15	0.30	1.11	0.30
						CL		0.67		0.79	
						PR		—		1.01	

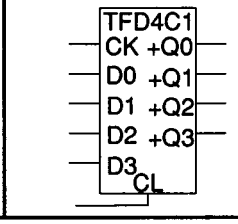
Flip-Flops (with Scan Function) (cont)

Macro					Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	In-put Name	Out-put Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
JK flip-flop TFJ	CK J K +Q –Q ↑ 0 0 0 1 ↑ 1 1 1 0 ↑ 0 1 +Q0 –Q0 ↑ 1 0 –Q0 +Q0 ↓ X X +Q0 –Q0 	11	2 1 1	@ @ #	C	CK	+Q	1.96	0.30	1.72	0.30
							–Q	1.96	0.30	1.72	0.30
JK flip-flop with CLR TFJC1	CK J K CL +Q –Q ↑ 0 0 0 0 1 ↑ 1 1 0 1 0 ↑ 0 1 0 +Q0 –Q0 ↑ 1 0 0 –Q0 +Q0 ↓ X X 0 +Q0 –Q0 X X X 1 0 1 	14	2 1 1 1	@ @ # #	C	CK	+Q	2.16	0.30	1.92	0.30
						CL		—		1.72	
						CK	–Q	2.00	0.30	1.94	0.30
						CL		2.08		—	
JK flip-flop with PRE/CLR TFJPC1	CK J K PR CL +Q –Q ↑ 0 0 1 0 0 1 ↑ 1 1 1 0 1 0 ↑ 0 1 1 0 +Q0 –Q0 ↑ 1 0 1 0 –Q0 +Q0 ↓ X X 1 0 +Q0 –Q0 X X X 0 0 1 0 X X X 1 1 0 1 X X X 0 1 1 1 	15	2 1 1 2 1	@ @ # @ #	C	CK	+Q	1.94	0.30	2.10	0.30
						PR		1.32		1.30	
						CL		—		2.10	
						CK	–Q	2.01	0.30	2.16	0.30
						PR		—		2.06	
						CL		1.72		1.34	

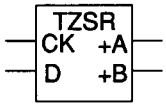
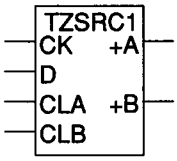
Flip-Flops (with Scan Function) (cont)

Macro						Delay					
								t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	In-put Name	Out-put Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
T flip-flop with CLR TFTC1		10	1 2	@ #	C	CK CL CK CL	+Q –Q 	1.34 — 1.10 0.67	0.30 0.30 	1.30 0.87 1.19 —	0.30 0.30
T flip-flop with PRE TFTP1		10	1 2	@ #	C	CK PR CK PR	+Q –Q 	1.26 1.02 1.15 —	0.30 0.30 	1.35 — 1.11 0.87	0.30 0.30
T flip-flop with PRE/CLR TFTPC3		11	1 2 2	@ # #	C	CK PR CL CK PR CL	+Q –Q 	1.36 1.26 1.04 1.25 — 0.77	0.30 0.30 	1.45 — 0.97 1.21 1.11 0.89	0.30 0.30
4-bit D flip-flop TFD4		29	1 1 1 1 1	@ @ @ @ @	B4	CK	+Q0– +Q3	1.40	0.30	1.85	0.30

Flip-Flops (with Scan Function) (cont)

Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Delay: Output Name	Delay: t_{plh} (ns) t_{olh}	Delay: t_{plh} (ns) K_{lh}	Delay: t_{phl} (ns) t_{ohl}	Delay: t_{phl} (ns) K_{hl}
4-bit D flip-flop with CLR TFD4C1	CK CL +Q0 +Q1 +Q2 +Q3 ↑ 0 D0 D1 D2 D3 ↓ 0 +Q00 +Q10 +Q20 +Q30 X 1 0 0 0 0 	34	1 1 1 1 1 1	@ @ @ @ @ #	B4	CK CL	+Q0– +Q3	1.60 —	0.30	1.85 1.60	0.30

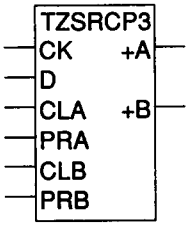
Shift Registers (with Scan Function)

Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Delay: Output Name	Delay: t_{plh} (ns) t_{olh}	Delay: t_{plh} (ns) K_{lh}	Delay: t_{phl} (ns) t_{ohl}	Delay: t_{phl} (ns) K_{hl}
2-bit shift register TZSR	CK +A +B ↑ D +A0 ↓ +A0 +B0 	13	1 1	@ @	B	CK	+A +B	1.16 1.16	0.30 0.30	1.33 1.33	0.30 0.30
2-bit shift register with CLR TZSRC1	CK CLA CLB +A +B ↑ 0 0 D +A0 ↓ 0 0 +A0 +B0 X 1 X 0 X X X 1 X 0 	16	1 1 2 2	@ @ # #	C	CK CLA CK CLB	+A +B	1.26 — 1.26 —	0.30 0.30	1.43 1.35 1.43 1.35	0.30 0.30

Shift Registers (with Scan Function) (cont)

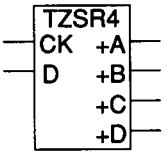
2-bit shift register with CLR/PRE — TZSRCP3

CK	CLA	CLB	PRA	PRB	+A	+B
↑	0	0	0	0	D	+A0
↓	0	0	0	0	+A0	+B0
X	1	X	X	X	0	X
X	X	1	X	X	X	0
X	X	X	1	X	1	X
X	X	X	X	1	X	1
X	1	X	1	X	0	X
X	X	1	X	1	X	0



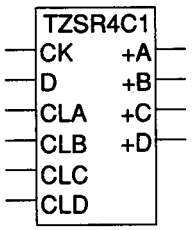
4-bit shift register — TZSR4

CK	+A	+B	+C	+D
↑	D	+A0	+B0	+C0
↓	+A0	+B0	+C0	+D0



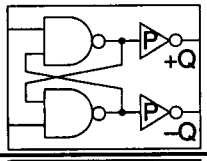
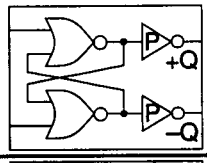
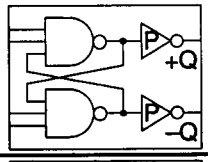
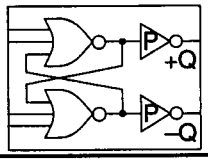
4-bit shift register with CLR — TZSR4C1

CK	CLA	CLB	CLC	CLD	+A	+B	+C	+D
↑	0	0	0	0	D	+A0	+B0	+C0
↓	0	0	0	0	+A0	+B0	+C0	+D0
X	1	X	X	X	0	X	X	X
X	X	1	X	X	X	0	X	X
X	X	X	1	X	X	X	0	X
X	X	X	X	1	X	X	X	0

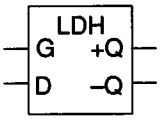
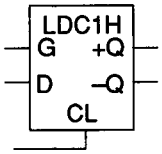
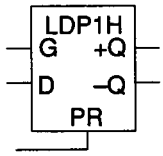
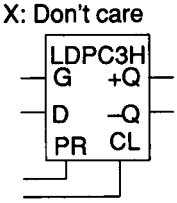


Function and Macro Name	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{plh} (ns)		t_{phl} (ns)	
							t_{olh}	K_{lh}	t_{ohl}	K_{hl}
2-bit shift register with CLR/PRE TZSRCP3	18	1	@	B4	CK	+A	1.46	0.30	1.63	0.30
		1	@		CLA		0.75		1.55	
		2	#		PRA		0.82		—	
		2	#		CK	+B	1.46	0.30	1.63	0.30
		2	#		CLB		0.75		1.55	
		2	#		PRB		0.82		—	
4-bit shift register TZSR4	29	1	@	C	CK	+A	1.38	0.30	1.55	0.30
		1	@			+B	1.38	0.30	1.55	0.30
						+C	1.38	0.30	1.55	0.30
						+D	1.38	0.30	1.55	0.30
4-bit shift register with CLR TZSR4C1	37	1	@	B4	CK	+A	1.58	0.30	1.75	0.30
		1	@		CLA		—		1.35	
		2	#		CK	+B	1.58	0.30	1.75	0.30
		2	#		CLB		—		1.35	
		2	#		CK	+C	1.58	0.30	1.75	0.30
		2	#		CLC		—		1.35	
					CK	+D	1.58	0.30	1.75	0.30
					CLD		—		1.35	

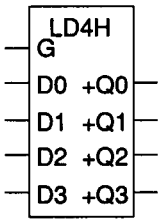
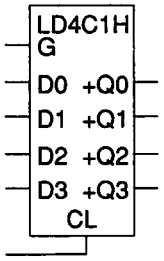
Power Latches

Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Delay: Output Name	Delay: t_{plh} (ns) t_{olh}	Delay: t_{plh} (ns) K_{lh}	Delay: t_{phl} (ns) t_{ohl}	Delay: t_{phl} (ns) K_{hl}
$\overline{RS}$ latch LRS0H	SN RN +Q –Q 0 0 0 0 0 1 1 0 1 0 0 1 1 1 Latch 	4	1	@ @	A3	$\overline{S}$ $\overline{R}$	+Q	0.75 0.61	0.30	— 0.45	0.30
						$\overline{S}$ R	–Q	0.61 0.75	0.30	0.45 —	0.30
RS latch LRS3H	S R +Q –Q 0 0 Latch 0 1 0 1 1 0 1 0 1 1 1 1 	4	1	# #	A3	S R	+Q	0.45 —	0.30	0.75 0.82	0.30
						S R	–Q	— 0.45	0.30	0.82 0.75	0.30
2-input $\overline{RS}$ latch LR2S20H	SN RN +Q –Q 0 0 0 0 0 1 1 0 1 0 0 1 1 1 Latch 	5	1	@ @ @ @	A4	$\overline{S}$ $\overline{R}$	+Q	0.82 0.75	0.30	— 0.50	0.30
						$\overline{S}$ R	–Q	0.75 0.82	0.30	0.50 —	0.30
2-input RS latch LR2S23H	S R +Q –Q 0 0 Latch 0 1 0 1 1 0 1 0 1 1 1 1 	5	1	# # # #	A4	S R	+Q	0.50 —	0.30	0.82 0.96	0.30
						S R	–Q	— 0.50	0.30	0.96 0.82	0.30

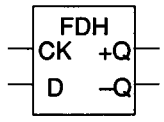
Power Latches (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	In-put Name	Out-put Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
D Latch LDH	G | +Q | –Q 1 | D | D ↘ | Latch 	5	2 1	@ @	C	G D	+Q	0.80 0.80	0.30	0.80 0.80	0.30
						G D	–Q	0.95 0.95	0.30	1.00 1.00	0.30
D Latch with CLR LDC1H	G | CL | +Q | –Q 1 | 0 | D | D ↘ | 0 | Latch X | 1 | 0 | 1 X: Don't care 	6	2 1 1	@ @ #	C	G D CL	+Q	1.25 1.25 0.80	0.30	1.15 1.15 0.75	0.30
						G D CL	–Q	0.95 0.95 0.55	0.30	1.10 1.10 0.65	0.30
D Latch with PRE LDP1H	G | PR | +Q | –Q 1 | 0 | D | D ↘ | 0 | Latch X | 1 | 1 | 0 X: Don't care 	6	2 1 1	@ @ #	C	G D PR	+Q	0.80 0.80 0.55	0.30	0.90 0.90 0.65	0.30
						G D PR	–Q	1.05 1.05 0.80	0.30	1.00 1.00 0.75	0.30
D Latch with CLR/PRE LDPC3H	G | PR | CL | +Q | –Q 1 | 0 | 0 | D | D ↘ | 0 | 0 | Latch X | 1 | 0 | 1 | 0 X | 0 | 1 | 0 | 1 X | 1 | 1 | 0 | 1 X: Don't care 	7	2 1 1 1	@ @ # #	C	G D PR CL	+Q	1.35 1.35 1.05 0.80	0.30	1.35 1.35 0.90 0.75	0.30
						G D PR CL	–Q	1.15 1.15 0.70 0.55	0.30	1.20 1.20 0.90 0.65	0.30

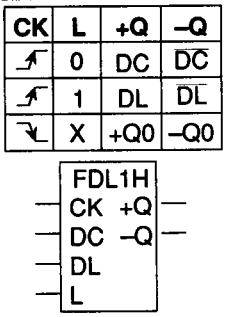
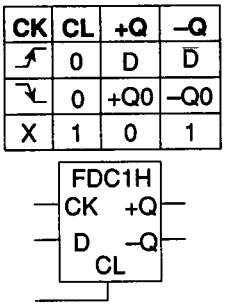
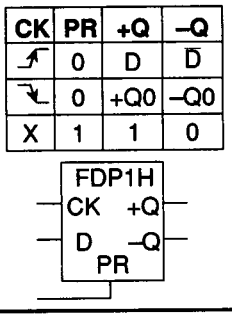
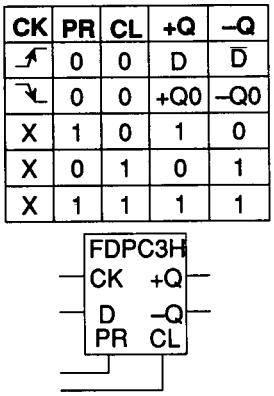
Power Latches (cont)

Function and Macro Name	Macro: Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Delay: Output Name	Delay: t_{plh} (ns) t_{olh}	Delay: t_{plh} (ns) K_{lh}	Delay: t_{phl} (ns) t_{ohl}	Delay: t_{phl} (ns) K_{hl}
4-bit latch LD4H	G | +Q0 | +Q1 | +Q2 | +Q3 1 | D0 | D1 | D2 | D3 ↘ | Latch 	14	1 1 1 1 1	@ @ @ @ @	B4	G D0–D3	+Q0–+Q3	0.92 0.82	0.30	1.03 0.82	0.30
4-bit latch with CLR LD4C1H	G | CL | +Q0 | +Q1 | +Q2 | +Q3 1 | 0 | D0 | D1 | D2 | D3 ↘ | 0 | Latch X | 1 | 0 | 0 | 0 | 0 X: Don't care 	15	1 1 1 1 1 1	@ @ @ @ @ #	B4	G D0–D3 CL	+Q0–+Q3	0.92 0.92 0.80	0.30	1.03 0.82 0.80	0.30

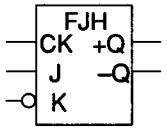
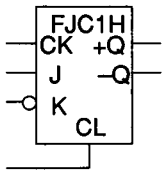
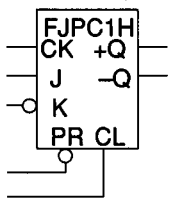
Power Flip-Flops

Function and Macro Name	Macro: Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Delay: Output Name	Delay: t_{plh} (ns) t_{olh}	Delay: t_{plh} (ns) K_{lh}	Delay: t_{phl} (ns) t_{ohl}	Delay: t_{phl} (ns) K_{hl}
D flip-flop FDH	CK | +Q | –Q ↗ | D | D̄ ↘ | +Q0 | –Q0 	7	1 1	@ @	C	CK	+Q –Q	0.84 1.05	0.30 0.30	0.90 1.04	0.30 0.30

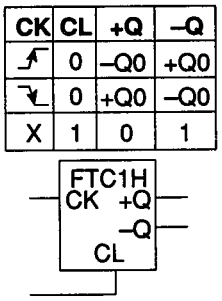
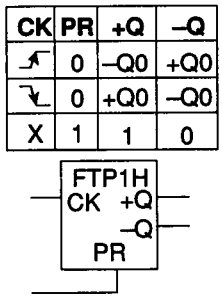
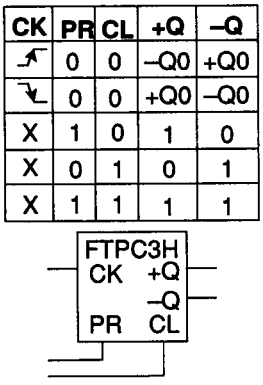
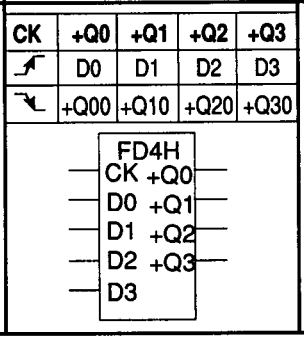
Power Flip-Flops (cont)

Function and Macro Name	Macro: Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Output Name	t_{plh} (ns) t_{olh}	t_{plh} (ns) K_{lh}	t_{phl} (ns) t_{ohl}	t_{phl} (ns) K_{hl}
D flip-flop with load FDL1H		9	1 1 1 2	@ @ @ #	C	CK 	+Q –Q	0.84 1.05	0.30 0.30	0.90 1.04	0.30 0.30
D flip-flop with CLR FDC1H		8	1 1 2	@ @ #	C	CK CL CK CL	+Q –Q 	0.84 — 1.05 0.62	0.30 0.30 	0.90 1.06 1.14 —	0.30 0.30
D flip-flop with PRE FDP1H		8	1 1 2	@ @ #	C	CK PR CK PR	+Q –Q 	0.86 0.62 1.10 —	0.30 0.30 	0.94 — 1.06 0.82	0.30 0.30
D flip-flop with CLR/PRE FDPC3H		9	1 1 2 2	@ @ # #	C	CK CL PR CK CL PR	+Q –Q 	0.86 — 0.62 1.10 0.62 —	0.30 0.30 	0.94 0.96 0.70 1.06 0.74 0.82	0.30 0.30

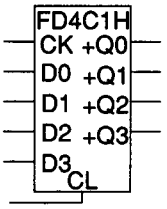
Power Flip-Flops (cont)

Function and Macro Name	Macro: Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Output Name	t_{plh} (ns) t_{olh}	t_{plh} (ns) K_{lh}	t_{phl} (ns) t_{ohl}	t_{phl} (ns) K_{hl}
JK flip-flop FJH	CK J K +Q –Q ↓ 0 0 0 1 ↓ 1 1 1 0 ↓ 0 1 +Q0 –Q0 ↓ 1 0 –Q0 +Q0 ↓ X X +Q0 –Q0 	10	2 1 1	@ @ #	C	CK	+Q –Q	1.16 1.16	0.30 0.30	0.92 0.92	0.30 0.30
JK flip-flop with CLR FJC1H	CK J K CL +Q –Q ↓ 0 0 0 0 1 ↓ 1 1 0 1 0 ↓ 0 1 0 +Q0 –Q0 ↓ 1 0 0 –Q0 +Q0 ↓ X X 0 +Q0 –Q0 X X X 1 0 1 	13	2 1 1 1	@ @ # #	C	CK CL CK CL	+Q –Q 	1.36 — 1.20 1.28	0.30 0.30 	1.12 0.92 1.14 —	0.30 0.30
JK flip-flop with PRE/CLR FJPC1H	CK J K PR CL +Q –Q ↓ 0 0 1 0 0 1 ↓ 1 1 1 0 1 0 ↓ 0 1 1 0 +Q0 –Q0 ↓ 1 0 1 0 –Q0 +Q0 ↓ X X 1 0 +Q0 –Q0 X X X 0 0 1 0 X X X 1 1 0 1 X X X 0 1 0 0 	14	2 1 1 2 1	@ @ # @ #	C	CK PR CL CK PR CL	+Q –Q 	1.36 1.26 0.54 1.30 0.50 1.30	0.30 0.30 	1.21 — 0.92 1.14 0.52 —	0.30 0.30

Power Flip-Flops (cont)

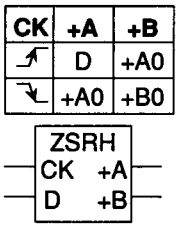
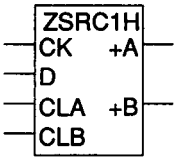
Function and Macro Name	Macro: Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Output Name	t_{plh} (ns) t_{olh}	K_{lh}	t_{phl} (ns) t_{ohl}	K_{hl}
T flip-flop with CLR FTC1H		9	1 2	@ #	C	CK CL CK CL	+Q –Q 	0.84 — 1.05 0.62	0.30 0.30 	0.90 1.06 1.14 —	0.30 0.30
T flip-flop with PRE FTP1H		9	1 2	@ #	C	CK PR CK PR	+Q –Q 	0.86 0.62 1.10 —	0.30 0.30 	0.94 — 1.06 0.82	0.30 0.30
T flip-flop with PRE/CLR FTPC3H		10	1 2 2	@ # #	C	CK PR CL CK PR CL	+Q –Q 	0.86 0.62 — 1.20 — 0.72	0.30 0.30 	0.94 0.70 0.96 1.16 0.92 0.84	0.30 0.30
4-bit D flip-flop FD4H		22	1 1 1 1 1	@ @ @ @ @	B4	CK	+Q0– +Q3	1.20	0.30	1.60	0.30

Power Flip-Flops (cont)

Function and Macro Name	Macro: Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Output Name	t_{plh} (ns) t_{olh}	t_{plh} (ns) K_{lh}	t_{phl} (ns) t_{ohl}	t_{phl} (ns) K_{hl}
4-bit D flip-flop with CLR FD4C1H		26	1 1 1 1 1 1	@ @ @ @ @ #	B4	CK CL	+Q0– +Q3	1.40 —	0.30	1.60 1.35	0.30

CK	CL	+Q0	+Q1	+Q2	+Q3
↑	0	D0	D1	D2	D3
↓	0	+Q00	+Q10	+Q20	+Q30
X	1	0	0	0	0

Power Shift Registers

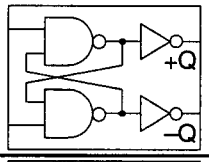
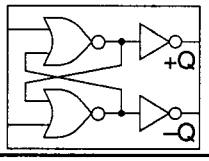
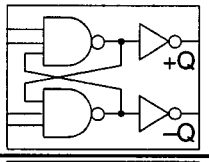
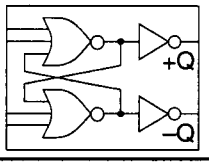
Function and Macro Name	Macro: Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Output Name	t_{plh} (ns) t_{olh}	t_{plh} (ns) K_{lh}	t_{phl} (ns) t_{ohl}	t_{phl} (ns) K_{hl}
2-bit shift register ZSRH		11	1 1	@ @	B1	CK	+A +B	0.96 0.96	0.30 0.30	1.08 1.08	0.30 0.30
2-bit shift register with CLR ZSRC1H		13	1 1 2 2	@ @ # #	C	CK CLA CK CLB	+A +B 	1.06 — 1.06 —	0.30 0.30 	1.18 1.10 1.18 1.10	0.30 0.30

CK	CLA	CLB	+A	+B
↑	0	0	D	+A0
↓	0	0	+A0	+B0
X	1	X	0	X
X	X	1	X	0

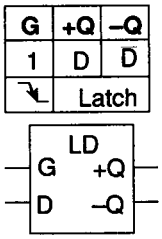
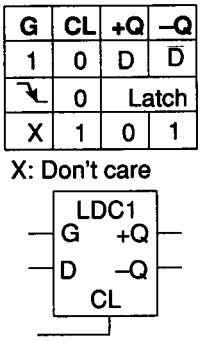
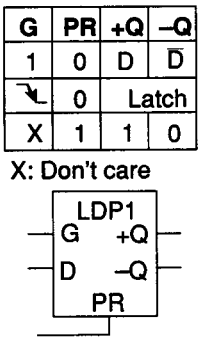
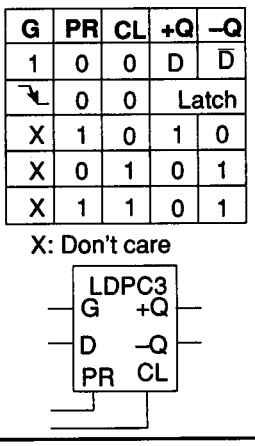
Power Shift Registers (cont)

Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	Delay t_{plh} (ns)		Delay t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
2-bit shift register with CLR/PRE ZSRCP3H	CK CLA CLB PRA PRB +A +B ↑ 0 0 0 0 D +A0 ↓ 0 0 0 0 +A0 +B0 X 1 X X X 0 X X X 1 X X X 0 X X X 1 X 1 X X X X X 1 X 1 X 1 X 1 X 1 X X X 1 X 1 X 1 ZSRCP3H: CK, D, CLA, PRA, CLB, PRB → +A, +B	15	1 1 2 2 2 2	@ @ # # # #	B4	CK CLA PRA CK CLB PRB	+A +B 	1.26 — 0.62 1.26 — 0.62	0.30 0.30 	1.38 1.30 0.70 1.38 1.30 0.70	0.30 0.30
4-bit shift register ZSR4H	CK +A +B +C +D ↑ D +A0 +B0 +C0 ↓ +A0 +B0 +C0 +D0 ZSR4H: CK, D → +A, +B, +C, +D	20	1 1	@ @	C	CK	+A +B +C +D	1.18 1.18 1.18 1.18	0.30 0.30 0.30 0.30	1.30 1.30 1.30 1.30	0.30 0.30 0.30 0.30
4-bit shift register with CLR ZSR4C1H	CK CLA CLB CLC CLD +A +B +C +D ↑ 0 0 0 0 D +A0 +B0 +C0 ↓ 0 0 0 0 +A0 +B0 +C0 +D0 X 1 X X X 0 X X X X X 1 X X X 0 X X X X X 1 X X X 0 X X X X X 1 X X X 0 ZSR4C1H: CK, D, CLA, CLB, CLC, CLD → +A, +B, +C, +D	24	1 1 2 2 2 2	@ @ # # # #	B4	CK CLA CK CLB CK CLC CK CLD	+A +B +C +D 	1.38 — 1.38 — 1.38 — 1.38 —	0.30 0.30 0.30 0.30 	1.50 1.10 1.50 1.10 1.50 1.10 1.50 1.10	0.30 0.30 0.30 0.30

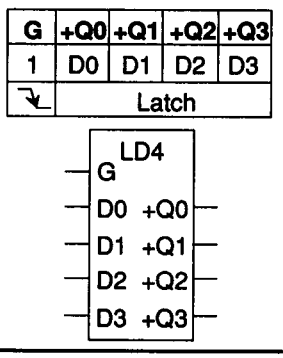
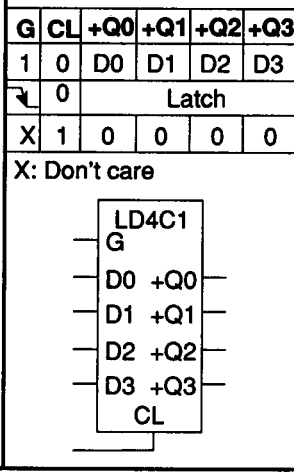
Latches (Normal)

Macro: Function and Macro Name	Macro: Equiv. Circuit and Symbol	Macro: Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	Delay: In-put Name	Delay: Out-put Name	Delay: t_{plh} (ns) t_{olh}	Delay: t_{plh} (ns) K_{lh}	Delay: t_{phl} (ns) t_{ohl}	Delay: t_{phl} (ns) K_{hl}
RS latch LRS0	SN RN +Q –Q 0 0 0 0 0 1 1 0 1 0 0 1 1 1 Latch 	3	1	@ @	A3	S R	+Q	0.65 0.51	0.50	— 0.35	0.50
						S R	–Q	0.51 0.65	0.50	0.35 —	0.50
RS latch LRS3	S R +Q –Q 0 0 Latch 0 1 0 1 1 0 1 0 1 1 1 1 	3	1	# #	A3	S R	+Q	0.35 —	0.50	0.65 0.72	0.50
						S R	–Q	— 0.35	0.50	0.72 0.65	0.50
2-input RS latch LR2S20	SN RN +Q –Q 0 0 0 0 0 1 1 0 1 0 0 1 1 1 Latch 	4	1	@ @ @ @	A4	S R	+Q	0.72 0.65	0.50	— 0.40	0.50
						S R	–Q	0.65 0.72	0.50	0.40 —	0.50
2-input RS latch LR2S23	S R +Q –Q 0 0 Latch 0 1 0 1 1 0 1 0 1 1 1 1 	4	1	# # # #	A4	S R	+Q	0.40 —	0.50	0.72 0.86	0.50
						S R	–Q	— 0.40	0.50	0.86 0.72	0.50

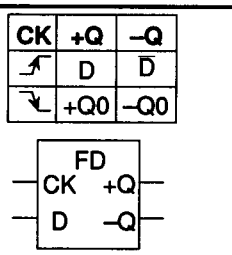
Latches (Normal) (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	In-put Name	Out-put Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
D Latch LD		4	2 1	@ @	C	G D	+Q	0.70 0.70	0.50	0.70 0.70	0.50
						G D	–Q	0.85 0.85	0.50	0.90 0.90	0.50
D Latch with CLR LDC1		5	2 1 1	@ @ #	C	G D CL	+Q	1.15 1.15 0.70	0.50	1.05 1.05 0.65	0.50
						G D CL	–Q	0.85 0.85 0.45	0.50	1.00 1.00 0.55	0.50
D Latch with PRE LDP1		5	2 1 1	@ @ #	C	G D PR	+Q	0.70 0.70 0.45	0.50	0.80 0.80 0.55	0.50
						G D PR	–Q	0.95 0.95 0.70	0.50	0.90 0.90 0.65	0.50
D Latch with CLR/PRE LDPC3		6	2 1 1 1	@ @ # #	C	G D PR CL	+Q	1.25 1.25 0.95 0.70	0.50	1.25 1.25 0.80 0.65	0.50
						G D PR CL	–Q	1.05 1.05 0.60 0.45	0.50	1.10 1.10 0.80 0.55	0.50

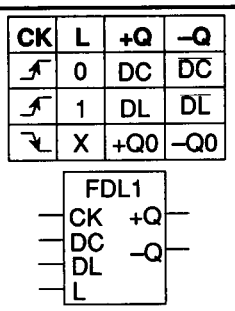
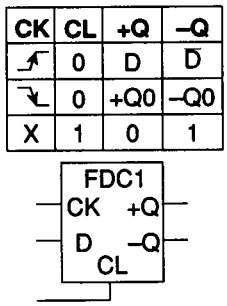
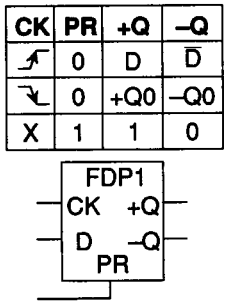
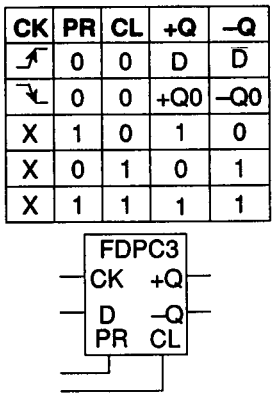
Latches (Normal) (cont)

Function and Macro Name	Macro: Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	Delay: In-put Name	Out-put Name	t_{plh} (ns) t_{olh}	t_{plh} (ns) K_{lh}	t_{phl} (ns) t_{ohl}	t_{phl} (ns) K_{hl}
4-bit latch LD4		13	1 1 1 1 1	@ @ @ @ @	B4	G D0–D3	+Q0–+Q3	0.82 0.72	0.50	0.93 0.72	0.50
4-bit latch with CLR LD4C1		14	1 1 1 1 1 1	@ @ @ @ @ # @	B4	G D0–D3 CL	+Q0–+Q3	0.82 0.82 0.70	0.50	0.93 0.72 0.70	0.50

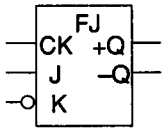
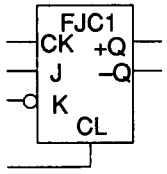
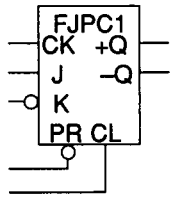
Flip-Flops (Normal)

Function and Macro Name	Macro: Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	Delay: In-put Name	Out-put Name	t_{plh} (ns) t_{olh}	t_{plh} (ns) K_{lh}	t_{phl} (ns) t_{ohl}	t_{phl} (ns) K_{hl}
D flip-flop FD		6	1	@ @	C	CK	+Q –Q	0.74 0.95	0.50 0.50	0.80 0.94	0.50 0.50

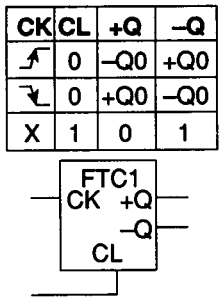
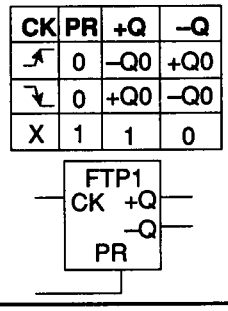
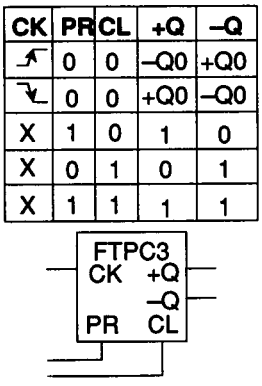
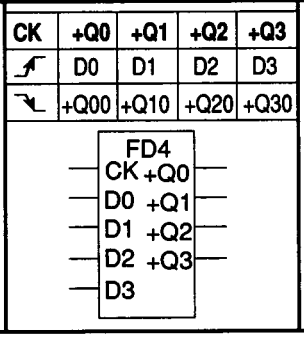
Flip-Flops (Normal) (cont)

Function and Macro Name	Macro: Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Output Name	t_{plh} (ns) t_{olh}	K_{lh}	t_{phl} (ns) t_{ohl}	K_{hl}
D flip-flop with load FDL1		8	1 1 1 2	@ @ @ #	C	CK	+Q	0.74	0.50	0.80	0.50
							–Q	0.95	0.50	0.94	0.50
D flip-flop with CLR FDC1		7	1 1 2	@ @ #	C	CK	+Q	0.74	0.50	0.80	0.50
						CL		—		0.96	
						CK	–Q	0.95	0.50	1.04	0.50
						CL		0.52		—	
D flip-flop with PRE FDP1		7	1 1 2	@ @ #	C	CK	+Q	0.76	0.50	0.84	0.50
						PR		0.52		—	
						CK	–Q	1.00	0.50	0.96	0.50
						PR		—		0.72	
D flip-flop with PRE/CLR FDPC3		8	1 1 2 2	@ @ # #	C	CK	+Q	0.76	0.50	0.84	0.50
						CL		—		0.86	
						PR		0.52		0.60	
						CK	–Q	1.00	0.50	0.96	0.50
						CL		0.52		0.64	
						PR		—		0.72	

Flip-Flops (Normal) (cont)

Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Sym-bol No.	Delay: In-put Name	Delay: Out-put Name	Delay: t_{plh} (ns) t_{olh}	Delay: t_{plh} (ns) K_{lh}	Delay: t_{phl} (ns) t_{ohl}	Delay: t_{phl} (ns) K_{hl}
JK flip-flop FJ	CK J K +Q –Q ↑ 0 0 0 1 ↑ 1 1 1 0 ↑ 0 1 +Q0 –Q0 ↑ 1 0 –Q0 +Q0 ↓ X X +Q0 –Q0 	9	2 1 1	@ @ #	C	CK	+Q	1.06	0.50	0.82	0.50
							–Q	1.06	0.50	0.82	0.50
JK flip-flop with CLR FJC1	CK J K CL +Q –Q ↑ 0 0 0 0 1 ↑ 1 1 0 1 0 ↑ 0 1 0 +Q0 –Q0 ↑ 1 0 0 –Q0 +Q0 ↓ X X 0 +Q0 –Q0 X X X 1 0 1 	12	2 1 1 1	@ @ # #	C	CK	+Q	1.26	0.50	1.02	0.50
						CL		—		0.82	
						CK	–Q	1.10	0.50	1.04	0.50
						CL		1.18		—	
JK flip-flop with PRE/CLR FJPC1	CK J K PR CL +Q –Q ↑ 0 0 1 0 0 1 ↑ 1 1 1 0 1 0 ↑ 0 1 1 0 +Q0 –Q0 ↑ 1 0 1 0 –Q0 +Q0 ↓ X X 1 0 +Q0 –Q0 X X X 0 0 1 0 X X X 1 1 0 1 X X X 0 1 0 0 	13	2 1 1 2 1	@ @ # @ #	C	CK	+Q	1.26	0.50	1.11	0.50
						PR		1.16		—	
						CL		0.44		0.82	
						CK	–Q	1.20	0.50	1.04	0.50
						PR		0.40		0.42	
						CL		1.20		—	

Flip-Flops (Normal) (cont)

Function and Macro Name	Macro: Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Output Name	t_{plh} (ns) t_{olh}	t_{plh} (ns) K_{lh}	t_{phl} (ns) t_{ohl}	t_{phl} (ns) K_{hl}
T flip-flop with CLR FTC1		8	1 2	@ #	C	CK CL CK CL	+Q –Q 	0.74 — 0.95 0.52	0.50 0.50 	0.80 0.96 1.04 —	0.50 0.50
T flip-flop with PRE FTP1		8	1 2	@ #	C	CK PR CK PR	+Q –Q 	0.76 0.52 1.00 —	0.50 0.50 	0.84 — 0.96 0.72	0.50 0.50
T flip-flop with PRE/CLR FTPC3		9	1 2 2	@ # #	C	CK PR CL CK PR CL	+Q –Q 	0.76 0.52 — 1.10 — 0.62	0.50 0.50 	0.84 0.60 0.86 1.06 0.82 0.74	0.50 0.50
4-bit D flip-flop FD4		21	1 1 1 1 1	@ @ @ @ @	B4	CK	+Q0– +Q3	1.10	0.50	1.50	0.50

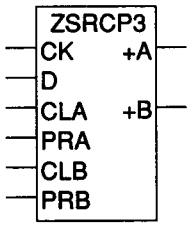
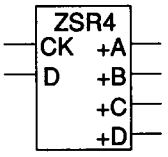
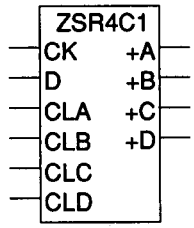
Flip-Flops (Normal) (cont)

Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Delay: Output Name	Delay: t_{plh} (ns) t_{olh}	Delay: t_{plh} (ns) K_{lh}	Delay: t_{phl} (ns) t_{ohl}	Delay: t_{phl} (ns) K_{hl}
4-bit D flip-flop with CLR FD4C1	CK ↑ 0 D0 D1 D2 D3 CK ↓ 0 +Q00 +Q10 +Q20 +Q30 X 1 0 0 0 0 FD4C1: CK +Q0, D0 +Q1, D1 +Q2, D2 +Q3, D3, CL	25	1 1 1 1 1 1	@ @ @ @ @ # (CL)	B4	CK CL	+Q0–+Q3	1.30 —	0.50	1.50 1.25	0.50

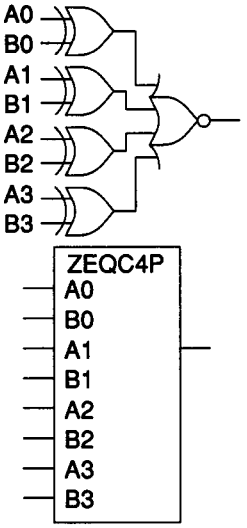
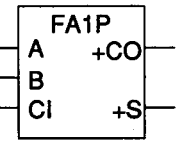
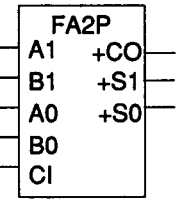
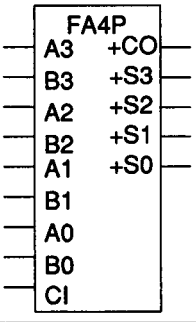
Shift Registers (Normal)

Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Delay: Input Name	Delay: Output Name	Delay: t_{plh} (ns) t_{olh}	Delay: t_{plh} (ns) K_{lh}	Delay: t_{phl} (ns) t_{ohl}	Delay: t_{phl} (ns) K_{hl}
2-bit shift register ZSR	CK ↑ D +A0 CK ↓ +A0 +B0 ZSR: CK +A, D +B	10	1 1	@ @	B1	CK	+A +B	0.86 0.86	0.50 0.50	0.98 0.98	0.50 0.50
2-bit shift register with CLR ZSRC1	CK ↑ 0 0 D +A0 CK ↓ 0 0 +A0 +B0 X 1 X 0 X X X 1 X 0 ZSRC1: CK +A, D, CLA +B, CLB	12	1 1 2 2	@ @ # # (CLA) (CLB)	C	CK CLA CK CLB	+A +B	0.96 — 0.96 —	0.50 0.50	1.08 1.00 1.08 1.00	0.50 0.50

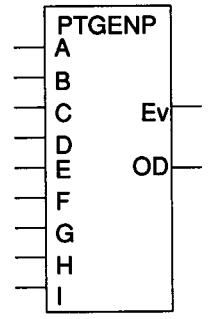
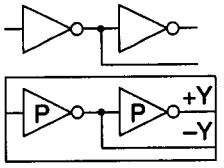
Shift Registers (Normal)

Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{plh} (ns) t_{olh}	t_{plh} (ns) K_{lh}	t_{phl} (ns) t_{ohl}	t_{phl} (ns) K_{hl}
2-bit shift register with CLR/PRE ZSRCP3	CK CLA CLB PRA PRB +A +B ↓ 0 0 0 0 D +A0 ↑ 0 0 0 0 +A0 +B0 X 1 X X X 0 X X X 1 X X X 0 X X X 1 X 1 X X X X X 1 X 1 X 1 X 1 X 1 X X X 1 X 1 X 1 	14	1 1 2 2 2 2	@ @ # # # #	B4	CK CLA PRA CK CLB PRB	+A +B 	1.16 — 0.52 1.16 — 0.52	0.50 0.50 	1.28 1.20 0.60 1.28 1.20 0.60	0.50 0.50
4-bit shift register ZSR4	CK +A +B +C +D ↓ D +A0 +B0 +C0 ↑ +A0 +B0 +C0 +D0 	19	1 1	@ @	C	CK	+A +B +C +D	1.08 1.08 1.08 1.08	0.50 0.50 0.50 0.50	1.20 1.20 1.20 1.20	0.50 0.50 0.50 0.50
4-bit shift register with CLR ZSR4C1	CK CLA CLB CLC CLD +A +B +C +D ↓ 0 0 0 0 D +A0 +B0 +C0 ↑ 0 0 0 0 +A0 +B0 +C0 +D0 X 1 X X X 0 X X X X X 1 X X X 0 X X X X X 1 X X X 0 X X X X X 1 X X X 0 	23	1 1 2 2 2 2	@ @ # # # #	B4	CK CLA CK CLB CK CLC CK CLD	+A +B +C +D 	1.28 — 1.28 — 1.28 — 1.28 —	0.50 0.50 0.50 0.50 	1.40 1.00 1.40 1.00 1.40 1.00 1.40 1.00	0.50 0.50 0.50 0.50

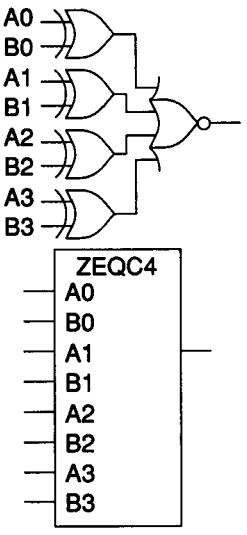
Others (Power)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
4-bit comparator ZEQC4P		14	2	# # # # # # # #	B5	A0–A3, B0–B3		0.78	0.98	0.70	0.30
1-bit full adder FA1P		9	2 2 2	# # #	B2	A, B CI	+CO	1.02 0.70	0.30	0.80 0.42	0.42
						A, B CI	+S	1.06 0.74	0.30	1.08 0.70	0.30
2-bit full adder FA2P		16	2 2 2 2 2	# # # # #	C	An, Bn CI	+CO	1.48 1.30	0.30	1.32 0.74	0.42
						An, Bn CI	+Sn	1.72 1.14	0.30	1.44 0.86	0.30
4-bit full adder FA4P		46	2 2 2 2 2 2 2 2 4	# # # # # # # # #	B5	An, Bn CI	+CO	1.30 1.10	0.30	1.22 1.06	0.30
						An, Bn CI	+Sn	2.68 2.26	0.50	2.74 2.32	0.42

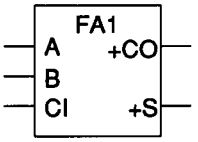
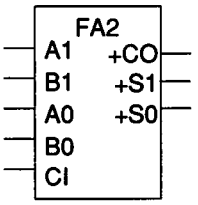
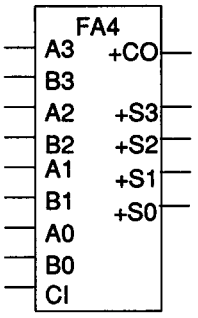
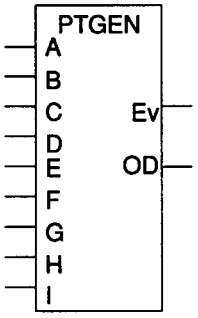
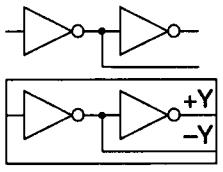
Others (Power) (cont)

Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	Delay t_{plh} (ns) t_{olh}	Delay t_{plh} (ns) K_{lh}	Delay t_{phl} (ns) t_{ohl}	Delay t_{phl} (ns) K_{hl}
4-bit parity generator/ checker PTGENP		42	1 1 1 1 1 1 1 1 1	# # # # # # # # #	B5	A–I	Ev	2.50	0.98	2.50	0.58
							OD	2.65	0.30	2.70	0.30
Power buffer BUFP		2	2	@	A1		+Y	0.51	0.30	0.44	0.30
							–Y	0.24	0.30	0.36	0.30

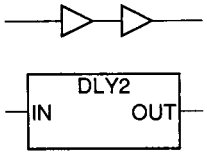
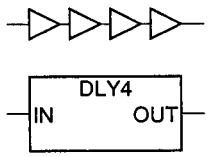
Other (Normal)

Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	Delay t_{plh} (ns) t_{olh}	Delay t_{plh} (ns) K_{lh}	Delay t_{phl} (ns) t_{ohl}	Delay t_{phl} (ns) K_{hl}
4-bit comparator ZEQC4		12	2	# # # # # # # #	B5	A0–A3, B0–B3		0.68	1.80	0.60	0.50

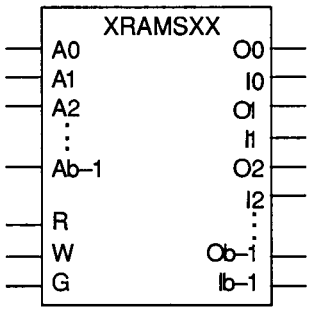
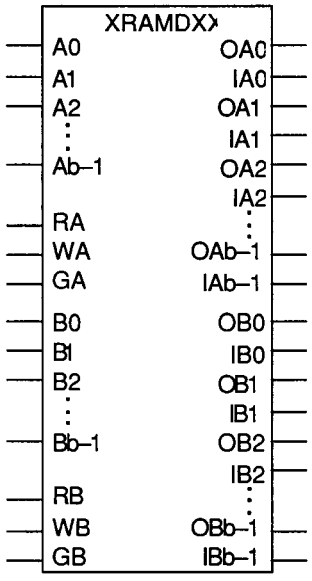
Other (Normal) (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	In-put Name	Out-put Name	t_{plh} (ns) t_{olh}	t_{plh} (ns) K_{lh}	t_{phl} (ns) t_{ohl}	t_{phl} (ns) K_{hl}
1-bit full adder FA1		7	2 2 2	# # #	B2	A, B CI A, B CI	+CO +S 	0.92 0.60 0.96 0.64	0.50 0.50 	0.70 0.32 0.98 0.60	0.76 0.50
2-bit full adder FA2		14	2 2 2 2 2	# # # # #	C	An, Bn CI An, Bn CI	+CO +Sn 	1.38 1.20 1.62 1.04	0.50 0.50 	1.22 0.64 1.34 0.76	0.76 0.50
4-bit full adder FA4		43	2 2 2 2 2 2 2 2 3	# # # # # # # # #	B5	An, Bn CI An, Bn CI	+CO +Sn 	1.20 1.00 2.58 2.16	0.50 0.92 	1.12 0.96 2.64 2.22	0.50 0.76
9-bit parity generator/ checker PTGEN		37	1 1 1 1 1 1 1 1 1	# # # # # # # # #	B5	A–I	Ev OD	2.40 2.55	1.80 0.50	2.40 2.60	1.08 0.50
Power buffer BUF		1	1	@	A1		+Y –Y	0.60 0.30	0.50 0.50	0.50 0.45	0.50 0.50

Other (Normal) (cont)

Macro						Delay					
Function and Macro Name	Equiv. Circuit and Symbol	Equiv. Gate Count	LV	Clamp Level when Open	Symbol No.	Input Name	Output Name	t_{plh} (ns)		t_{phl} (ns)	
								t_{olh}	K_{lh}	t_{ohl}	K_{hl}
Delay cell DLY2		6	1	@		IN	OUT	2.3	0.5	2.4	0.5
Delay cell DLY4		13	1	@		IN	OUT	4.2	0.5	4.3	0.5

RAM

Macro			LV	Clamp Level when Open	Delay					
							t_{plh} (ns)		t_{phl} (ns)	
Function and Macro Name	Equiv. Circuit and Symbol				Input Name	Output Name	t_{olh}	K_{lh}	t_{ohl}	K_{hl}
Single-port RAM			1	#	A0 to Ab–1	O0 to Ob–1	12	0.24	12	0.24
			1	#	R		6		6	
			1	#	W		—		—	
			1	@	G		12		12	
			1	#	I0 to Ib–1		—		—	
Cell Name	Function	Equivalent Gate Count								
TRAMS1A	256 W × 9 b (scan func.)	10000								
TRAMS2A	128 W × 18 b (scan func.)	10000								
TRAMS3A	64 W × 36 b (scan func.)	10000								
RAMS1A	256 W × 9 b	10000								
RAMS2A	128 W × 18 b	10000								
RAMS3A	64 W × 36 b	10000								
Dual-port RAM			1	#	A0 to Ab–1, B0 to Bb–1	OA0 to OAb-1, OB0 to OBb-1	12	0.24	12	0.24
			1	#	R,A, RB		6		6	
			1	#	WA, WB		—		—	
			1	@	GA, GB		12		12	
			1	#	IA0 to IAb–1, IB0 to IBb–1		—		—	
Cell Name	Function	Equivalent Gate Count								
TRAMD1A	128 W × 9 b (scan func.)	10000								
TRAMD2A	64 W × 18 b (scan func.)	10000								
TRAMD3A	32 W × 36 b (scan func.)	10000								
RAMD1A	128 W × 9 b	10000								
RAMD2A	64 W × 18 b	10000								
RAMD3A	32 W × 36 b	10000								

Single-Port RAM

Features

- One address, one R/W port
- Asynchronous
- Autodiagnosis
- 256 word × 9 bit
  128 word × 18 bit
  64 word × 36 bit

Notes

- Since the address latch (ADD-L, figure 2) is built in, G must be open (automatically pulled high) when it is not used.
- Outputs (O_0–O_{b-1}) are high impedance when read enable (R) is low.
- Change the address while write enable (W) is low only.

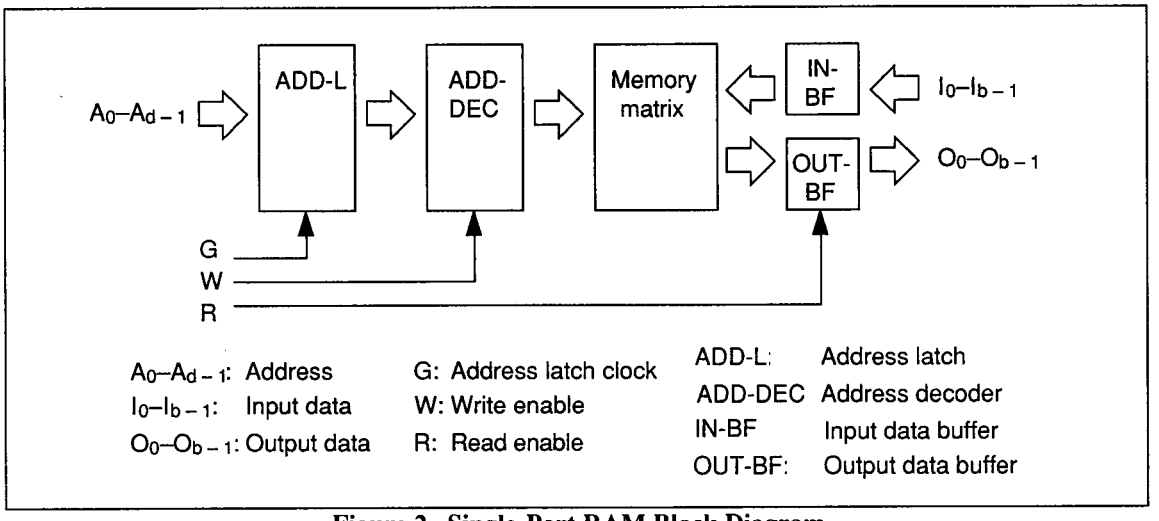


Figure 2 Single-Port RAM Block Diagram

Timing

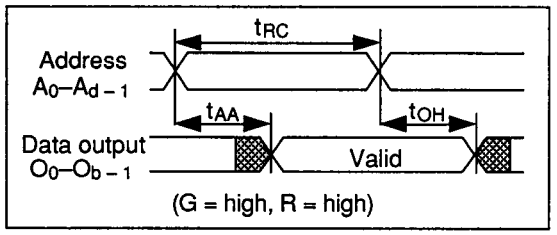


Figure 3 Single-Port Read Cycle Timing

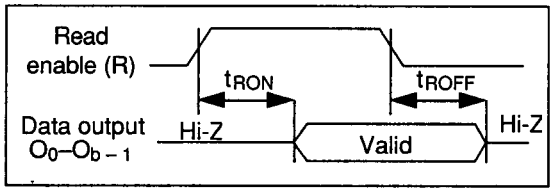


Figure 4 Single-Port Data Output Timing

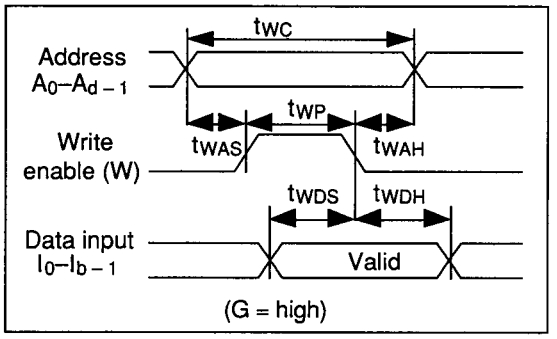


Figure 5 Single-Port Write Cycle Timing

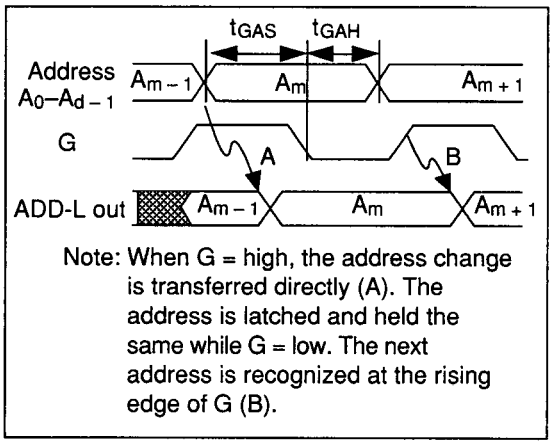


Figure 6 Single-Port Address Latch Timing

Table 6 Single-Port RAM Timing

Item	Symbol	Min	Typ	Max	Unit
Read cycle time	t_{RC}	24	—	—	ns
Address access time	t_{AA}	—	12	20	ns
Output data hold time	t_{OH}	1	—	—	ns
Read enable time	t_{RON}	—	6	10	ns
Read disable time	t_{ROFF}	0.8	—	—	ns
Write cycle	t_{WC}	24	—	—	ns
Write pulse width	t_{WP}	10	—	—	ns
Address setup time	t_{WAS}	6	—	—	ns
Address hold time	t_{WAH}	8	—	—	ns
Data setup time	t_{WDS}	10	—	—	ns
Data hold time	t_{WDH}	8	—	—	ns
Address latch setup time	t_{GAS}	4	—	—	ns
Address latch hold time	t_{GAH}	2	—	—	ns

Dual-Port RAM

Features

- Two addresses, two R/W ports
- Asynchronous
- Autodiagnosis
- 128 word × 9 bit
  64 word × 18 bit
  32 word × 36 bit

Notes

- Since the address latch (ADD-L, figure 7) is built in, GA and GB must be open (automatically pulled high) when it is not used.
- Outputs (OA_0–OA_{b-1}/OB_0–OB_{b-1}) are high impedance when read enable (RA/RB) is low.
- You cannot write to the same address from both the A and B ports simultaneously.
- Change the address while write enable (WA/WB) is low only.

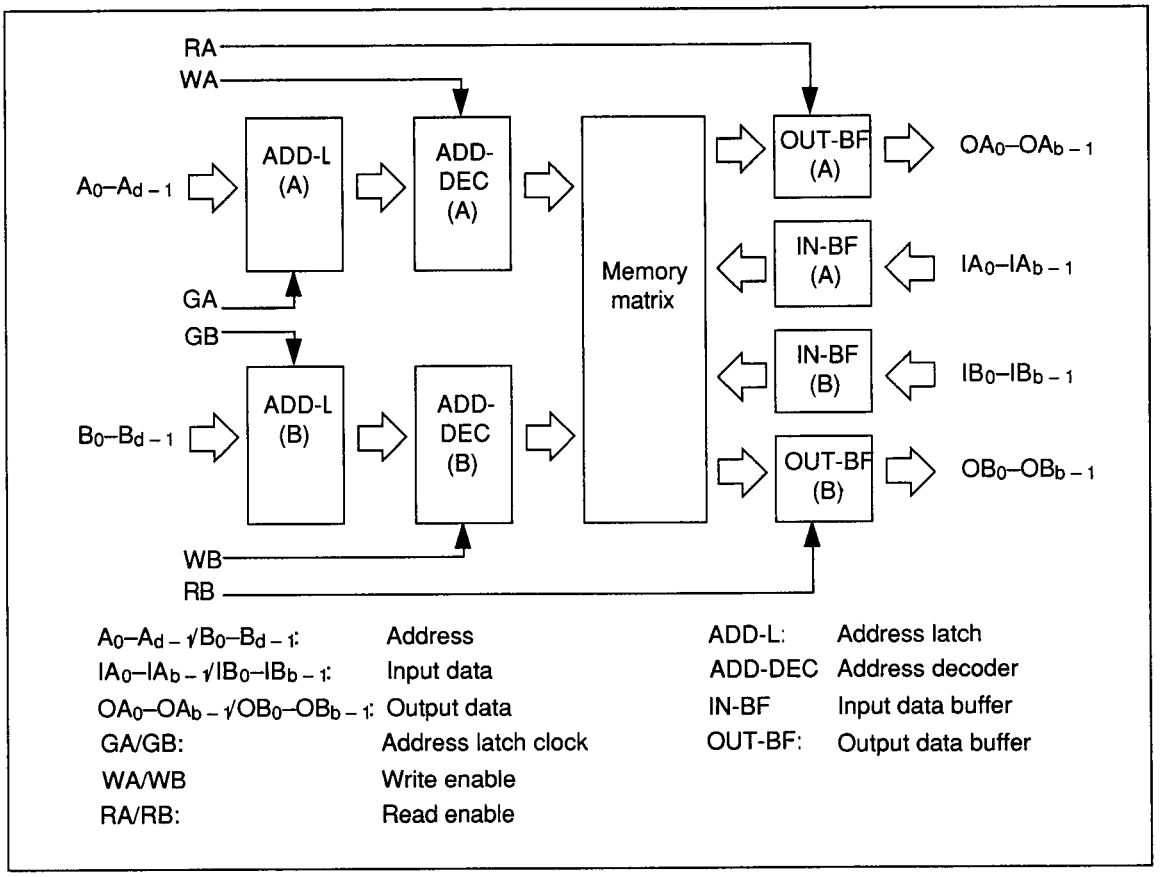


Figure 7 Dual-Port RAM Block Diagram

Timing

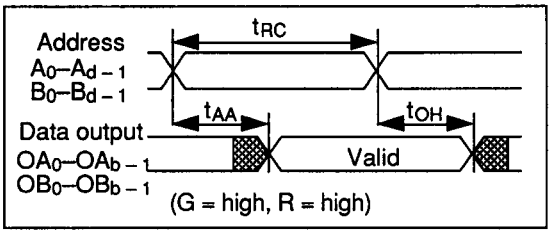


Figure 8 Dual-Port Read Cycle Timing

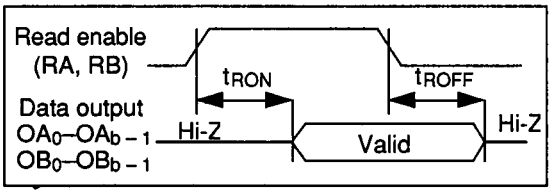


Figure 9 Dual-Port Data Output Timing

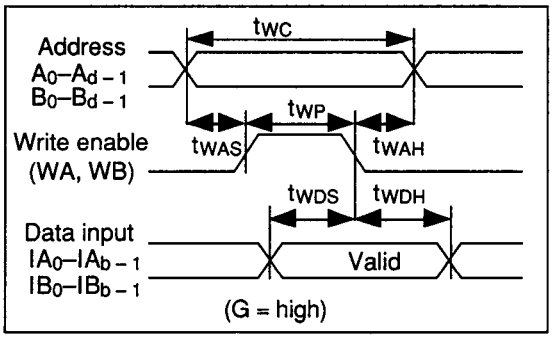


Figure 10 Dual-Port Write Cycle Timing

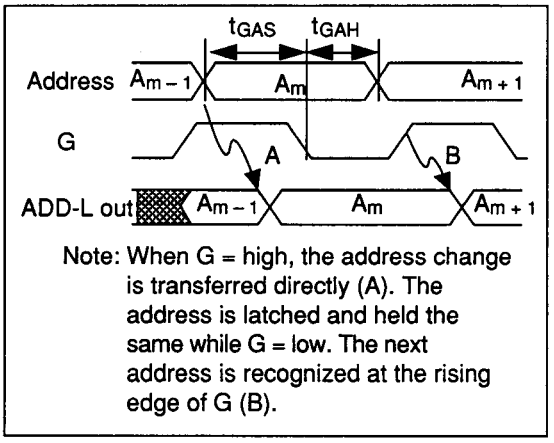


Figure 11 Dual-Port Address Latch Timing

Table 7 Dual-Port RAM Timing

Item	Symbol	Min	Typ	Max	Unit
Read cycle time	t_{RC}	24	—	—	ns
Address access time	t_{AA}	—	12	20	ns
Output data hold time	t_{OH}	1	—	—	ns
Read enable time	t_{RON}	—	6	10	ns
Read disable time	t_{ROFF}	0.8	—	—	ns
Write cycle	t_{WC}	24	—	—	ns
Write pulse width	t_{WP}	10	—	—	ns
Address setup time	t_{WAS}	6	—	—	ns
Address hold time	t_{WAH}	8	—	—	ns
Data setup time	t_{WDS}	10	—	—	ns
Data hold time	t_{WDH}	8	—	—	ns
Address latch setup time	t_{GAS}	4	—	—	ns
Address latch hold time	t_{GAH}	2	—	—	ns

Absolute Maximum Ratings

Item		Symbol	Rating	Unit
Supply voltage		V_{CC}	–0.3 to +6.7	V
Terminal voltage	Input	V_{TI}	–0.3 to V_{CC} + 0.3	V
	Output	V_{TO}	–0.3 to V_{CC} + 0.3	V
Output current	Per output	I_O	–32 to +32	mA
	Per V_{CC}/GND	I_{OT}	–70 to +70	mA
Operating temperature		T_{opr}	–20 to +75	°C
Storage temperature	With bias	T_{bias}	–20 to +85	°C
	Without bias	T_{stg}	–55 to +125	°C

Electrical Characteristics

Terminal Capacitance (Ta = 25°C, f = 1 MHz)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Terminal capacitance	C_T	—	—	12.5	pF	V_{IN} = 0 V

Note: Terminal capacitance is sampled and not 100% tested.

Normal Temperature Range (V_{CC} = 5 V ± 5%, Ta = 0°C to +70°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Input voltage (TTL level)	V_{IHT}	2.2	—	V_{CC} + 0.3	V	
	V_{ILT}	–0.3	—	0.8	V	
Input voltage (CMOS level)	V_{IHC}	0.7 × V_{CC}	—	V_{CC} + 0.3	V	
	V_{ILC}	–0.3	—	0.3 × V_{CC}	V	
Schmitt trigger (TTL level)	V_{TT+}	(1.5)	—	2.5	V	V_{CC} = 5 V
	V_{TT-}	0.7	—	(1.7)	V	V_{CC} = 5 V
	ΔV_{TT}	(0.3)	—	—	V	V_{CC} = 5 V
Schmitt trigger (CMOS level)	V_{TC+}	(2.8)	—	4.0	V	V_{CC} = 5 V
	V_{TC-}	1.2	—	(2.4)	V	V_{CC} = 5 V
	ΔV_{TC}	(0.3)	—	—	V	V_{CC} = 5 V
Output voltage (I_{OL} = 2 mA)	V_{OH}	3.5	—	—	V	I_{OH} = –1 mA
	V_{OL}	—	—	0.4	V	I_{OL} = 2 mA
Output voltage (I_{OL} = 8 mA)	V_{OH}	3.5	—	—	V	I_{OH} = –2 mA
	V_{OL}	—	—	0.4	V	I_{OL} = 8 mA
Output voltage (I_{OL} = 12 mA)	V_{OH}	3.5	—	—	V	I_{OH} = –4 mA
	V_{OL}	—	—	0.4	V	I_{OL} = 12 mA

Normal Temperature Range (cont) (V_{CC} = 5 V ± 5%, Ta = 0°C to +70°C)

Item		Symbol	Min	Typ	Max	Unit	Test Condition
Output voltage (I_{OL} = 24 mA)		V_{OH}	3.5	—	—	V	I_{OH} = –12 mA
		V_{OL}	—	—	0.4	V	I_{OL} = 24 mA
Input leakage current		I_{LI}	—	—	1	µA	
Output leakage current		I_{LO}	—	—	1	µA	At high impedance
Pull-up current		I_{PU}	80	220	550	µA	V_{IN} = GND
Pull-down current		I_{PD}	80	220	550	µA	V_{IN} = V_{CC}
Gate delay	Internal	t_{pd}	—	0.3	—	ns	2-input power NAND, FO = 2, Al = 2 mm
	Input buffer	t_{pd}	—	0.8	—	ns	FO = 2, Al = 2 mm
	Output buffer	t_{pd}	—	1.8	—	ns	High-speed buffer C_L = 50 pF
Power dissipation		Pi	—	9	—	µW/gate	1 MHz

Note: Input level may be degraded by GND noise due to numbers of output switching simultaneously.

Extended Temperature Range (V_{CC} = 5 V ± 5%, Ta = –20°C to +75°C)

Item		Symbol	Min	Typ	Max	Unit	Test Condition
Input voltage (TTL level)		V_{IHT}	2.4	—	V_{CC} + 0.3	V	
		V_{ILT}	–0.3	—	0.8	V	
Input voltage (CMOS level)		V_{IHC}	0.7 × V_{CC}	—	V_{CC} + 0.3	V	
		V_{ILC}	–0.3	—	0.3 × V_{CC}	V	
Schmitt trigger (TTL level)		V_{TT+}	(1.5)	—	2.5	V	V_{CC} = 5 V
		V_{TT-}	0.7	—	(1.7)	V	V_{CC} = 5 V
		ΔV_{TT}	(0.3)	—	—	V	V_{CC} = 5 V
Schmitt trigger (CMOS level)		V_{TC+}	(2.8)	—	4.0	V	V_{CC} = 5 V
		V_{TC-}	1.2	—	(2.4)	V	V_{CC} = 5 V
		ΔV_{TC}	(0.3)	—	—	V	V_{CC} = 5 V
Output voltage (I_{OL} = 2 mA)		V_{OH}	3.5	—	—	V	I_{OH} = –1 mA
		V_{OL}	—	—	0.4	V	I_{OL} = 2 mA
Output voltage (I_{OL} = 8 mA)		V_{OH}	3.5	—	—	V	I_{OH} = –2 mA
		V_{OL}	—	—	0.4	V	I_{OL} = 8 mA
Output voltage (I_{OL} = 12 mA)		V_{OH}	3.5	—	—	V	I_{OH} = –4 mA
		V_{OL}	—	—	0.4	V	I_{OL} = 12 mA
Output voltage (I_{OL} = 24 mA)		V_{OH}	3.5	—	—	V	I_{OH} = –12 mA
		V_{OL}	—	—	0.4	V	I_{OL} = 24 mA
Input leakage current		I_{LI}	—	—	1	µA	
Output leakage current		I_{LO}	—	—	1	µA	At high impedance
Pull-up current		I_{PU}	80	220	550	µA	V_{IN} = GND
Pull-down current		I_{PD}	80	220	550	µA	V_{IN} = V_{CC}
Gate delay	Internal	t_{pd}	—	0.3	—	ns	2-input power NAND, FO = 2, Al = 2 mm
	Input buffer	t_{pd}	—	0.8	—	ns	FO = 2, Al = 2 mm
	Output buffer	t_{pd}	—	1.8	—	ns	High-speed buffer C_L = 50 pF
Power dissipation		Pi	—	9	—	µW/gate	1 MHz

Note: Input level may be degraded by GND noise due to numbers of output switching simultaneously.

Low Voltage Version (V_{CC} = 3 V ±10%, Ta = 0°C to +70°C)

Item		Symbol	Min	Typ	Max	Unit	Test Condition
Input voltage *1 (CMOS level)		V_{IHC}	0.7 × V_{CC}	—	V_{CC} +0.3	V	
		V_{ILC}	–0.3	—	0.3 × V_{CC}	V	
Schmitt trigger *2 (CMOS level)		V_{TC}+	(1.7)	—	2.9	V	V_{CC} = 3 V
		V_{TC}–	0.7	—	(1.9)	V	V_{CC} = 3 V
		ΔV_{TC}	(0.2)	—	—	V	V_{CC} = 3 V
Output voltage *3		V_{OH}	V_{CC} –0.4	—	—	V	I_{OH} = –0.5 mA
(I_{OL} = 2 mA)		V_{OL}	—	—	0.4	V	I_{OL} = 1 mA
Output voltage *3		V_{OH}	V_{CC} –0.4	—	—	V	I_{OH} = –1 mA
(I_{OL} = 8 mA)		V_{OL}	—	—	0.4	V	I_{OL} = 4 mA
Output voltage *3		V_{OH}	V_{CC} –0.4	—	—	V	I_{OH} = –2 mA
(I_{OL} = 12 mA)		V_{OL}	—	—	0.4	V	I_{OL} = 6 mA
Output voltage *3		V_{OH}	V_{CC} –0.4	—	—	V	I_{OH} = –6 mA
(I_{OL} = 24 mA)		V_{OL}	—	—	0.4	V	I_{OL} = 12 mA
Input leakage current		I_{LI}	—	—	1	µA	
Output leakage current		I_{LO}	—	—	1	µA	At high impedance
Pull-up current		I_{PU}	25	100	230	µA	V_{IN} = GND
Pull-down current		I_{PD}	25	100	230	µA	V_{IN} = V_{CC}
Gate delay	Internal	t_{pd}	—	0.45	—	ns	2-input power NAND, FO = 2, Al = 2 mm
	Input buffer	t_{pd}	—	1.2	—	ns	FO = 2, Al = 2 mm
	Output buffer	t_{pd}	—	2.7	—	ns	High-speed buffer C_L = 50 pF
Power dissipation		Pi	—	3.3	—	µW/ gate	1 MHz
tpd Variation		α	0.65	1.5	3.1	times	Post-layout

Notes: 1. Input voltage may be changed according to the number of simultaneous switching output buffers.
2. The schmitt input value in ( ) is just for reference. It can be tested and guaranteed by customers test vecter.
3. I_{OL} current drive in ( ) below Output level is specified at V_{CC} = 5 V. For ones at V_{CC} = 3 V see test conditions.

Low Voltage Version (V_{CC} = 3 V ±10%, Ta = –20°C to +75°C)

Item		Symbol	Min	Typ	Max	Unit	Test Condition
Input voltage *1 (CMOS level)		V_{IHC}	0.7 × V_{CC}	—	V_{CC} +0.3	V	
		V_{ILC}	–0.3	—	0.3 × V_{CC}	V	
Schmitt trigger *2 (CMOS level)		V_{TC}+	(1.7)	—	2.9	V	V_{CC} = 3 V
		V_{TC}–	0.7	—	(1.9)	V	V_{CC} = 3 V
		ΔV_{TC}	(0.2)	—	—	V	V_{CC} = 3 V
Output voltage *3		V_{OH}	V_{CC} –0.4	—	—	V	I_{OH} = –0.5 mA
(I_{OL} = 2 mA)		V_{OL}	—	—	0.4	V	I_{OL} = 1 mA
Output voltage *3		V_{OH}	V_{CC} –0.4	—	—	V	I_{OH} = –1 mA
(I_{OL} = 8 mA)		V_{OL}	—	—	0.4	V	I_{OL} = 4 mA
Output voltage *3		V_{OH}	V_{CC} –0.4	—	—	V	I_{OH} = –2 mA
(I_{OL} = 12 mA)		V_{OL}	—	—	0.4	V	I_{OL} = 6 mA
Output voltage *3		V_{OH}	V_{CC} –0.4	—	—	V	I_{OH} = –6 mA
(I_{OL} = 24 mA)		V_{OL}	—	—	0.4	V	I_{OL} = 12 mA
Input leakage current		I_{LI}	—	—	1	µA	
Output leakage current		I_{LO}	—	—	1	µA	At high impedance
Pull-up current		I_{PU}	25	100	230	µA	V_{IN} = GND
Pull-down current		I_{PD}	25	100	230	µA	V_{IN} = V_{CC}
Gate delay	Internal	t_{pd}	—	0.45	—	ns	2-input power NAND, FO = 2, Al = 2 mm
	Input buffer	t_{pd}	—	1.2	—	ns	FO = 2, Al = 2 mm
	Output buffer	t_{pd}	—	2.7	—	ns	High-speed buffer C_L = 50 pF
Power dissipation		Pi	—	3.3	—	µW/ gate	1 MHz
tpd Variation		α	0.60	1.5	3.1	time	Post-layout

Notes: 1. Input voltage may be changed according to the number of simultaneous switching output buffers.
2. The schmitt input value in ( ) is just for reference. It can be tested and guaranteed by customers test vecter.
3. I_{OL} current drive in ( ) below Output level is specified at V_{CC} = 5 V. For ones at V_{CC} = 3 V see test conditions.

Characteristic Curves

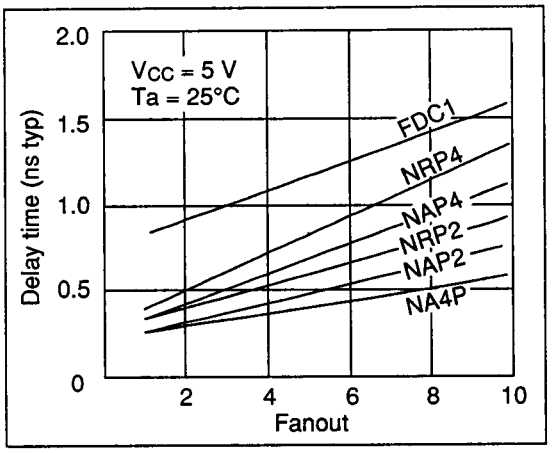


Figure 12 Internal Gate Delay Time

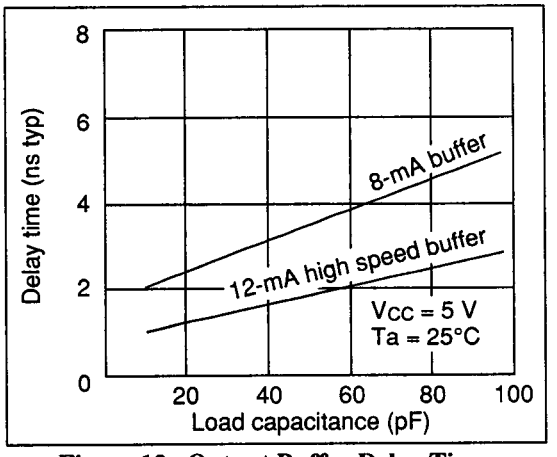


Figure 13 Output Buffer Delay Time

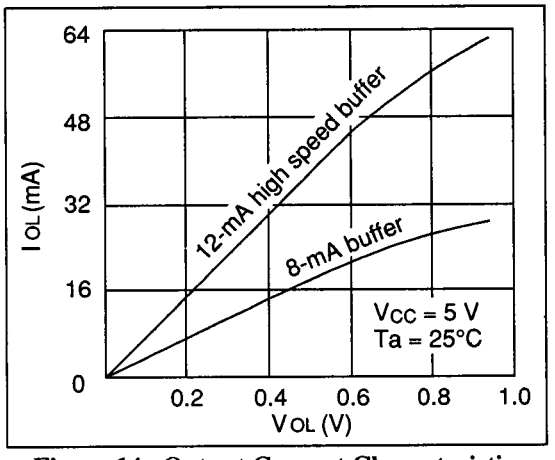


Figure 14 Output Current Characteristics (V_{OL}—I_{OL})

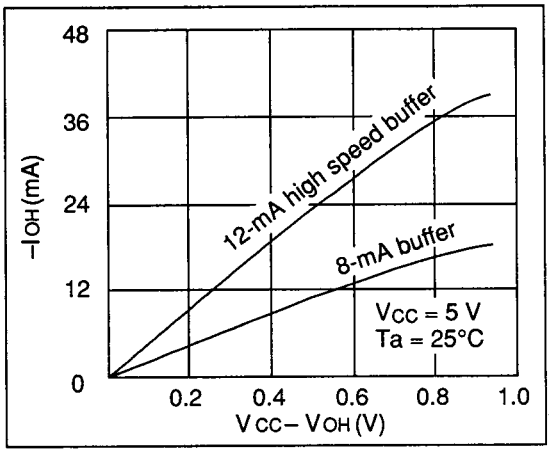
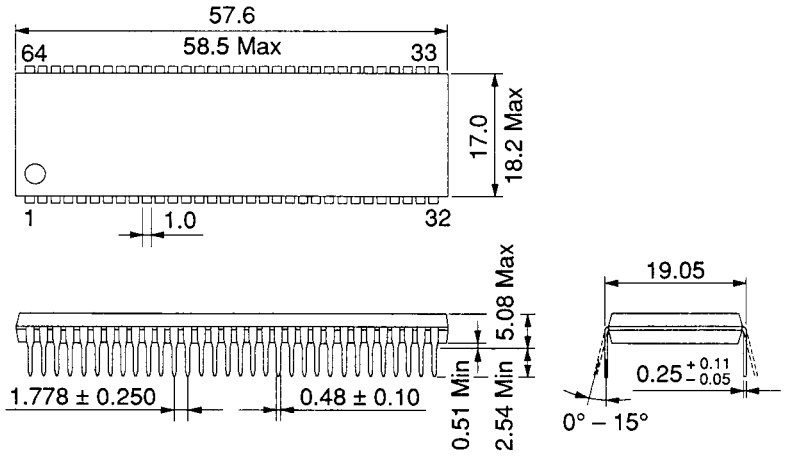


Figure 15 Output Current Characteristics (V_{OH}—I_{OH})

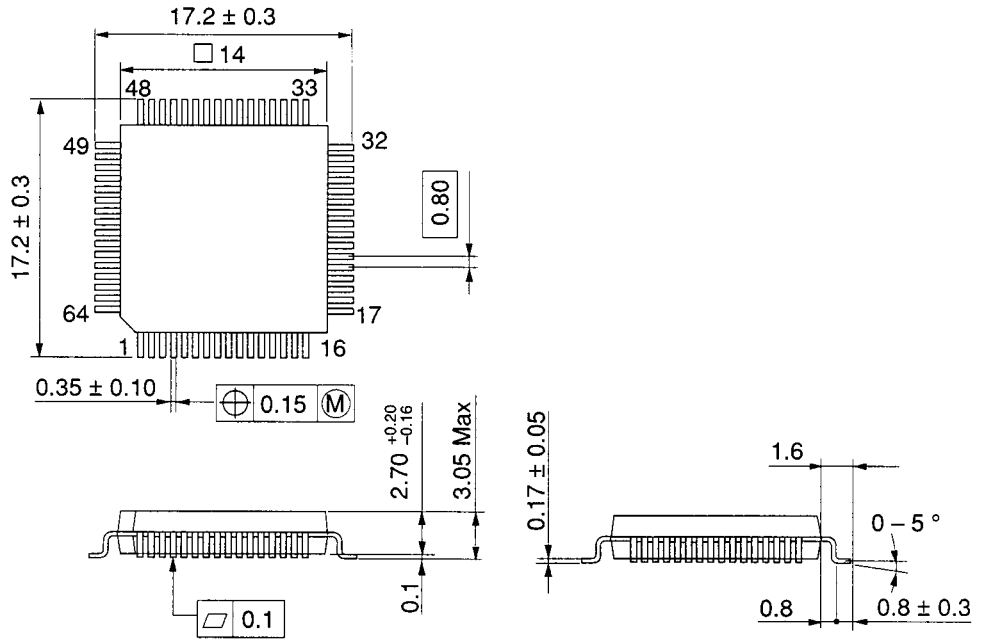
Package Dimensions

Unit: mm

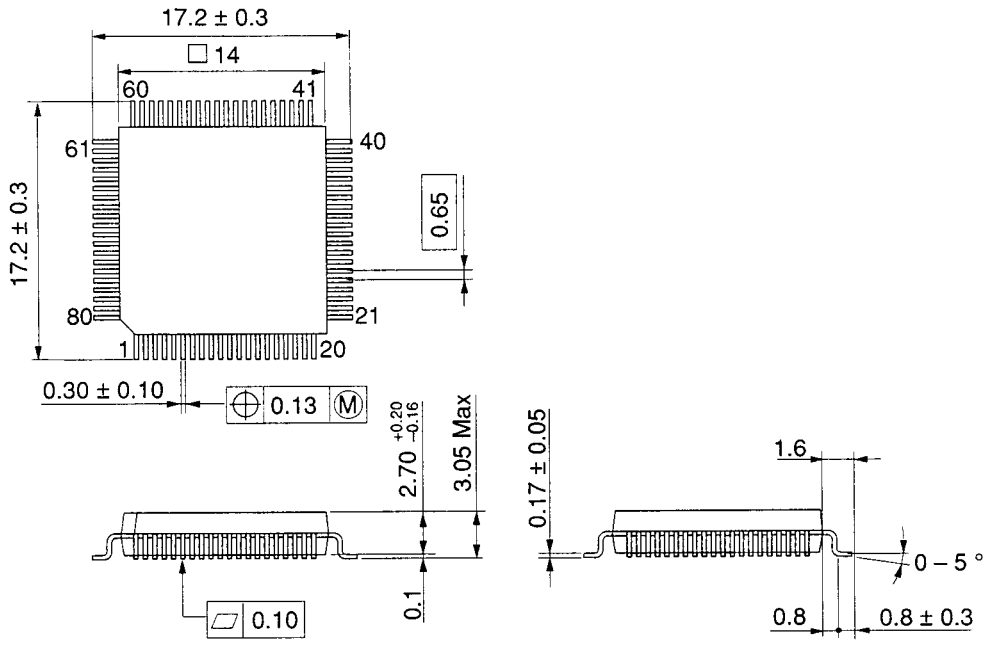
DILP-64S



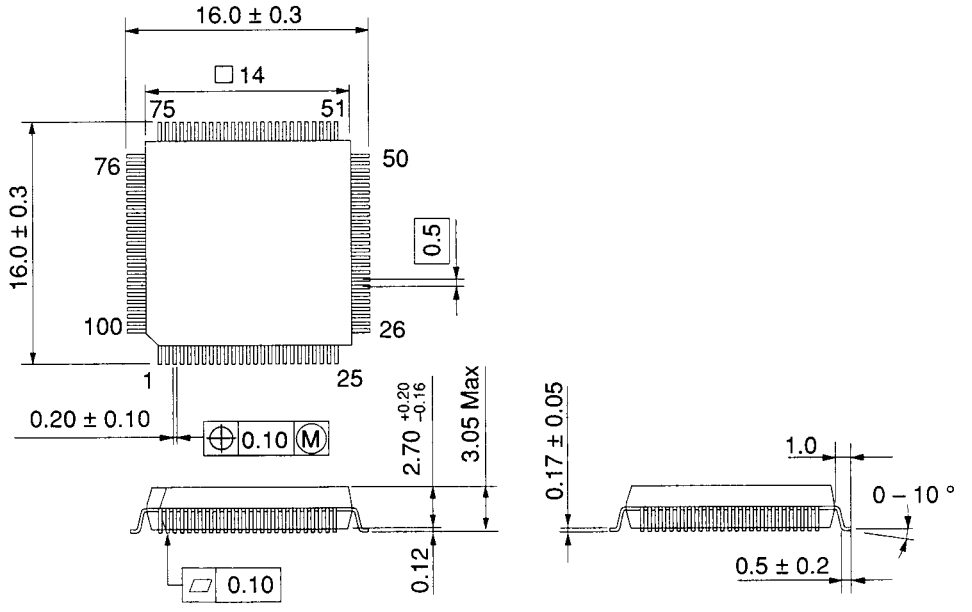
QFP-64



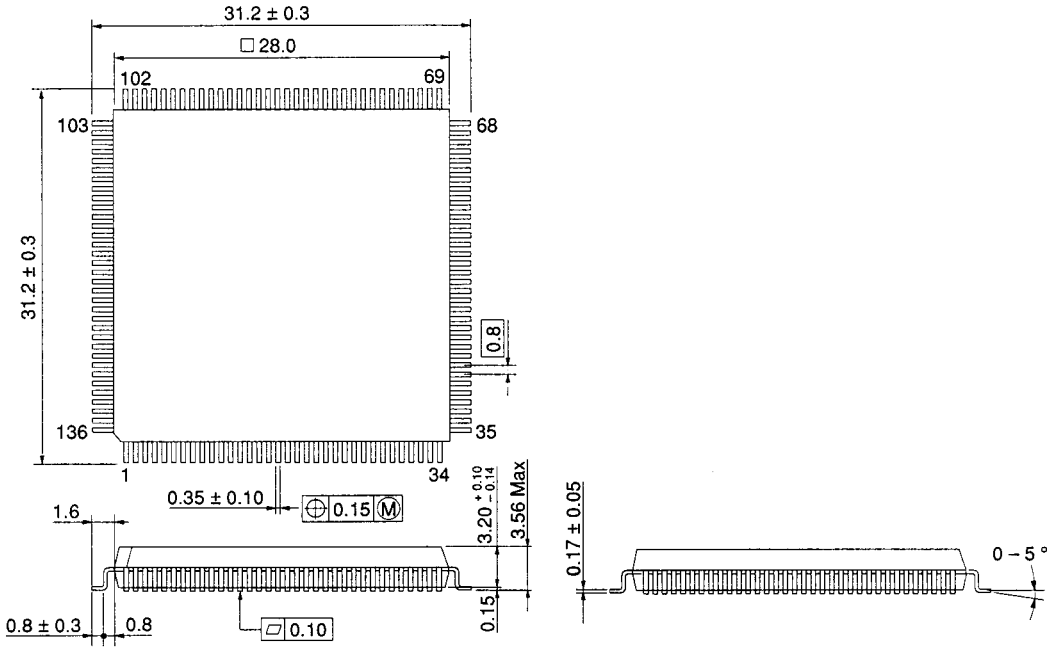
QFP-80



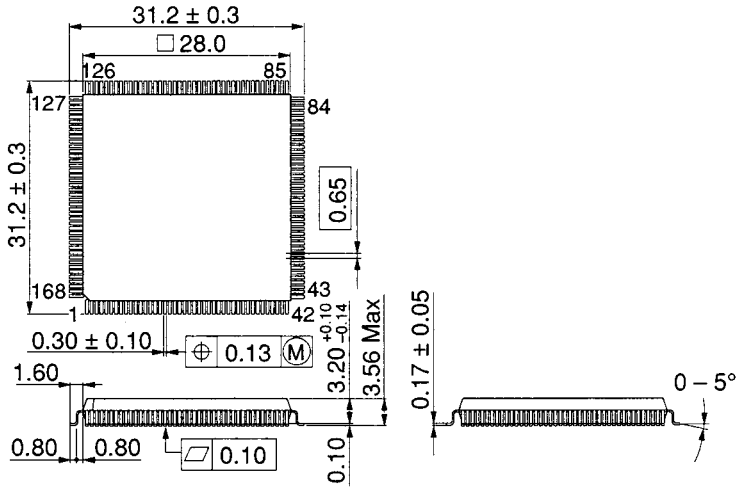
QFP-100



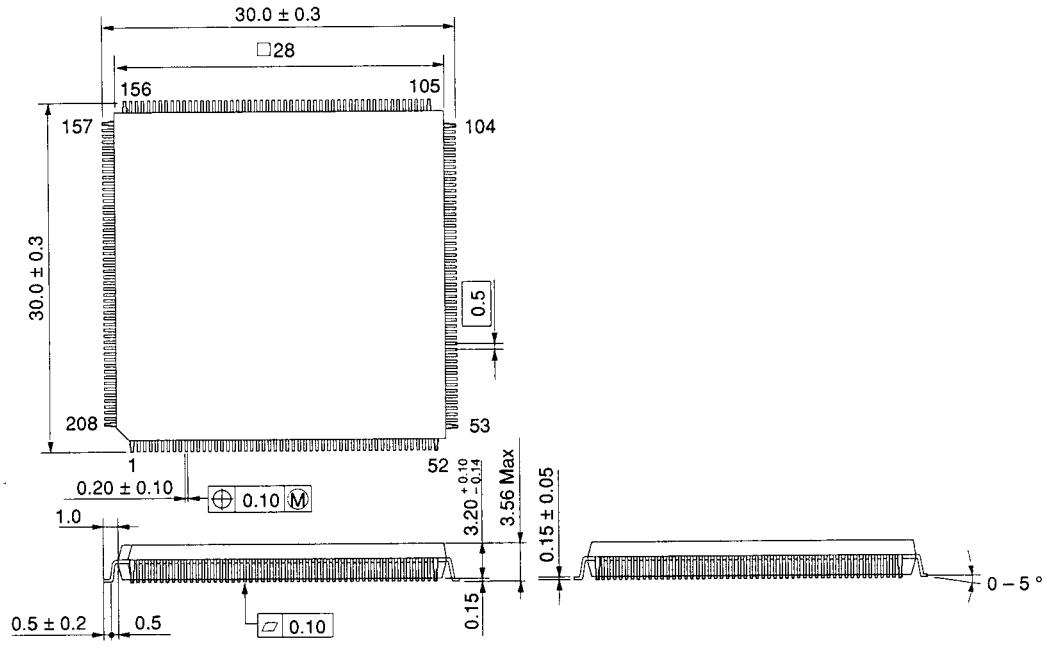
QFP-136



QFP-168



QFP-208


30.0 ± 0.3
□28
156
105
157
104
30.0 ± 0.3
0.5
208
53
1
52
0.20 ± 0.10
0.10 M
1.0
3.20 +0.10 −0.14
3.56 Max
0.15 ± 0.05
0 – 5 °
0.5 ± 0.2
0.5
0.10
0.15

When using this document, keep the following in mind:

1. This document may, wholly or partially, be subject to change without notice.
2. All rights are reserved: No one is permitted to reproduce or duplicate, in any form, the whole or part of this document without Hitachi's permission.
3. Hitachi will not be held responsible for any damage to the user that may result from accidents or any other reasons during operation of the user's unit according to this document.
4. Circuitry and other examples described herein are meant merely to indicate the characteristics and performance of Hitachi's semiconductor products. Hitachi assumes no responsibility for any intellectual property claims or other problems that may result from applications based on the examples described herein.
5. No license is granted by implication or otherwise under any patents or other rights of any third party or Hitachi, Ltd.
6. MEDICAL APPLICATIONS: Hitachi's products are not authorized for use in MEDICAL APPLICATIONS without the written consent of the appropriate officer of Hitachi's sales company. Such use includes, but is not limited to, use in life support systems. Buyers of Hitachi's products are requested to notify the relevant Hitachi sales offices when planning to use the products in MEDICAL APPLICATIONS.

HITACHI

Hitachi, Ltd.
Semiconductor & IC Div.
Karukozaka MN Bldg., 2-1, Ageba-cho, Shinjuku-ku, Tokyo 162, Japan
Tel: Tokyo (03) 3266-9376
Fax: (03) 3235-2375

For further information write to:

Hitachi America, Ltd.
Semiconductor & IC Div.
2000 Sierra Point Parkway
Brisbane, CA. 94005-1819
U S A
Tel: 415-589-8300
Fax: 415-583-4207

Hitachi Europe GmbH
Electronic Components Div.
Central Europe Headquarters
Hans-Pinsel-Straße 10A
8013 Haar bei München
F. R. Germany
Tel: 089-46140
Fax: 089-463068

Hitachi Europe Ltd.
Electronic Components Div.
Northern Europe Headquarters
Wihtebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA
United Kingdom
Tel: 0628-585000
Fax: 0628-778322

Hitachi Asia (Hong Kong) Ltd.
Unit 706, North Tower,
World Finance Centre,
Harbour City, Canton Road
Tsimshatsui, Kowloon
Hong Kong
Tel: 7359218
Fax: 7306071

109

031161 ✓

ADE-206-009A (H) Printed in Japan